

S5M8767A

Power Management IC for Mobile Applications

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Data Sheet

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Chip Handling Guide

Precaution against Electrostatic Discharge

When handling semiconductor devices, be sure that the environment is protected against static electricity.

1. Operators should wear anti-static clothing and use earth band.
2. All objects that come in direct contact with devices should be made of materials that do not produce static electricity that would cause damage.
3. Equipment and work table must be earthed.
4. Ionizer is recommended to remove electron charge.

Contamination

Be sure to use semiconductor products in the environment that may not be exposed to dust or dirt adhesion.

Temperature/Humidity

Semiconductor devices are sensitive to environment temperature and humidity. High temperature or humidity may deteriorate semiconductor device's characteristics. Therefore avoid storage or use in such conditions.

Mechanical Shock

Care should be exercised not to apply excessive mechanical shock or force on semiconductor device.

Chemical

Do not expose semiconductor device to chemical because reaction to chemical may cause deterioration of device characteristics.

Light Protection

In case of non-EMC (Epoxy Molding Compound) package, do not expose semiconductor IC to strong light. It may cause device's malfunction. (But, some special products which utilize the light or have security function are excepted from this guide)

Radioactive, Cosmic and X-ray

Semiconductor devices can be influenced by radioactive, cosmic ray or X-ray. Radioactive, cosmic and X-ray may cause soft error during device operation. Therefore semiconductor devices must be shielded under environment that may be exposed to radioactive, cosmic ray or X-ray.

EMS (Electromagnetic Susceptibility)

Note that semiconductor device's characteristics may be affected by strong electromagnetic wave or magnetic field during operation under insufficient PCB circuit design for EMS.

Revision History

Revision No.	Date	Description	Author(s)
0.00	Nov. 9, 2011	<ul style="list-style-type: none">Released Initial preliminary specification	WS Kang
0.10	Dec.5, 2011	<ul style="list-style-type: none">Ordering information is changed.LDO4 is modified default on and added to power sequence.Buck9 default voltage is changed.Figure3 System Connection Diagram is modified.Description of Manual reset function is modified.Buck Remote Sense description is updated.Mode control description of LDO4/18/23 is added.Table3 is modified.Slave address of PM section is updated.	WS Kang

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List of Conventions

Register RW Access Type Conventions

Type	Definition	Description
R	Read Only	The application has permission to read the Register field. Writes to read-only fields have no effect.
W	Write Only	The application has permission to write in the Register field.
RW	Read & Write	The application has permission to read and writes in the Register field. The application sets this field by writing 1'b1 and clears it by writing 1'b0.
RC	Read & Clear	If reading 0x01 to 0x03 registers, the information is automatically cleared.

Register Value Conventions

Expression	Description
x	Undefined bit
X	Undefined multiple bits
?	Undefined, but depends on the device or pin status
Device dependent	The value depends on the device
Pin value	The value depends on the pin status

Reset Value Conventions

Expression	Description
0	
1	
x	

Warning: Some bits of control registers are driven by hardware or write only. As a result the indicated reset value and the read value after reset might be different.

1

Product Overview

1.1 Introduction

S5M8767A is an advanced Power Management IC (PMIC) designed for mobile applications. It is comprised of high efficient Buck converters including Dual-Phase Buck converters, various LDOs, and an RTC integrated into a 144-WFP (Wafer-level Fabricated Package), 5.0mm × 5.0mm package.

S5M8767A, coupled with Multi Core Samsung Application Processors (Exynos4212/4412/5250), is used in wide mobile applications such as smart phones and tablet PCs.

The Buck Converters in S5M8767A provide stable power to the ARM core/cache, internal logic, memory, camera processor, and sub-regulations. Three Buck Converters for high load capacity in Application Processor side also provide optimal power control using Dynamic Voltage Scaling (DVS) via I2C or GPIO interface between PMIC and Application Processor.

The various LDOs supply appropriate power to each I/O and functional block in an Application Processor and camera IC in set application. Applying independent LDO to each I/O block helps the CPU to support various types of devices. Each block can be turned on and turned off for power optimization. Other features include thermal regulation and internal timer function.

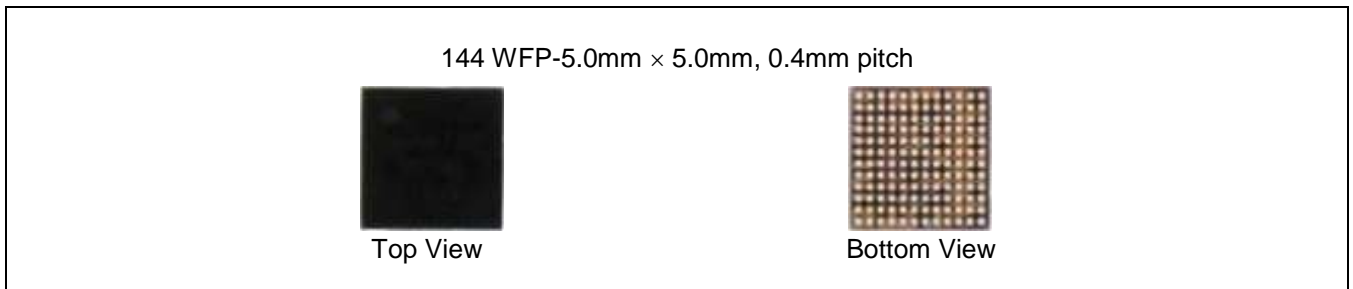


Figure 1 S5M8767A Package Top and Bottom Views

1.2 Features

The key features of S5M8767A include:

1.2.1 Regulators

- 9 High-Efficiency and programmable Buck Converters (2 Dual Phase Bucks)
 - Buck1 (VDD_MIF): 1.5 A (0.65 V to 2.225 V, 6.25mV step, default on 1.0 V)
 - Buck2 (VDD_ARM): 5.0 A, Eight Step DVS (0.6 V to 1.6 V, 6.25 mV step, default on 1.1 V)
 - Buck3 (VDD_INT): 2.5 A, Eight Step DVS (0.6 V to 1.6 V, 6.25 mV step, default on 1.0 V)
 - Buck4 (VDD_G3D): 5.0 A , Eight Step DVS (0.6 V to 1.6 V, 6.25 mV step, default on 1.0 V)
 - Buck5 (VDD_MEM): 2.0 A (0.65 V to 2.225 V, 6.25 mV step, default on 1.2 V), supports low power mode at sleep state
 - Buck6 (VDD_CAM_CORE): 1.5 A (0.65 V to 2.225 V, 6.25 mV step, default off 1.2 V)
 - Buck7 (VDD_H_LDO): 1.5 A (0.75 V to 3.0 V, 12.5 mV step, default on 2.0 V)
 - Buck8 (VDD_L_LDO): 1.5 A (0.75 V to 3.0 V, 12.5 mV step, default on 1.4 V)
 - Buck9 (VDD_F_eMMC): 1.5 A (0.75 V to 3.3 V, 12.5 mV step, default off 2.85 V)
- 28 LDO Regulators (22 PMOS LDOs, 6 NMOS LDOs, N:NMOS type LDO , P:PMOS type LDO)
 - LDO1 (N): 150 mA (0.8 V to 2.375 V, 25 mV step, default on 1.0 V)
 - LDO2 (N): 450 mA (0.8 V to 2.375 V, 25 mV step, default on 1.2 V)
 - LDO3 (P): 300 mA (0.8 V to 3.95 V, 50 mV step, default on 1.8 V)
 - LDO4 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default on 1.8 V)
 - LDO5 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default on 1.8 V)
 - LDO6 (N): 150 mA (0.8 V to 2.375 V, 25 mV step, default on 1.0 V)
 - LDO7 (N): 150 mA (0.8 V to 2.375 V, 25 mV step, default on 1.0 V)
 - LDO8 (N): 300 mA (0.8V to 2.375 V, 25 mV step, default on 1.0 V)
 - LDO9 (P): 400 mA (0.8 V to 3.95 V, 50 mV step, default off 3.0 V)
 - LDO10 (P): 300 mA (0.8 V to 3.95 V, 50 mV step, default on 1.8 V)
 - LDO11 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default on 1.8 V)
 - LDO12 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default on 3.0 V)
 - LDO13 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default on 1.8 V)
 - LDO14 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default on 1.8 V)
 - LDO15 (N): 150 mA (0.8 V to 2.375 V, 25 mV step, default on 1.0 V)
 - LDO16 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default on 1.8 V)
 - LDO17 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default on 2.8 V)
 - LDO18 (P): 300 mA (0.8V to 3.95 V, 50 mV step, default off 2.8 V)
 - LDO19 (P): 150 mA (0.8V to 3.95 V, 50 mV step, default off 3.0 V)
 - LDO20 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default off 3.0 V)
 - LDO21 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default off 3.0 V)
 - LDO22 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default off 3.3 V)

- LDO23 (P): 300 mA (0.8 V to 3.95 V, 50 mV step, default off 2.8 V)
- LDO24 (P): 300 mA (0.8 V to 3.95 V, 50 mV step, default off 3.0 V)
- LDO25 (P): 300 mA (0.8 V to 3.95 V, 50 mV step, default off 1.2 V)
- LDO26 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default off 1.8 V)
- LDO27 (P): 150 mA (0.8 V to 3.95 V, 50mV step, default off 1.8 V)
- LDO28 (P): 150 mA (0.8 V to 3.95 V, 50 mV step, default off 1.8 V)

1.2.2 Supplementary Functions

- RTC with two alarms
- Three Buffered 32.768 kHz Outputs (for AP, CP, and B/T)
- One Back up battery charger
- Low-Battery Monitor and Reset Output
- Under Voltage Lock Out / Thermal Shutdown / BandGap Reference
- Power-on Sequence
- I2C Interface for Programming

1.2.3 Applications

- Smart Phones and Cellular Phones
- Portable Applications (Tablet PC and Wireless Handheld)

1.2.4 Ordering Information

Device	Package	Operating Temperature
S5M8767A01-6030 (NOTE)	144 WFP – 5.0mm × 5.0mm (0.4mm pitch)	– 40°C to 85°C

NOTE: Under Development

Warning: This device should be shorted together or the device should be placed in conductive foam during storage or handling to prevent electrostatic damage.

1.3 Block Diagram

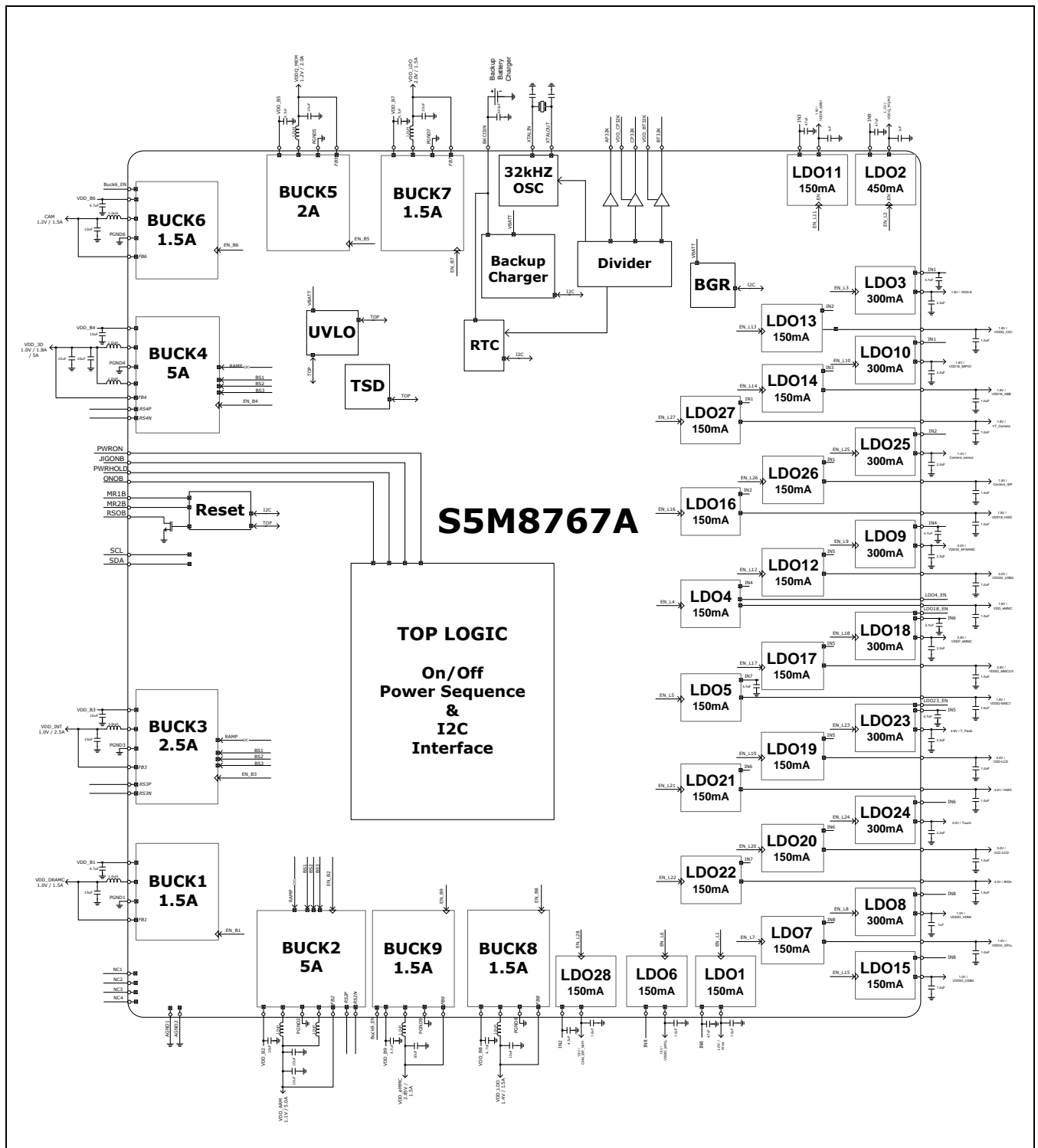


Figure 2 Block Diagram of S5M8767A

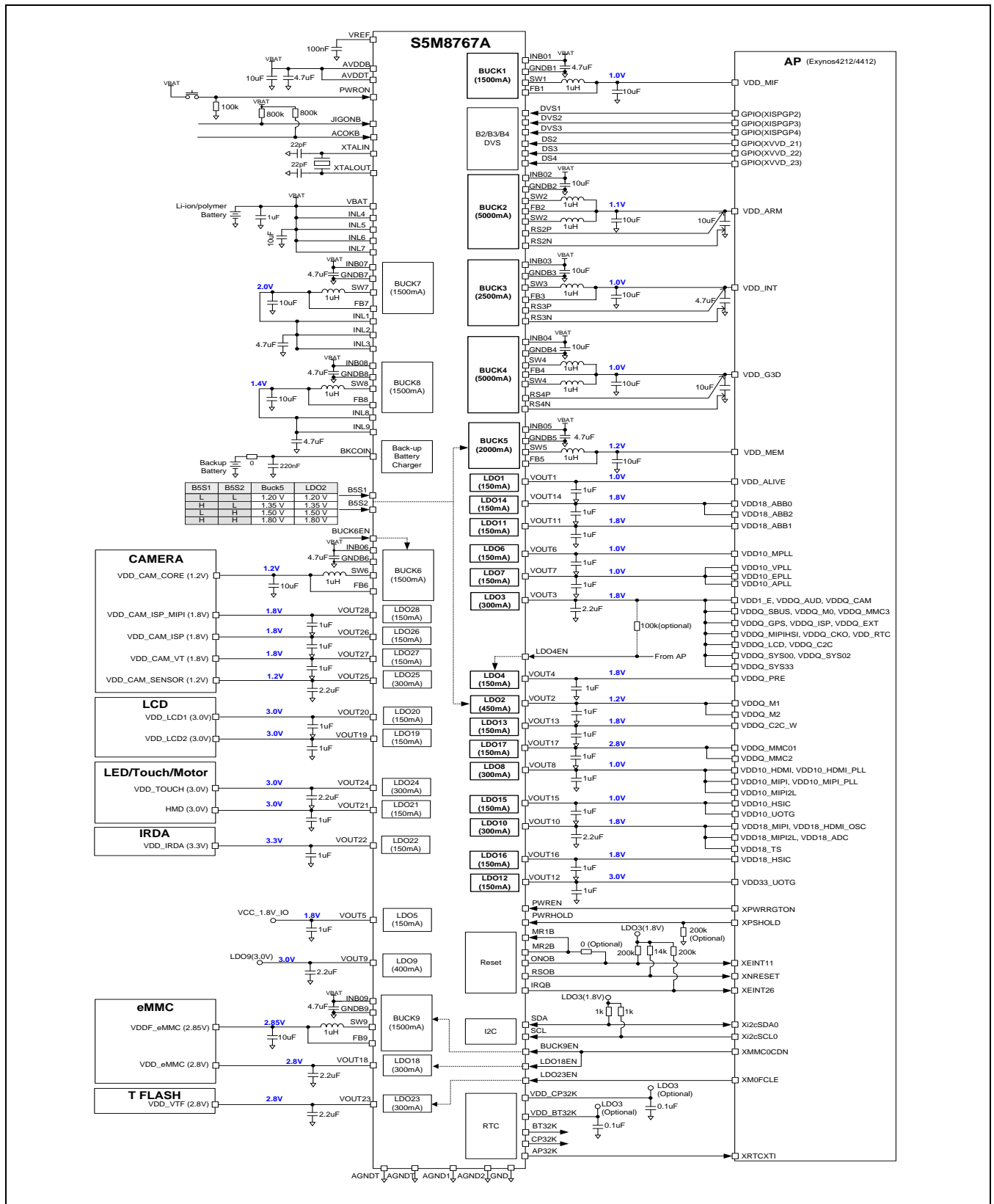


Figure 3 System Connection Diagram

1.4 Ball Configuration (Top View)

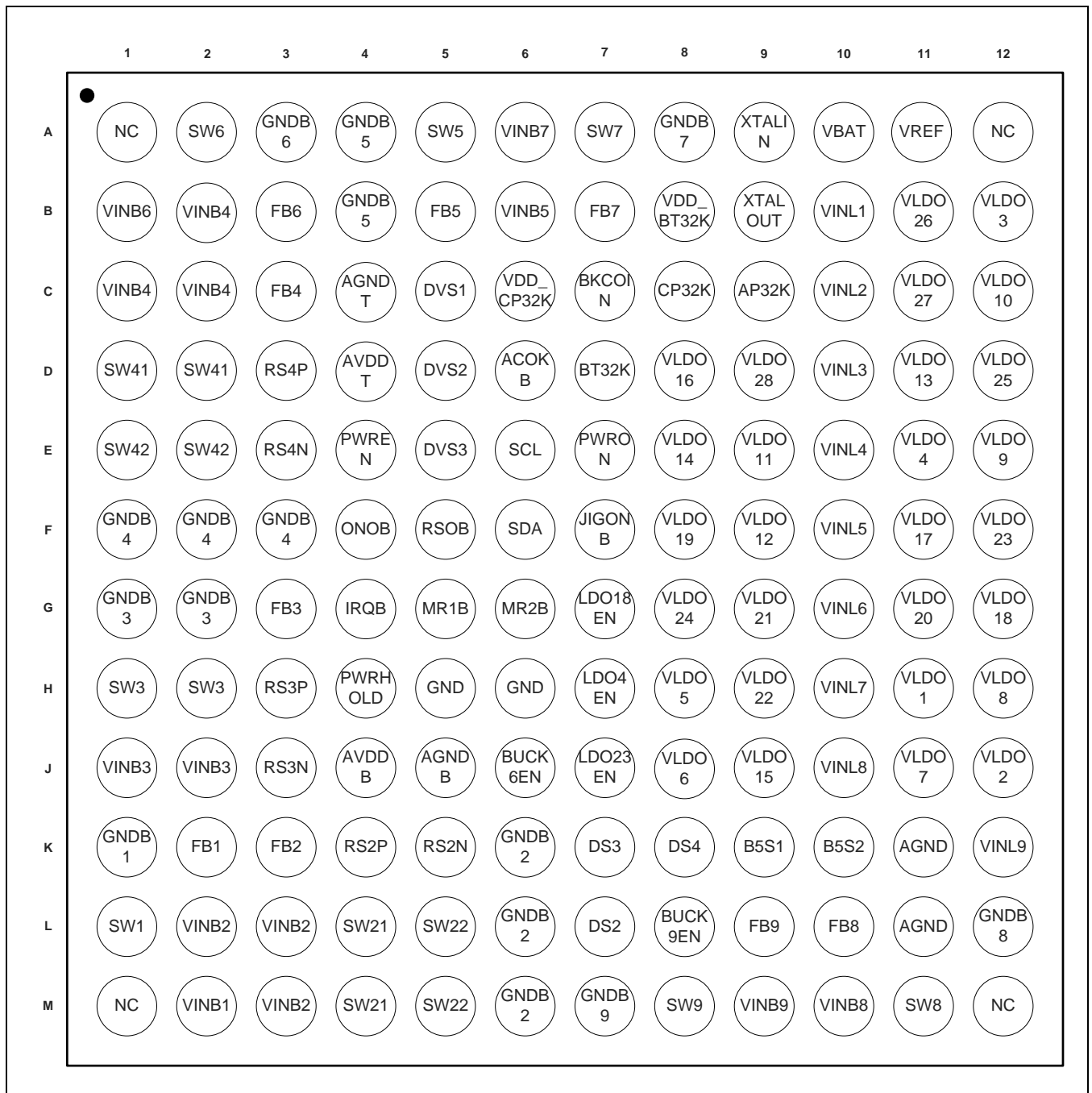


Figure 4 Ball Configuration

1.5 Ball Description

Pin No.	Symbol	I/O	Description
Power Management and I2C Section			
A9	XTALIN	AI	32.768 kHz Crystal Oscillator Input. Connect 22 pF
B8	VDD_BT32K	Power	Power Supply for 32.768 kHz BT Buffer
B9	XTALOUT	AO	32.768 kHz Crystal Oscillator Output. Connect 22 pF
C4	AGNDT	GND	Analog Ground for Bucks.
C6	VDD_CP32K	Power	Power Supply for 32.768 kHz CP Buffer
C7	BKCOIN	AO	Back up Battery Charger Output
C8	CP32K	DO	32.768 kHz Output for CP
C9	AP32K	DO	32.768 kHz Output for AP
D4	AVDDT	Power	Power Supply for Bucks.
D6	ACOKB	DI	VDCIN okay signal from external charger
D7	BT32K	DO	32.768 kHz Output for BT
E4	PWREN	DI	Power Enable Pin for Buck2/3/4 and LDO2/6/7/8/10/11/12/14/15/16
E6	SCL	DI	I2C Serial Clock Input
E7	PWRON	DI	Power Enable Signal. Connected 800 kΩ Pull-down to Ground.
F4	ONOB	DO	PWRON key active low signal. NMOS Open Drain
F5	RSOB	DO	Reset Output. NMOS Open Drain
F6	SDA	DIO	I2C Serial Data Bidirectional
F7	JIGONB	DI	Power Enable Signal through JIG.
G4	IRQB	DO	Interrupt Request Output (active low). NMOS Open Drain
G5	MR1B	DI	Manual Reset Input 1
G6	MR2B	DI	Manual Reset Input 2
G7	LDO18EN	DI	LDO18 Enable
H4	PWRHOLD	DI	Power Supply Hold Signal
H5	GND	GND	Ground
H6	GND	GND	Ground
H7	LDO4EN	DI	LDO4 Enable
J4	AVDDDB	Power	Power Supply for Bucks.
J5	AGNDB	GND	Analog Ground for Bucks.
J6	BUCK6EN	DI	BUCK 6 Enable
J7	LDO23EN	DI	LDO23 Enable
K9	B5S1	DI	Set the Buck 5 & LDO2 default voltage.
K10	B5S2	DI	Set the Buck 5 & LDO2 default voltage.
K11	AGND	GND	Analog Ground
L8	BUCK9EN	DI	BUCK 9 Enable

Pin No.	Symbol	I/O	Description
L11	AGND	GND	Analog Ground
A1	NC	AIO	No Connection
A12	NC	AIO	No Connection
M1	NC	AIO	No Connection
M12	NC	AIO	No Connection
LDO Regulator, BGR Section			
B10	VINL1	Power	Power Supply for LDO3/10/26/27 from Buck 7 or VBAT
C10	VINL2	Power	Power Supply for LDO13/16/25/28 from Buck 7 or VBAT
D10	VINL3	Power	Power Supply for LDO11/14 from Buck7 or VBAT
E10	VINL4	Power	Power Supply for LDO4/9
F10	VINL5	Power	Power Supply for LDO12/17/19/23
G10	VINL6	Power	Power Supply for LDO18/20/21/24
H10	VINL7	Power	Power Supply for LDO5/22
J10	VINL8	Power	Power Supply for LDO1/6/7/8/15 from Buck 8 or VBAT
K12	VINL9	Power	Power Supply for LDO2 from Buck 8 or VBAT
H11	VLDO1	AO	LDO1 Output
J12	VLDO2	AO	LDO2 Output
B12	VLDO3	AO	LDO3 Output
E11	VLDO4	AO	LDO4 Output
H8	VLDO5	AO	LDO5 Output
J8	VLDO6	AO	LDO6 Output
J11	VLDO7	AO	LDO7 Output
H12	VLDO8	AO	LDO8 Output
E12	VLDO9	AO	LDO9 Output
C12	VLDO10	AO	LDO10 Output
E9	VLDO11	AO	LDO11 Output
F9	VLDO12	AO	LDO12 Output
D11	VLDO13	AO	LDO13 Output
E8	VLDO14	AO	LDO14 Output
J9	VLDO15	AO	LDO15 Output
D8	VLDO16	AO	LDO16 Output
F11	VLDO17	AO	LDO17 Output
G12	VLDO18	AO	LDO18 Output
F8	VLDO19	AO	LDO19 Output
G11	VLDO20	AO	LDO20 Output
G9	VLDO21	AO	LDO21 Output
H9	VLDO22	AO	LDO22 Output

Pin No.	Symbol	I/O	Description
F12	VLDO23	AO	LDO23 Output
G8	VLDO24	AO	LDO24 Output
D12	VLDO25	AO	LDO25 Output
B11	VLDO26	AO	LDO26 Output
C11	VLDO27	AO	LDO27 Output
D9	VLDO28	AO	LDO28 Output
A10	VBAT	Power	Power Supply for BGR
A11	VREF	AO	Bandgap Reference Output
Buck Converter Section			
M2	VINB1	Power	Power Supply for Buck 1
L1	SW1	AO	Switching Node of Buck 1
K2	FB1	AI	Feedback of Buck1
K1	GNDB1	GND	Power Ground for Buck 1
L2	VINB2	Power	Power Supply for Buck 2
L3	VINB2	Power	Power Supply for Buck 2
M3	VINB2	Power	Power Supply for Buck 2
L4	SW21	AO	Switching Node of Buck 2
M4	SW21	AO	Switching Node of Buck 2
L5	SW22	AO	Switching Node of Buck 2
M5	SW22	AO	Switching Node of Buck 2
K3	FB2	AI	Feedback of Buck 2
K6	GNDB21	GND	Power Ground for Buck 2
L6	GNDB22	GND	Power Ground for Buck 2
M6	GNDB23	GND	Power Ground for Buck 2
K4	RS2P	AIO	Remote sensing of Buck 2 voltage
K5	RS2N	AIO	Remote sensing of Buck 2 GND
J1	VINB31	Power	Power Supply for Buck 3
J2	VINB32	Power	Power Supply for Buck 3
H1	SW31	AO	Switching Node of Buck 3
H2	SW32	AO	Switching Node of Buck 3
G3	FB3	AI	Feedback of Buck3
G1	GNDB31	GND	Power Ground for Buck 3
G2	GNDB32	GND	Power Ground for Buck 3
H3	RS3P	AIO	Remote sensing of Buck 3 voltage
J3	RS3N	AIO	Remote sensing of Buck 3 GND
B2	VINB4	Power	Power Supply for Buck 4
C1	VINB4	Power	Power Supply for Buck 4

Pin No.	Symbol	I/O	Description
C2	VINB4	Power	Power Supply for Buck 4
D1	SW41	AO	Switching Node of Buck 4
D2	SW41	AO	Switching Node of Buck 4
E1	SW42	AO	Switching Node of Buck 4
E2	SW42	AO	Switching Node of Buck 4
C3	FB4	AI	Feedback of Buck 4
F1	GNDB41	GND	Power Ground for Buck 4
F2	GNDB42	GND	Power Ground for Buck 4
F3	GNDB43	GND	Power Ground for Buck 4
D3	RS4P	AIO	Remote sensing of Buck 4 voltage
E3	RS4N	AIO	Remote sensing of Buck 4 GND
B6	VINB5	Power	Power Supply for Buck 5
A5	SW5	AO	Switching Node of Buck 5
B5	FB5	AIO	Feedback of Buck 5
A4	GNDB51	GND	Power Ground for Buck 5
B4	GNDB52	GND	Power Ground for Buck 5
B1	VINB6	Power	Power Supply for Buck 6
A2	SW6	AO	Switching Node of Buck 6
B3	FB6	AI	Feedback of Buck 6
A3	GNDB6	GND	Power Ground for Buck 6
A6	VINB7	Power	Power Supply for Buck 7
A7	SW7	AO	Switching Node of Buck 7
B7	FB7	AI	Feedback of Buck 7
A8	GNDB7	GND	Power Ground for Buck 7
M10	VINB8	Power	Power Supply for Buck 8
M11	SW8	AO	Switching Node of Buck 8
L10	FB8	AI	Feedback of Buck 8
L12	GNDB8	GND	Power Ground for Buck 8
M9	VINB9	Power	Power Supply for Buck 9
M8	SW9	AO	Switching Node of Buck 9
L9	FB9	AI	Feedback of Buck 9
M7	GNDB9	GND	Power Ground for Buck 9
L7	DS2	DI	DVS Selection for Buck 2
K7	DS3	DI	DVS Selection for Buck 3
K8	DS4	DI	DVS Selection for Buck 4
C5	DVS1	DI	Output Voltage Setting for Buck2/3/4
D5	DVS2	DI	Output Voltage Setting for Buck2/3/4

Pin No.	Symbol	I/O	Description
E5	DVS3	DI	Output Voltage Setting for Buck2/3/4

NOTE: Power, GND: Power Supply.

AI, AO, AIO: Analog Input, Output, Input/Output.

DI, DO, DIO: Digital Input, Output, Input/Output.

1.6 Absolute Maximum Ratings

Characteristic	Symbol	Value	Unit
Maximum Battery Supply Voltage	VBAT	– 0.3 to 6.0	V
Maximum Analog Supply Voltage	VINB1 to VINB9, VINL1 to VINL9, VDD_CP32K, VDD_BT32K	– 0.3 to 6.0	V
Junction Temperature	T _J	– 40 to 150	°C
Storage Temperature	T _{STG}	– 55 to 150	°C

NOTE: ABSOLUTE MAXIMUM RATING specifies the values beyond which the device may be damaged permanently. Exposure to ABSOLUTE MAXIMUM RATING conditions for extended periods may affect reliability. Each condition value is applied with the other values kept within the following operating conditions and function operation under any of these conditions is not implied.

1.7 Recommended Operating Condition

Characteristic	Symbol	Value	Unit
Battery Supply Voltage	VBAT	2.65 (TBD) to 5.5	V
Analog Supply Voltage	VINB1 to VINB9, VINL4 to VINL7	2.65 (TBD) to 5.5	V
	VDD_CP32K, VDD_BT32K	1.0 to 5.5	V
Analog Supply Voltage for Sub-Regulation	VINL1, VINL2, VINL3	1.7 to 5.5	V
Analog Supply Voltage for Sub-Regulation	VINL8, VINL9	1.0 to 5.5	V
Operating Ambient Temperature	T _{OPR}	– 40 to 85	°C

2

Electrical Specifications

2.1 General and Logic

(VBAT = 3.7 V, T_A = 25 °C, unless otherwise specified)

Characteristics	Test Conditions	Min.	Typ.	Max.	Unit
Supply Current					
Shutdown supply current	All Bucks and LDOs are off. Backup battery is fully charged.	–	10		μA
No load current 1 (Sleep Mode)	LDO1,5,13,17 & Buck 5 Low Power Mode, LDO3 Normal Mode, Buck 7 On, (PWREN = Low) Backup battery is fully charged. Other circuits are off.	–	120 (TBD)		μA
No load current 2 (Default On)	Buck1,2,3,4,5,7,8, LDO1-3, 5-8,10-17 on. Backup battery is fully charged. Other circuits are off.	–	600	1000	μA
UVLO and VREF					
Under-voltage lockout threshold	UVLO rising	–	3.1	–	V
	UVLO falling	–	2.55	–	V
Reference voltage (VREF)	VBATT = 2.65 V to 5.5 V	–	0.8	–	V
VREF capacitor		–	100	–	nF
Thermal Shutdown					
Thermal shutdown temperature	Thermal shutdown threshold	–	160	–	°C
	Thermal shutdown hysteresis	–	20	–	°C
Power Management					
PWRON	Power on Key input	1.4	–	–	V
	Pull-down input resistor, Connected to AGND	–	800	–	kΩ
MRB1/2	Reset Key input	–	–	0.4	V
PWREN	Power enable input	1.4	–	–	V
PWRHOLD	Power supply hold input	1.4	–	–	V
DVS1, DVS2, DVS3, DS2, DS3, DS4, B5S1, B5S2, LDO4EN, LDO18EN,	Logic input low level	–	–	0.4	V
	Logic input high level	1.4	–	–	V

Characteristics	Test Conditions	Min.	Typ.	Max.	Unit
LDO23EN, BUCK6EN, BUCK9EN, JIGONB, ACOKB					
SCL, SDA input (I2C Control Signals)	Logic input low level from AP	–	–	0.4	V
	Logic input high level from AP	1.4	–	–	V
	Logic input hysteresis	–	0.2	–	V
	Logic input coupling capacitor	–	–	10	pF
SDA Output (I2C Output Signal)	SDA logic output low signal, NMOS open drain output, active low	Pull-up external resistor to LDO3			V
	Logic output to AP, active low	–	–	0.2	V
ONOB,RSOB, IRQB	System reset output signal, NMOS open-drain output	Pull-up external resistor to LDO3			V
	Logic output to AP, active low	–	–	0.2	V
	RSOB De-assert delay	–	60	–	ms
I2C Control					
Clock frequency	–	–	–	3.5	MHz
Bus free time between start and stop	–	1.3	–	–	μs
Hold time repeated start condition	–	0.6	–	–	μs
CLK low period	–	1.3	–	–	μs

2.2 Buck Converters

2.2.1 Buck Converter 1, 3, 5, 6, 7, 8, 9

(VBAT = 3.7 V, T_A = 25 °C, unless otherwise specified)

Buck 1, 3, and 5 to 9: Cout = 10 µF, L = 1.0 µH

Characteristics	Test Conditions				Min.	Typ.	Max.	Unit
Voltage Mode Buck Converter								
Input voltage range ⁽¹⁾					2.7		5.5	V
Shutdown current ⁽²⁾	Regulator disabled				–	0.1	–	μA
Ground current ⁽²⁾	Buck 1,3,5,6, 7,8,9	Regulator enabled, no load, no switching,			–	17	–	μA
	Buck5	Low power mode				10		
Output voltage range	Buck 1, programmable in 6.25 mV Steps				0.650		2.225	V
	Buck 3, programmable in 6.25 mV Steps				0.600		1.6	
	Buck 5, programmable in 6.25 mV Steps				0.650		2.225	
	Buck 6, programmable in 6.25 mV Steps				0.650		2.225	
	Buck 7, programmable in 12.5 mV Steps				0.750		3.000	
	Buck 8, programmable in 12.5 mV Steps				0.750		3.000	
	Buck 9, programmable in 12.5 mV Steps				0.750		3.300	
Default output voltage ⁽⁵⁾	Buck 1	PWM Mode			– 3.0 %	1.0	+ 3.0 %	V
	Buck 3	PWM Mode			– 1.0 %	1.0	+ 1.0 %	
	Buck 5	PWM Mode & Iload < 5 mA (Low power mode)	B5S1 & B5S2 ⁽⁴⁾	00	– 3.0 %	1.2	+ 3.0 %	
				01	– 3.0 %	1.35	+ 3.0 %	
				10	– 3.0 %	1.50	+ 3.0 %	
				11	– 3.0 %	1.80	+ 3.0 %	
	Buck 6	PWM Mode			– 3.0 %	1.2	+ 3.0 %	
	Buck 7	PWM Mode			– 3.0 %	2.0	+ 3.0 %	
	Buck 8	PWM Mode			– 3.0 %	1.4	+ 3.0 %	
	Buck 9	PWM Mode			– 3.0 %	2.85	+ 3.0 %	
Maximum output current	Buck 1, 6, 7, 8, 9				1500	–	–	mA
	Buck 3				2500	–	–	
	Buck 5	Normal mode			2000	–	–	
		Low power mode			5			
Output load regulation	Buck 1, 6, 7, 8, 9	10mA < Iout < 1.5 A (PWM)			–	0.15	–	%A
	Buck 3	10mA < Iout < 2.5 A (PWM)			–	0.15	–	
	Buck 5	10mA < Iout < 2.0 A (PWM)			–	0.15	–	

Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
Output line regulation	VINBx = 3.0 V to 4.5 V		–	0.1	–	%/V
Current limit	Buck 1	PFET Switch	–	2200	–	mA
	Buck 3	PFET switch	–	3700	–	
	Buck 5	PFET switch	–	3000	–	
	Buck 6	PFET switch	–	2200	–	
	Buck 7, 8	PFET switch	–	2200	–	
	Buck 9	PFET switch	–	2200	–	
On-resistance	Buck 1, 5, 6, 7, 8, 9	PFET switch (VINB to SW), ILX = – 150 mA @3.7 V	–	150	-	mΩ
		NFET rectifier (SW to GNDB), ILX = – 150 mA @3.7 V	–	80	-	
	Buck 3	PFET switch (VINB to SW), ILX = – 50 mA @3.7 V	–	130	-	
		NFET rectifier (SW to GNDB), ILX = – 150 mA @3.7 V	–	70	-	
Switching frequency	PWM mode		–	3.5	–	MHz
Active discharge	Regulator disabled, resistance from FB3 to GNDB3 for Buck 3		–	0.1	–	kΩ
	Regulator disabled, resistance from SWx to GNDBx for Buck 1, 5, 6, 7, 8, 9			1		
Soft start ramp rate ⁽³⁾	Ramp rate in soft start operation		–	30	–	mV/ μs
Startup delay ⁽³⁾	Delay for calibration			20		μs
Dynamic-change ramp Rate ⁽²⁾	Buck 3	Positive and Negative Ramp Rate in Dynamic Voltage Scale 5 mV/μs, 10 mV/μs, 25 mV/μs, 50 mV/μs and 100 mV/μs Ramp off: Max ramp rate (100 mV)	5	10	100	mV/μs

2.2.2 Buck Converter 2 & 4

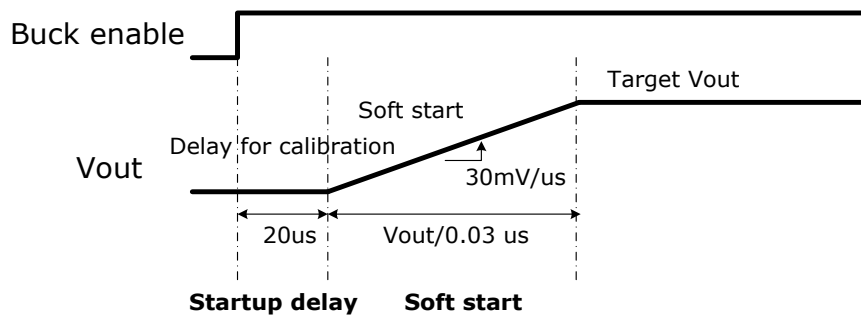
(VBAT = 3.7 V, T_A = 25 °C, unless otherwise specified)

Buck 2, 4: C_{out} = 2x10 μF, L = 1.0 μH

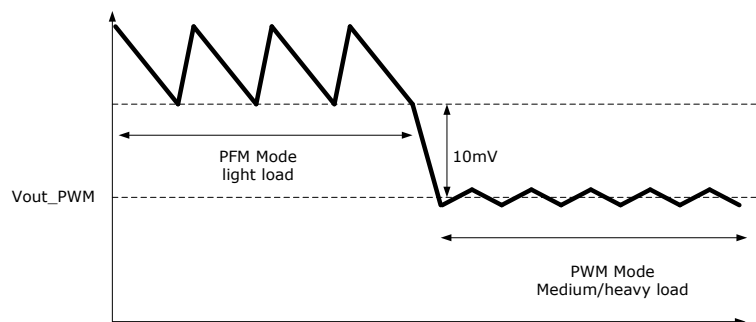
Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
Current Mode Buck Converter						
Input voltage range ⁽¹⁾			2.7		5.5	V
Shutdown current ⁽²⁾	Regulator disabled		–	0.1	–	μA
Ground current ⁽²⁾	Regulator enabled, no load, no switching,		–	22	–	μA
	No load, No switching current In Remote Sensing mode			32		
Output voltage range	Programmable in 6.25 mV Steps		0.6		1.6	V
Default output voltage ⁽⁵⁾	Buck 2	PWM Mode	– 1.0 %	1.1	+ 1.0 %	V
	Buck 4	PWM Mode	– 1.0 %	1.0	+ 1.0 %	V
Maximum output current	Maximum Output current		5000	–	–	mA
Output load regulation	Buck 2, 4	10 mA < Iout < 5.0 A (PFM to PWM)	–	0.5	–	%/A
Output line regulation	Buck 2, 4	VINBx = 3.0 V to 4.5 V	–	0.1	–	%/V
Current limit	Buck 2, 4	PFET Switch	–	6000	–	mA
On-resistance	Buck 2, 4	PFET switch (VINBx to SWx), ILX = – 150 mA @3.7 V	–	150	–	mΩ
		NFET rectifier (SWx to GNDBx), ILX = – 150 mA @3.7 V	–	80	–	
Switching frequency	Buck 2, 4	PWM MODE	–	2.5	3.0	MHz
Active discharge	Regulator disabled, resistance from FBx to GNDBx		–	50	–	Ω
Soft start ramp rate ⁽³⁾	Ramp rate in soft start operation		–	30	–	mV/μs
Startup delay ⁽³⁾	Delay for calibration			20		μs
Dynamic-change ramp rate ⁽²⁾	Buck 2, 4	Positive and Negative Ramp Rate with 5 mV/μs,10 mV/μs, 25 mV/μs, 50 mV/μs and 100 mV/μs in Dynamic Voltage Scale Ramp off: Max ramp rate (100 mV)	5	10	100	mV/μs

NOTE:

1. Minimum input voltage is 1/D_{max} multiplied by the addition of output voltage and the product of load current and sum of R_{on} and R_{parasitic}.
2. Design guidance; not tested for each device.
3. Startup waveform of Buck converter.



4. B5S1 / B5S2 control output voltage of Buck5 and LDO2 together.
5. PFM voltage is 10mV higher than PWM voltage.



2.3 LDOs

2.3.1 LDO (P) 4, 5, 11, 12, 13, 14, 16, 17, 19, 20, 21, 22, 26, 27, 28 (150 mA, PMOS)

(VBAT = 3.7 V, T_A = 25 °C, unless otherwise specified)

Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
Input voltage range (VINL) ⁽¹⁾			1.7	–	5.5	V
Under voltage Lockout	Rising, 100 mV Hysteresis			1.6	1.7	V
Battery Voltage Range	Equal or Higher than VINL		2.7	–	5.5	V
Output Voltage Range	IL = 150 mA Programmable in 50 mV steps		0.8	–	3.95	V
Default output voltage (VLDO)	LDO (P) 4, 5, 11, 13, 14, 16, 26, 27, 28	150 mA @VINL = VLDO +0.3V	–	1.8	–	V
	LDO (P) 17			2.8		
	LDO (P) 12, 19, 20, 21			3.0		
	LDO (P) 22			3.3		
Maximum Load Current	Normal Mode		150			mA
	Low-Power Mode		5			
Output Current Limit	VOUT = 90 % of VLDO		180	225	270	mA
Minimum Output Bypass Capacitance			0.7	1		μF
Ground Current	Battery Supply Current, with No Load	Shutdown		< 0.1		μA
		Normal Regulation		8	10	
		Low-Power Mode		0.5	1	
	Input Supply Current, with No Load	Shutdown		0	1	
		Normal Regulation		12	20	
		Low-Power Mode		2	5	
	Normal Mode Total Current			20	30	
	Low-Power Mode Total Current			2.5	6	
	LDO disabled Total Current			< 0.1		
Output voltage accuracy	Normal Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA to 150 mA.	– 3	–	+ 3	%
	Low power Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA to 5 mA,	– 3		+ 3	
Load Regulation ⁽²⁾	Normal Mode	VINL = VLDO + 0.3 V, VBAT = VLDO +1.5 V, IL = 0.1 mA to 150 mA		0.1		%

Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
	Low power Mode	VINL = VLDO + 0.3 V, VBAT = VLDO + 1.5 V, IL = 0.1 mA to 5 mA		0.2		
Line Regulation	Normal Mode	VINL = VLDO + 0.3 V to 5.5V, IL = 0.1 mA		0.05		%V
	Low power Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1mA		0.1		
Drop-out voltage ⁽²⁾	Normal Mode	VLDO = 3.3 V, IL = 150 mA		60	120	mV
		VLDO = 1.8 V, IL = 150 mA		150	300	
	Low power Mode	VLDO = 3.3 V, IL = 5 mA		50	100	
		VLDO = 1.8 V, IL = 5 mA		150	300	
Output load transient ⁽²⁾	Normal Mode	VINL=VLDO + 0.3V IL = 1.5 mA to150 mA, and vice versa, tr = tf = 1 μs		60	120	mV
Output line transient	Normal Mode	VINL = VLDO + 0.3 V to VLDO + 0.8 V to VLDO + 0.3 V, tr = tf = 1 μs, IL = 150 mA		5	10	mV
Power Supply Rejection Ratio (PSRR)	f = 1 kHz to 4 MHz, IL = 15 mA, VINL = VLDO + 0.3 V + 50 mVpp	1 kHz		70		dB
		10 kHz		62		
		100 kHz		40		
		1 MHz		45		
		4 MHz		55		
Output Noise	f = 10 Hz to 100 kHz, CL = 1 μF, IL = 15 mA	VLDO = 1.8 V, VINL = VLDO + 0.3 V		70		μVrms
		VLDO = 3.3 V, VINL = VLDO + 0.3 V		80		
Enable delay (ton) ⁽³⁾	Time from LDO enable-command to the output starting to slew. Required to stabilize the internal LDO bias.			10		μs
Soft start time (tsu) ⁽³⁾	From shut down to output regulations			30	100	μs
Start-up ramp rate	After enabling		–	100	–	mV/ μs
disable delay (toff) ⁽³⁾	After LDO is disabled; The LDO output voltage will discharge based on Load current (IL) and			0.1		μs

Characteristics	Test Conditions	Min.	Typ.	Max.	Unit
	CL				
Active Discharge Resistance	Output Disabled	0.05	0.08	0.15	kΩ
Active Discharge Time (tdis) ⁽³⁾	Until 10 % of VLDO		200		μs
Transition time from low power mode to normal mode (tln), and vice versa (tnl) ⁽⁴⁾	IL = 1 mA		10		μs
Clamp Active Regulation Voltage ⁽⁵⁾	Clamp Active		VLDO	+ 2.5 %	V
Thermal shutdown	Tj Rising.	–	165	–	°C
	Tj Falling	–	150	–	

2.3.2 LDO (P) 3, 10, 18, 23, 24, 25 (300 mA, PMOS)

(VBAT = 3.7 V, T_A = 25 °C, unless otherwise specified)

Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
Input voltage range (VINL) ⁽¹⁾			1.7	–	5.5	V
Under voltage Lockout	Rising, 100 mV Hysteresis			1.6	1.7	V
Battery Voltage Range	Equal or Higher than VINL		2.7	–	5.5	V
Output Voltage Range	IL = 300 mA Programmable in 50 mV steps		0.8	–	3.95	V
Default output voltage (VLDO)	LDO (P) 25	300 mA @VINL = VLDO +0.3V	–	1.2	–	V
	LDO (P) 3, 10			1.8		
	LDO (P) 18, 23			2.8		
	LDO (P) 24			3.0		
Maximum Load Current	Normal Mode		300			mA
	Low-Power Mode		5			
Output Current Limit	VOUT = 90 % of VLDO		350	500	750	mA
Minimum Output Bypass Capacitance			1.5	2.2		μF
Ground Current	Battery Supply Current, with No Load	Shutdown		< 0.1		μA
		Normal Regulation		8	10	
		Low-Power Mode		0.5	1	
	Input Supply Current, with No Load	Shutdown		0	1	
		Normal Regulation		12	20	
		Low-Power Mode		2	5	
	Normal Mode Total Current			20	30	
	Low-Power Mode Total Current			2.5	6	
	LDO disabled Total Current			< 0.1		
Output voltage accuracy	Normal Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA to 300 mA.	– 3	–	+ 3	%
	Low power Mode	VINL = VLDO + 0.3 V to 5.5 V, IL= 0.1 mA to 5 mA,	– 3		+3	
Load Regulation ⁽²⁾	Normal Mode	VINL = VLDO + 0.3 V, VBAT = VLDO + 1.5 V, IL = 0.1 mA to 300 mA		0.1		%
	Low power Mode	VINL = VLDO + 0.3 V, VBAT = VLDO + 1.5 V, IL = 0.1 mA to 5 mA		0.2		
Line Regulation	Normal Mode	VINL = VLDO + 0.3 V to 5.5V, IL = 0.1 mA		0.05		%/V

Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
	Low power Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA		0.1		
Drop-out voltage ⁽²⁾	Normal Mode	VLDO = 3.7 V, IL = 300 mA		60	120	mV
		VLDO = 1.8 V, IL = 300 mA		150	300	
	Low power Mode	VLDO = 3.3 V, IL = 5 mA		50	100	
		VLDO = 1.8 V, IL = 5 mA		150	300	
Output load transient ⁽²⁾	Normal Mode	VINL=VLDO + 0.3V IL = 1.5 mA to 300 mA, and vice versa, tr = tf = 1 μs		60	120	mV
Output line transient	Normal Mode	VINL = VLDO + 0.3 V to VLDO + 0.8 V to VLDO + 0.3 V, tr = tf = 1 μs, IL = 300 mA		5	10	mV
Power Supply Rejection Ratio (PSRR)	f = 1 kHz to 4 MHz, IL = 30 mA, VINL= VLDO + 0.3 V + 50 mVpp	1 kHz		70		dB
		10 kHz		62		
		100 kHz		40		
		1 MHz		45		
		4 MHz		55		
Output Noise	f = 10 Hz to 100 kHz, CL = 2.2 μF, IL = 30 mA	VLDO = 1.8 V, VINL= VLDO + 0.3 V		70		μVrms
		VLDO = 3.3 V, VINL = VLDO + 0.3 V		100		
Enable delay (ton) ⁽³⁾	Time from LDO enable-command to the output starting to slew. Required to stabilize the internal LDO bias.			10		μs
Soft start time (tsu) ⁽³⁾	From shut down to output regulations			30	100	μs
Start-up ramp rate	After enabling		–	150	–	mV/μs
disable delay (toff) ⁽³⁾	After LDO is disabled; The LDO output voltage will discharge based on Load current (IL) and CL			0.1		μs
Active Discharge Resistance	Output Disabled		0.05	0.08	0.15	kΩ
Active Discharge Time (tdis) ⁽³⁾	Until 10 % of VLDO			400		μs
Transition time from low power mode to	IL = 1 mA			10		μs

Characteristics	Test Conditions	Min.	Typ.	Max.	Unit
normal mode (tln), and vice versa (tnl) ⁽⁴⁾					
Clamp Active Regulation Voltage ⁽⁵⁾	Clamp Active		VLDO	+ 2.5 %	V
Thermal shutdown	Tj Rising.	–	165	–	°C
	Tj Falling	–	150	–	

2.3.3 LDO (P) 9 (400 mA, PMOS)

(VBAT = 3.7 V, T_A = 25 °C, unless otherwise specified)

Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
Input voltage range (VINL) ⁽¹⁾			1.7	–	5.5	V
Under voltage Lockout	Rising, 100 mV Hysteresis			1.6	1.7	V
Battery Voltage Range	Equal or Higher than VINL		2.7	–	5.5	V
Output Voltage Range	IL = 400 mA Programmable in 50 mV steps		0.8	–	3.95	V
Default output voltage (VLDO)	400 mA @VINL = VLDO +0.3V		–	3.0	–	V
Maximum Load Current	Normal Mode		400			mA
	Low-Power Mode		5			
Output Current Limit	VOOUT = 90 % of VLDO		450	600	750	mA
Minimum Output Bypass Capacitance			1.5	2.2		μF
Ground Current	Battery Supply Current, with No Load	Shutdown		<0.1		μA
		Normal Regulation		8	10	
		Low-Power Mode		0.5	1	
	Input Supply Current, with No Load	Shutdown		0	1	
		Normal Regulation		12	20	
		Low-Power Mode		2	5	
	Normal Mode Total Current			20	30	
	Low-Power Mode Total Current			2.5	6	
	LDO disabled Total Current			< 0.1		
Output voltage accuracy	Normal Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA to 400 mA.	– 3	–	+ 3	%
	Low power Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA to 5 mA,	– 3		+ 3	
Load Regulation ⁽²⁾	Normal Mode	VINL = VLDO + 0.3 V, VBAT = VLDO + 1.5 V, IL = 0.1 mA to 400 mA		0.1		%
	Low power Mode	VINL = VLDO + 0.3 V, VBAT = VLDO + 1.5 V, IL = 0.1 mA to 5 mA		0.2		
Line Regulation	Normal Mode	VINL = VLDO + 0.3 V to 5.5 V, IL =0.1 mA		0.05		%/V
	Low power Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA		0.1		

Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
Drop-out voltage (2)	Normal Mode	VLDO = 3.7 V, IL = 400 mA		60	120	mV
		VLDO = 1.7 V, IL = 400 mA		150	300	
	Low power Mode	VLDO = 3.3 V, IL = 5 mA		50	100	
		VLDO = 1.8 V, IL = 5 mA		150	300	
Output load transient (2)	Normal Mode	VINL=VLDO + 0.3V IL = 1.5 mA to 400 mA, and vice versa, tr = tf = 1 μs		60	100	mV
Output line transient	Normal Mode	VINL = VLDO + 0.3 V to VLDO + 0.8 V to VLDO + 0.3V, tr = tf = 1 μs, IL = 400 mA		5	10	mV
Power Supply Rejection Ratio (PSRR)	f = 1 kHz to 4 MHz, IL = 40 mA, VINL = VLDO + 0.3 V + 50 mVpp	1 kHz		70		dB
		10 kHz		62		
		100 kHz		40		
		1 MHz		45		
		4 MHz		55		
Output Noise	f = 10 Hz to 100 kHz, CL = 2.2 μF, IL = 40 mA	VLDO = 1.8 V, VINL = VLDO + 0.3V		70		μVrms
		VLDO = 3.3 V, VINL = VLDO + 0.3 V		100		
Enable delay (ton)(NOTE3)	Time from LDO enable-command to the output starting to slew. Required to stabilize the internal LDO bias.			10		μs
Soft start time (tsu) (3)	From shut down to output regulations			40	100	μs
Start-up ramp rate	After enabling		–	100	–	mV/ μs
disable delay (toff) (3)	After LDO is disabled; The LDO output voltage will discharge based on Load current (IL) and CL			0.1		μs
Active Discharge Resistance	Output Disabled		0.05	0.08	0.15	kΩ
Active Discharge Time (tdis) (3)	Until 10 % of VLDO			400		μs
Transition time from low power mode to normal mode (tln), and vice	IL = 1 mA			10		μs

Characteristics	Test Conditions	Min.	Typ.	Max.	Unit
versa (tnl) ⁽⁴⁾					
Clamp Active Regulation Voltage ⁽⁵⁾	Clamp Active		VLDO	+ 2.5 %	V
Thermal shutdown	Tj Rising.	–	165	–	°C
	Tj Falling	–	150	–	

2.3.4 LDO (N) 1, 6, 7, 15 (150 mA, NMOS)

(VBAT = 3.7 V, T_A = 25 °C, unless otherwise specified)

Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
Input voltage range (VINL) ⁽¹⁾			VLDO	–	VBAT	V
Battery Voltage Range	Equal or Higher than VINL		2.7	–	5.5	V
Output Voltage Range	IL = 150 mA Programmable in 25 mV steps		0.8	–	2.375	V
Default output voltage (VLDO)	LDO (P) 1, 6, 7, 15	150 mA @VINL = VLDO + 0.3V	–	1.0	–	V
Maximum Load Current	Normal Mode		150			mA
	Low-Power Mode		5			
Output Current Limit	VOOUT = 90 % of VLDO		180	225	270	mA
Minimum Output Bypass Capacitance			0.7	1		μF
Ground Current	Battery Supply Current, with No Load	Shutdown		< 0.1		μA
		Normal Regulation		28	40	
		Low-Power Mode		2	3	
	Input Supply Current, with No Load	Shutdown		0	1	
		Normal Regulation		2	5	
		Low-Power Mode		0	1	
	Normal Mode Total Current			30	45	
	Low-Power Mode Total Current			2	4	
	LDO disabled Total Current			< 0.1		
Output voltage accuracy	Normal Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA to 150 mA.	– 3	–	+ 3	%
	Low power Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA to 5 mA,	– 3		+3	
Load Regulation ⁽²⁾	Normal Mode	VINL = VLDO + 0.3 V, VBAT = VLDO + 1.5 V, IL = 0.1 mA to 150 mA		0.1		%
	Low power Mode	VINL = VLDO + 0.3 V, VBAT = VLDO + 1.5 V, IL = 0.1 mA to 5 mA		0.2		
Line Regulation	Normal Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA		0.05		% / V
	Low power Mode	VBAT = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA VINL = VLDO + 0.3 V		0.1		

Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
Drop-out voltage ⁽²⁾	Normal Mode	VBAT-VLDO = 2.5 V, VLDO = 1.2 V, IL = 150 mA		60	120	mV
		VBAT-VLDO = 1.5 V, VLDO = 2.2 V, IL = 150 mA		150	300	
	Low power Mode	VBAT = 3.7 V, VINL = 0, IL = 5 mA		50	100	
		VBAT = 3.7 V, VINL = 3.7, IL = 5 mA		150	300	
Output load transient ⁽²⁾	Normal Mode	VINL=VLDO + 0.3V IL = 1.5 mA to 150 mA, and vice versa, tr = tf = 1 μs		60	120	mV
Output line transient	Normal Mode	VINL = VLDO + 0.3 V to VLDO + 0.8 V to VLDO + 0.3 V, tr = tf = 1 μs, IL = 150 mA		5	10	mV
Power Supply Rejection Ratio (PSRR)	f = 1 kHz to 4 MHz, IL = 15 mA, VINL = VLDO + 0.3 V, VBAT = 3.7V + 50 mVpp	1 kHz		81		dB
		10 kHz		62		
		100 kHz		45		
		1 MHz		45		
		4 MHz		69		
Output Noise	f = 10 Hz to 100 kHz, CL = 1 μF, IL = 15 mA	VLDO = 1.0 V, VINL = VLDO + 0.3 V		50		μVrms
Enable delay (ton) ⁽³⁾	Time from LDO enable-command to the output starting to slew. Required to stabilize the internal LDO bias.			10		μs
Soft start time (tsu) ⁽³⁾	From shut down to output regulations			15	100	μs
Start-up ramp rate	After enabling		–	100	–	mV/μs
disable delay (toff) ⁽³⁾	After LDO is disabled; The LDO output voltage will discharge based on Load current (IL) and CL			0.1		μs
Active Discharge Resistance	Output Disabled		0.05	0.08	0.15	kΩ
Active Discharge Time (tdis) ⁽³⁾	Until 10 % of VLDO			200		μs
Transition time from low power mode to normal mode (tln), and vice versa (tnl) ⁽⁴⁾	IL = 1 mA			10		μs

Characteristics	Test Conditions	Min.	Typ.	Max.	Unit
Clamp Active Regulation Voltage ⁽⁵⁾	Clamp Active		VLDO	+ 2.5 %	V
Thermal shutdown	Tj Rising.	–	165	–	°C
	Tj Falling	–	150	–	

2.3.5 LDO (N) 8 (300 mA, NMOS)

(VBAT = 3.7 V, T_A = 25 °C, unless otherwise specified)

Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
Input voltage range (VINL) ⁽¹⁾			VLDO	–	VBAT	V
Battery Voltage Range	Equal or Higher than VINL		2.7	–	5.5	V
Output Voltage Range	IL=300mA Programmable in 25 mV steps		0.8	–	2.375	V
Default output voltage (VLDO)	300 mA @VINL = VLDO + 0.3 V		–	1.0	–	V
Maximum Load Current	Normal Mode		300			mA
	Low-Power Mode		5			
Output Current Limit	VOUT = 90 % of VLDO		350	500	750	mA
Minimum Output Bypass Capacitance			0.7	1		μF
Ground Current	Battery Supply Current, with No Load	Shutdown		< 0.1		μA
		Normal Regulation		28	40	
		Low-Power Mode		2	3	
	Input Supply Current, with No Load	Shutdown		0	1	
		Normal Regulation		2	5	
		Low-Power Mode		0	1	
	Normal Mode Total Current			30	45	
	Low-Power Mode Total Current			2	4	
LDO disabled Total Current			< 0.1			
Output voltage accuracy	Normal Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA to 300 mA.	– 3	–	+ 3	%
	Low power Mode	VINL = VLDO + 0.3 V to 5.5 V, IL= 0.1 mA to 5 mA,	– 3		+ 3	
Load Regulation ⁽²⁾	Normal Mode	VINL = VLDO + 0.3 V, VBAT = VLDO + 1.5 V, IL = 0.1 mA to 300 mA		0.1		%
	Low power Mode	VINL = VLDO + 0.3 V, VBAT = VLDO + 1.5 V, IL = 0.1 mA to 5 mA		0.2		
Line Regulation	Normal Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA		0.05		%/V
	Low power Mode	VBAT = VLDO + 0.3 V to 5.5 V, IL =0.1 mA VINL = VLDO + 0.3 V		0.1		

Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
Drop-out voltage ⁽²⁾	Normal Mode	VBAT-VLDO = 2.5 V, VLDO = 1.2 V, IL = 300 mA		60	120	mV
		VBAT-VLDO = 1.5 V, VLDO = 2.2 V, IL = 300 mA		150	300	
	Low power Mode	VBAT = 3.7 V, VINL = 0, IL = 5 mA		50	100	
		VBAT = 3.7 V, VINL = 3.7, IL = 5 mA		150	300	
Output load transient ⁽²⁾	Normal Mode	VINL=VLDO + 0.3V IL = 1.5 mA to 300 mA, and vice versa, tr = tf = 1 μs		60	120	mV
Output line transient	Normal Mode	VINL = VLDO + 0.3 V to VLDO + 0.8 V to VLDO + 0.3 V, tr = tf = 1 μs, IL = 300 mA		5	10	mV
Power Supply Rejection Ratio (PSRR)	f = 1 kHz to 4 MHz, IL = 30 mA, VINL = VLDO + 0.3 V, VBAT = 3.7V + 50 mVpp	1 kHz		81		dB
		10 kHz		62		
		100 kHz		45		
		1 MHz		45		
		4 MHz		55		
Output Noise	f = 10 Hz to 100 kHz, CL = 1 μF, IL = 30 mA	VLDO = 1.0 V, VINL = VLDO + 0.3 V		50		μVrms
Enable delay (ton) ⁽³⁾	Time from LDO enable-command to the output starting to slew. Required to stabilize the internal LDO bias.			10		μs
Soft start time (tsu) ⁽³⁾	From shut down to output regulations			16	100	μs
Start-up ramp rate	After enabling		–	100	–	mV/ μs
disable delay (toff) ⁽³⁾	After LDO is disabled; The LDO output voltage will discharge based on Load current (IL) and CL			0.1		μs
Active Discharge Resistance	Output Disabled		0.05	0.08	0.15	kΩ
Active Discharge Time (tdis) ⁽³⁾	Until 10 % of VLDO			200		μs
Transition time from low power mode to normal mode (tln), and	IL = 1 mA			10		μs

Characteristics	Test Conditions	Min.	Typ.	Max.	Unit
vice versa (tnl) ⁽⁴⁾					
Clamp Active Regulation Voltage ⁽⁵⁾	Clamp Active		VLDO	+ 2.5 %	V
Thermal shutdown	Tj Rising.	–	165	–	°C
	Tj Falling	–	150	–	

2.3.6 LDO (N) 2 (450 mA, NMOS)

(VBAT = 3.7 V, T_A = 25 °C, unless otherwise specified)

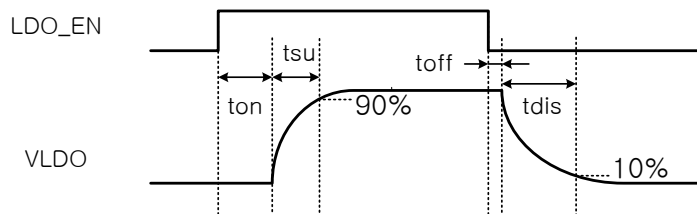
Characteristics	Test Conditions			Min.	Typ.	Max.	Unit
Input voltage range (VINL) ⁽¹⁾				VLDO	–	VBAT	V
Battery Voltage Range	Equal or Higher than VINL			2.7	–	5.5	V
Output Voltage Range	IL = 450 mA Programmable in 25 mV steps			0.8	–	2.375	V
Default output voltage (VLDO)	450 mA @VINL = VLDO + 0.3V	B5S1 & B5S2 ⁽⁶⁾	00	–	1.2	–	V
			01		1.35		
			10		1.5		
			11		1.8		
Maximum Load Current	Normal Mode			450			mA
	Low-Power Mode			5			
Output Current Limit	VOUT = 90 % of VLDO			495	765	1125	mA
Minimum Output Bypass Capacitance				0.7	1		μF
Ground Current	Battery Supply Current, with No Load	Shutdown			< 0.1		μA
		Normal Regulation			28	40	
		Low-Power Mode			2	3	
	Input Supply Current, with No Load	Shutdown			0	1	
		Normal Regulation			2	5	
		Low-Power Mode			0	1	
	Normal Mode Total Current				30	45	
	Low-Power Mode Total Current				2	4	
	LDO disabled Total Current				< 0.1		
Output voltage accuracy	Normal Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA to 450 mA.		– 3	–	+ 3	%
	Low power Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA to 5 mA,		– 3		+ 3	
Load Regulation ⁽²⁾	Normal Mode	VINL = VLDO + 0.3 V, VBAT = VLDO + 1.5 V, IL = 0.1 mA to 450 mA			0.1		%
	Low power Mode	VINL = VLDO + 0.3 V, VBAT = VLDO + 1.5 V, IL = 0.1 mA to 5 mA			0.2		
Line Regulation	Normal Mode	VINL = VLDO + 0.3 V to 5.5 V, IL = 0.1 mA			0.05		% / V
	Low power	VBAT = VLDO + 0.3 V			0.1		

Characteristics	Test Conditions		Min.	Typ.	Max.	Unit
	Mode	to 5.5 V, IL =0.1 mA VINL = VLDO + 0.3 V				
Drop-out voltage ⁽²⁾	Normal Mode	VBAT-VLDO = 2.5 V, VLDO = 1.2 V, IL = 450 mA		60	120	mV
		VBAT-VLDO =1.5 V, VLDO = 2.2 V, IL = 450 mA		150	300	
	Low power Mode	VBAT = 3.7 V, VINL = 0, IL = 5 mA		50	100	
		VBAT = 3.7 V, VINL = 3.7, IL= 5 mA		150	300	
Output load transient ⁽²⁾	Normal Mode	VINL=VLDO + 0.3V IL = 1.5 mA to 450 mA, and vice versa, tr = tf = 1 μs		60	120	mV
Output line transient	Normal Mode	VINL = VLDO + 0.3 V to VLDO + 0.8 V to VLDO + 0.3 V, tr = tf = 1 μs, IL = 450 mA		5	10	mV
Power Supply Rejection Ratio (PSRR)	f = 1 kHz to 4 MHz, IL = 45 mA, VINL = VLDO + 0.3 V, VBAT = 3.7V + 50 mVpp	1 kHz		81		dB
		10 kHz		62		
		100 kHz		45		
		1 MHz		45		
		4 MHz		69		
Output Noise	f = 10 Hz to 100 kHz, CL = 1 μF, IL = 45 mA	VLDO = 1.2 V, VINL = VLDO + 0.3 V		50		μVrms
Enable delay (ton) ⁽³⁾	Time from LDO enable-command to the output starting to slew. Required to stabilize the internal LDO bias.			10		μs
Soft start time (tsu) ⁽³⁾	From shut down to output regulations			16	100	μs
Start-up ramp rate	After enabling		—	100	—	mV/μs
disable delay (toff) ⁽³⁾	After LDO is disabled; The LDO output voltage will discharge based on load current (IL) and CL			0.1		μs
Active Discharge Resistance	Output Disabled		0.05	0.08	0.15	kΩ
Active Discharge Time (tdis) ⁽³⁾	Until 10 % of VLDO			200		μs
Transition time from low	IL = 1 mA			10		μs

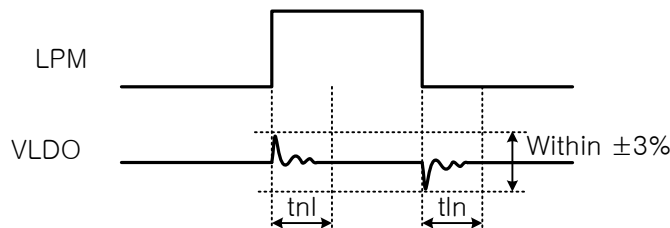
Characteristics	Test Conditions	Min.	Typ.	Max.	Unit
power mode to normal mode (tln), and vice versa (tnl) (4)					
Clamp Active Regulation Voltage (5)	Clamp Active		VLDO	+ 2.5 %	V
Thermal shutdown	Tj Rising.	–	165	–	°C
	Tj Falling	–	150	–	

NOTE:

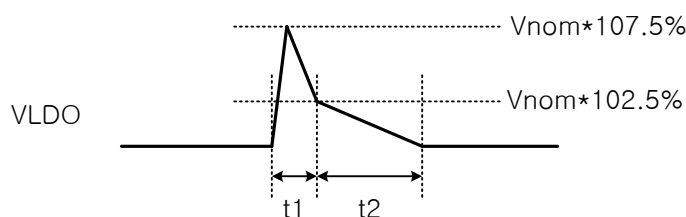
1. Input voltage range is guaranteed from VLDOs + 0.3 V to 5.5 V.
2. Performance may be different by the effect of PCB layout and external components.
3. Enable and Disable timing diagram is shown as below:



4. Transition waveforms from low-power mode to normal mode and vice versa are shown as below:



5. Over-voltage clamp operation is shown as below:



t1: discharged by active current sink (80Ω) and load current.

t2: discharged by bleeding resistor (PLDO: 750 kΩ, NLDO: 1.1 MΩ) and load current.

6. B5S1 / B5S2 control output voltage of Buck5 and LDO2 together.

2.4 Backup Coin Battery Charger

(VBATT = 3.7 V, T_A = 25 °C, unless otherwise specified)

Characteristics	Test Conditions	Min.	Typ.	Max.	Unit
-----------------	-----------------	------	------	------	------

BKCOIN					
Programmable output voltage range	Iload = 1μA	– 3 %	2.5 3.0 (Default) 3.3 3.5	+ 3 %	V
Constant current limit (CC Mode)	VCOIN short to ground	–	80 100 (Default) 200 400 600 800	–	μA
Internal programmable resistor	–	–	Bypass 1 (Default) 3 6	–	kΩ
Reverse leakage current from output (Off switch)	VBAT = 0 V, VCOIN = 3.0 V	–	–	1	μA
Regulator ground current	Iload = 1 μA (NOTE)	–	5	–	μA

NOTE: Design guidance only.

2.5 Clock and RTC

(VBATT = 3.7 V, T_A = 25 °C, unless otherwise specified)

Characteristics	Test Conditions	Min.	Typ.	Max.	Unit
32 kHz Clock Buffer					
Output high voltage	CP_32 kHz, AP_32 kHz, BT_32 kHz I _{source} = 2 mA	VDD _x -0.4	–	–	V
Output low voltage	CP_32 kHz, AP_32 kHz, BT_32 kHz I _{sink} = 2mA	–	–	0.4	V
Output duty cycle	–	45	50	55	%
RTC					
Operating voltage range	VBATT = Open	1.5	-	3.6	V
Time keeping current	VBATT = Open, BKCOIN = 3V	–	2.5	–	μA
Start up time	–	–	1	–	sec
Timing accuracy	Per day	–	2	–	sec
XTALIN/XTALOUT to GND capacitance	–	–	18 (TBD)	–	pF

NOTE: Tested with disconnecting crystal oscillator.

S5M8767A is guaranteed to meet performance spec from – 40 °C to 85 °C. Specification over the – 40 °C to 85 °C operating temperature range is not guaranteed by SEC.

3

Functional Description

3.1 Power Sequence

3.1.1 Power On Sequence

Power up event is started with active high of PWRON or active low of JIGONB or active low of ACOKB. When power boot up start event occurs (For example, when PWRON pin is on with Push button key) in power off mode (VBATT > 2.7 V), the internal timer of S5M8767A is enabled to measure time of subsequent events (For instance, PWRON high state time). If PWRON logic keep high or JIGONB and ACOKB logic keep low state until power boot up event, S5M8767A counts 16msec from Power on event and PWREN (high) signal is generated to the AP Processor and enables the Regulators sequentially. Power On/Off sequence, default On/Off regulators, and default output voltage levels can be changed with OTP (One Time Programmable) control.

Exynos4412: 23 ea Reg. ON Sequence PWRON → B7 (LDO2.0 V) → B8 (LDO1.4 V) → L1 (Alive, 1 V) → L11 (ABB1, 1.8 V) , L14 (ABB0/2, 1.8 V) → B2 (ARM, 1.1 V) → B1 (DRAM, 1.0 V) → B3 (INT, 1.0 V) → B4 (3D, 1.0 V) → L6 (MPLL, 1.0 V) , L7 (XPLL, 1.0 V) → L3 (SYS33, 1.8 V) , L4 (PRE, 1.8 V) → B5 (MEM, 1.2 V) → L2 (VDDQ_M1/2, 1.2 V) , L13 (VDDQ_C2C 1.8 V) → L5 (VDDQ_MMC1 2.8 V) , L17 (VDDQ_MMC2/3, 2.8 V) → L8 (HDMI, 1.0 V) , L15 (USB, 1.0 V) → L10 (MIPI/ADC, 1.8 V) → L16 (HSIC, 1.8 V) , L12 (USB3, UHOST, 3.0 V) → RESETB (60msec)

Power on sequence	Regulator	Note
1	Buck7	LDO2.0 V
2	Buck8	LDO1.4 V
3	LDO1	Alive, 1 V
4	LDO11 / LDO14	ABB1, 1.8 V / ABB0/2, 1.8 V
5	Buck2	ARM, 1.1 V
6	Buck1	DRAM, 1.0 V
7	Buck3	INT, 1.0 V
8	Buck4	3D, 1.0 V
9	LDO6 / LDO7	MPLL, 1.0 V / XPLL, 1.0 V
10	LDO3 / LDO4	SYS33, 1.8 V / PRE, 1.8 V
11	Buck5	MEM, 1.2 V
12	LDO2 / LDO13	VDDQ_M1/2, 1.2 V / VDDQ_C2C 1.8 V
13	LDO5 / LDO17	VDDQ_MMC1 2.8 V / VDDQ_MMC2/3
14	LDO8 / LDO15	HDMI, 1.0 V / USB, 1.0 V
15	LDO10	MIPI/ADC, 1.8 V
16	LDO16 / LDO12	HSIC, 1.8 V / USB3, UHOST, 3.0 V

3.1.1.1 Power Off Sequence

There are eight methods to Power shut down the system described as follows:

- Manual Reset Power off (MR1 & MR2 are low (After 3, 5, 7, 10 sec))
- PWRHOLD is Low when PWRON is Low & JIGONB is High (Except at WTSR = 1)
- **LDO3 is off**
- PWRON is Low & JIGONB is High when PWRHOLD is Low (Except at MR POWERON Seq.)
- At Alarm0, 1 & SMPL High, If PWRHOLD signal is not rising in 1sec
- After MR High, If PWRHOLD signal is not rising in 750ms (0.8s, 1s, and 1.6s).
- After WTSR EVENT, If PWRHOLD signal is not rising in 250msec to 1sec.
- After powering-on with active low of ACOKB, if PWRHOLD signal does not go high within 1sec.

3.1.1.2 Power On and Active Modes

The Power On event signal is needed for the system to start Power boot up sequence.

When the Power boot up sequence ends, RSOB becomes high and the system is able to control the internal block and register value by I2C. After then, if PWRHOLD signal which is active high is received from AP, the system enters active mode.

When the system enters Power on sequence, S5M8767A turns on the supplies sequentially to prevent the inrush current which can make the system unstable.

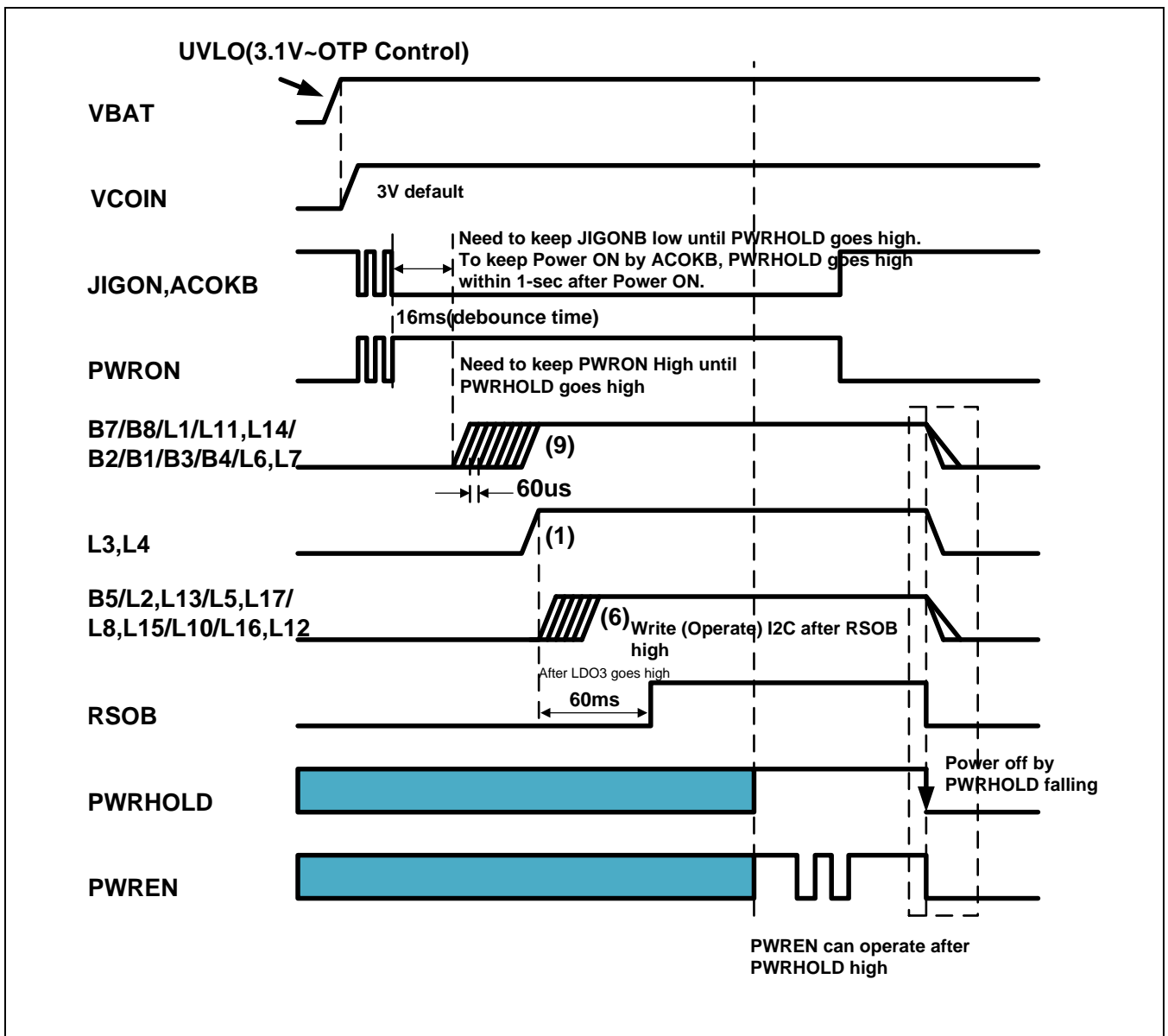


Figure 5 Power On Sequence

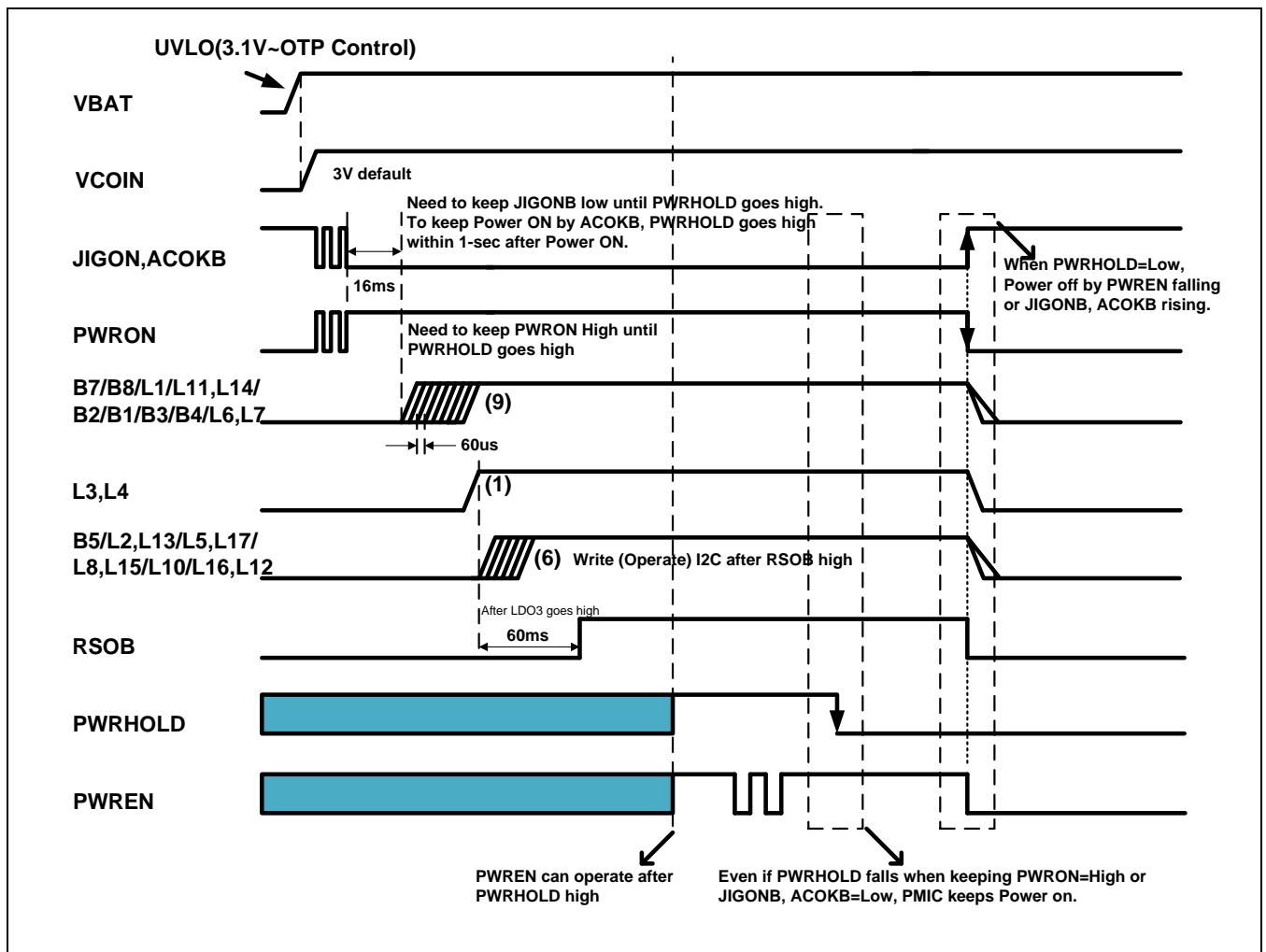


Figure 6 Power on/off Sequence

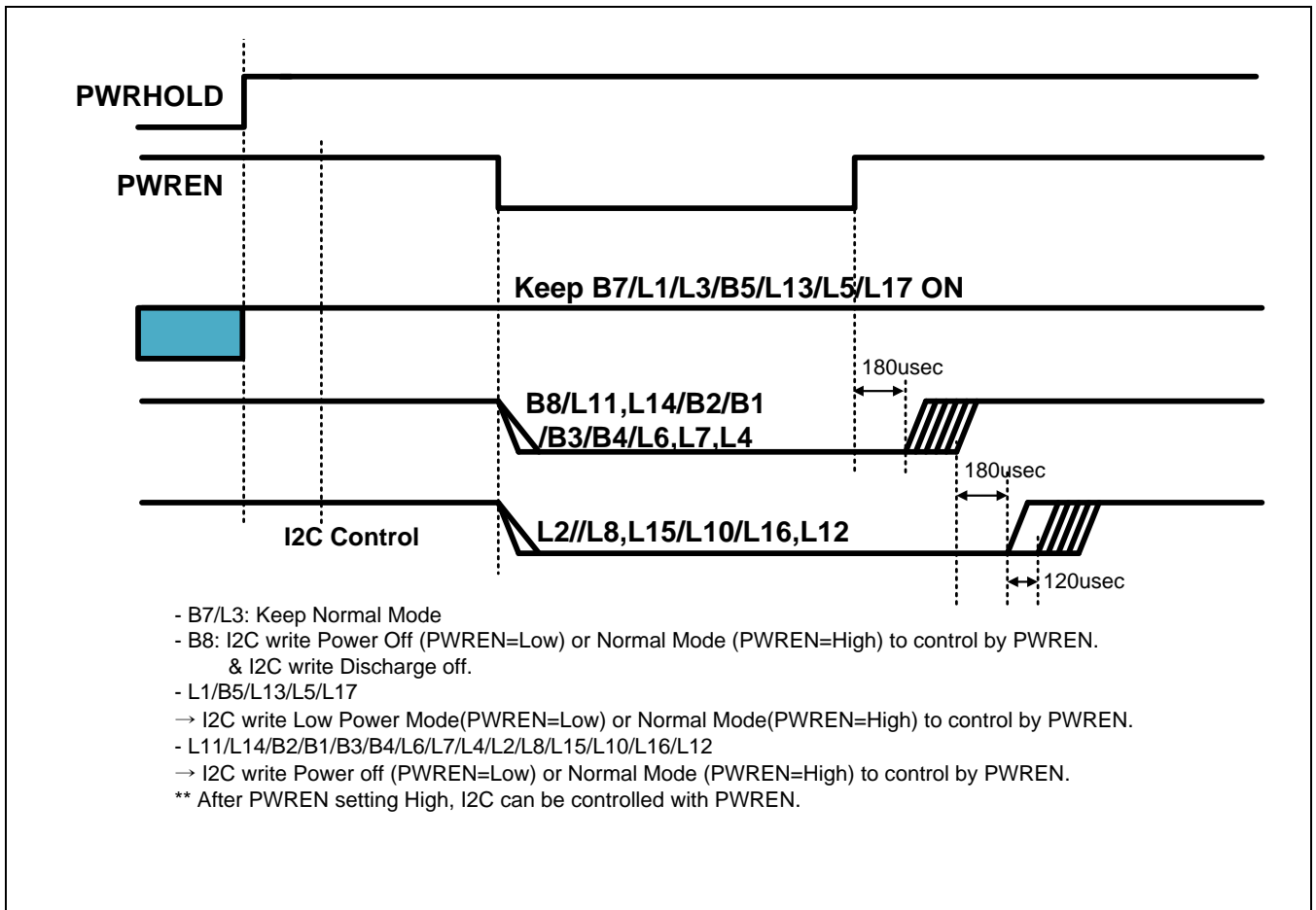


Figure 7 Sleep and Wakeup by PWREN

3.1.2 MR, SMPL, WTSR, RTC, POR, IRQB

3.1.2.1 Manual Reset Function

Manual Reset function is for Hardware reset in the Active mode. If MR1B and MR2B is kept low during the VLDO3 is active state, the system makes all internal presetting registers as default in the active mode (automatic power on sequence). If this hardware reset function is not required, connect MRB pin to high.

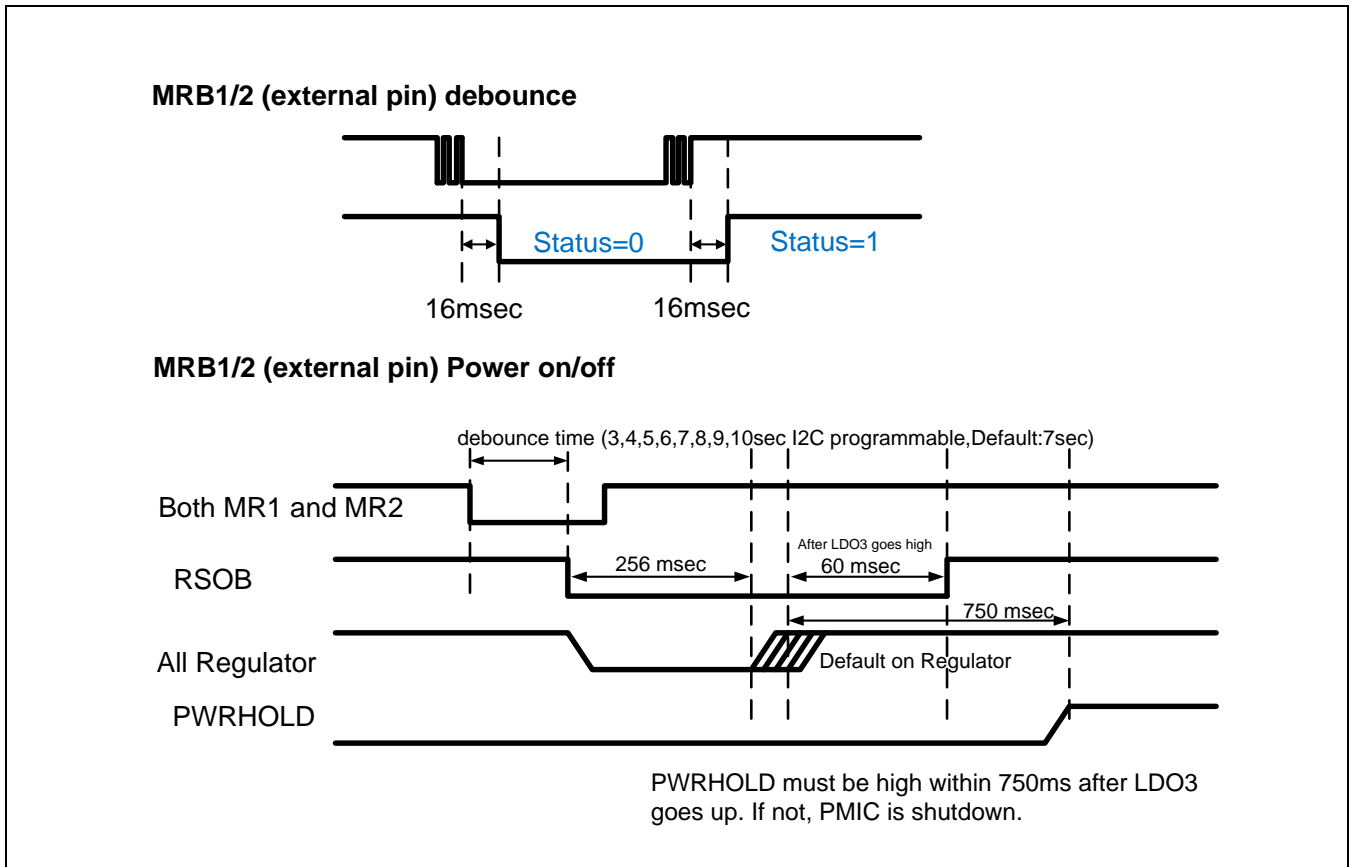


Figure 8 Manual Reset Sequence Timing Diagram

3.1.2.2 SMPL

When VBATT voltage is too low due to external causes (such as battery shock, contact problem, and so on), S5M8767A will recover by Sudden Momentary Power Loss (SMPL) circuit. SMPL is implemented by BKCOIN voltage. The SMPL value is disabled by default. This function operates when SMPL is enabled.

When the VBATT voltage drops below UVLO, the system turns on the SMPL timer (Default 0.5s). If the VBATT voltage is above the UVLO voltage within the SMPL timer operations, the system enters power on sequence and interrupt signal is generated to AP. If VBATT voltage cannot recover over UVLO voltage in SMPL timer operations, the system maintains power off sequence. The system does not monitor the VBATT voltage when SMPL is disabled.

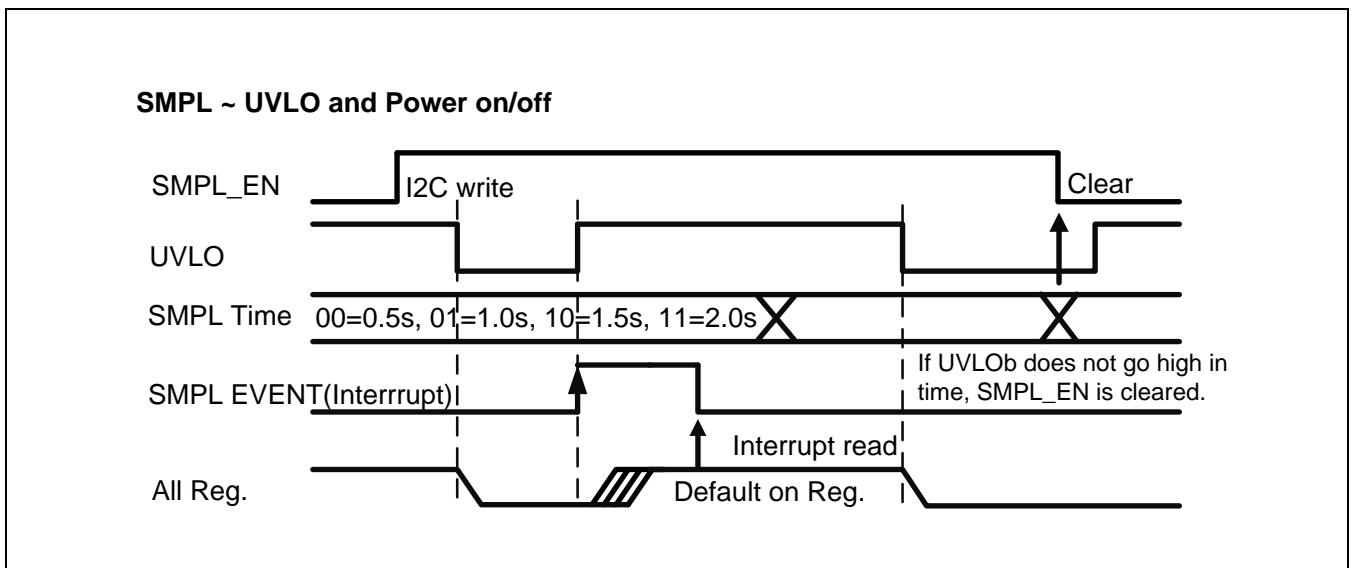


Figure 9 SMPL Timing Diagram

3.1.2.3 Watchdog Timeout

Watchdog Timeout keeps the chip on and resets the chip to its default register value (software reset).

For this operation, WTSR must be enabled (It is disabled by default). If PWRHOLD is low and the following function is started in active mode, all internal presetting register from falling edge to 60ms timer operations will be reset by the system. RSOB is set high after 60ms timer ends and interrupt signal is transferred to the AP simultaneously.

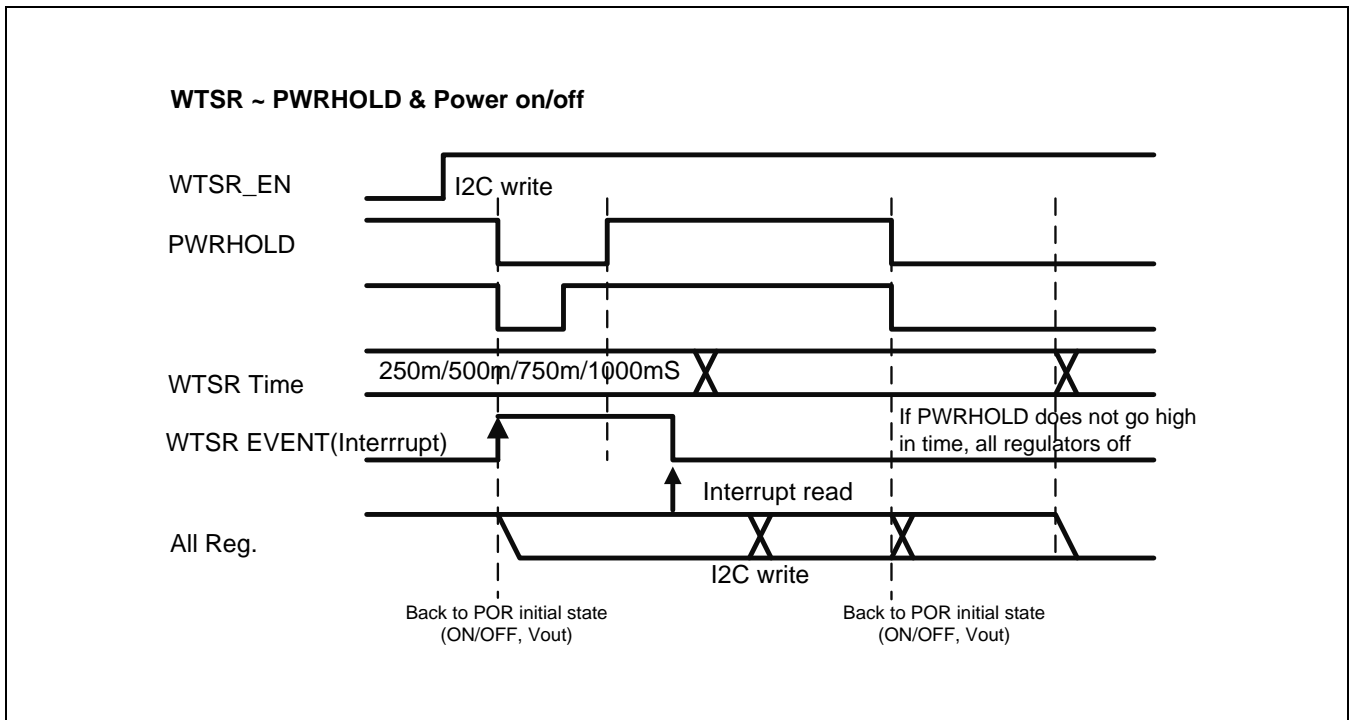


Figure 10 WTSR Timing Diagram

3.1.2.4 RTC

S5M8767A contains 8 byte timekeeping registers and two Alarm registers. The real-time clock stores time and date in a Binary Code Decimal (BCD) format. A timekeeping register comprises Century, Year, Month, Day, Date, and Hour (12/24 mode selectable). Each of these data can be read/write.

Alarm register is divided into Alarm threshold register and Alarm Configuration register. When it reaches the time threshold, the interrupt signal by configuration register will be delivered to the AP. When system is in off mode, the alarm can wake up (Turn on) by Alarm Wake up sequence.

3.1.2.5 RTC Alarm Power on Mode

S5M8767A has two Alarm interrupts used by RTC. The Alarm operates Power on sequence at a designed time.

3.1.2.6 Power on Reset (POR) Function

Power On Reset for I2C occurs when S5M8767A turns off or PWRHOLD = Low which puts the PMIC into shutdown and clears all previously programmed output voltages in the internal registers.

3.1.2.7 Interrupt Request (IRQB)

S5M8767A provides the power supply to system and checks the events that occur in the system. It sends the information of events to the AP through IRQB pin and I2C bus.

When any event occurs at S5M8767A, it generates the interrupt signal and writes the information to the corresponding register. In addition, S5M8767A also informs about the occurrence of events to the AP by pulling down IRQB pin (Active low). When IRQB pin is pulled down, the AP reads interrupt register in S5M8767A. After reading the interrupt register, the AP must reset the interrupt register (write "0") for further interrupt generation.

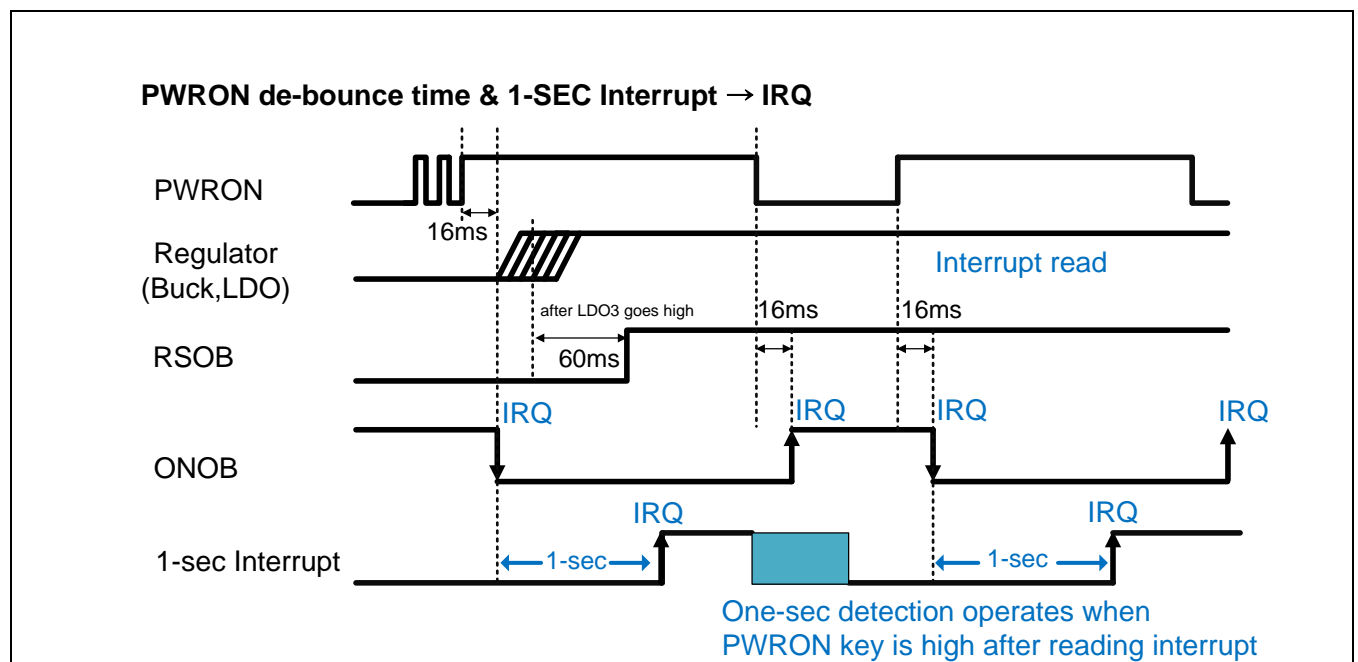


Figure 11 Power On Debounce and Interrupt

3.2 UVLO, Reference Voltage, Thermal Shutdown

S5M8767A contains Under-Voltage Lock Out (UVLO). The thermal protection limits total power dissipation. Reference block supplies voltage reference for regulators and internal block, and it has a noise filter to suppress voltage fluctuation.

3.2.1.1 Under-Voltage Lock Out (UVLO)

The UVLO circuit for the S5M8767A prevents the device from malfunctioning at low-input voltages and from excessive discharge of the battery. As VBAT voltage is under UVLO threshold, the S5M8767A enters into UVLO state which forces the device to a inactive state until the VBAT is high enough to allow the device to operate normal function.

The UVLO voltage level are 3.1 V rising and 2.55 V falling (hysteresis 550 mV), respectively. In case the VIN voltage rises over 3.1 V, S5M8767A including all regulators starts to operate from lockout state and if the VBAT voltage falls under 2.55 V, S5M8767A is turned off.

3.2.1.2 Reference Voltage and Thermal Shutdown

When VBATT is applied, UVLO, Reference Voltage (VREF), and BKCOIN start to work. VREF generates 0.8V output and no current can be loaded from VREF for external use. Loading any current from this node can drop the voltage in reference and LDO output. VREF needs an external bypass capacitor (over 100nF) for noise reduction.

Thermal overload protection in each regulator limits total power dissipation in S5M8767A which shut downs corresponding regulator at a die temperature of 160 °C above and turns it on with a down hysteresis of 20 °C.

3.3 Regulator

3.3.1 Buck Converters

S5M8767A contains high efficiency 9 buck converters ranging from 1.5 A to 5 A of maximum output current driving capacity. Each Buck converter has a forced PWM (FPWM) and AUTO mode operation which enable mode transition to achieve high efficiency according to driving current range. It operates in PWM mode under heavy loads and saves power dissipation at light loads by less switching in PFM operation.

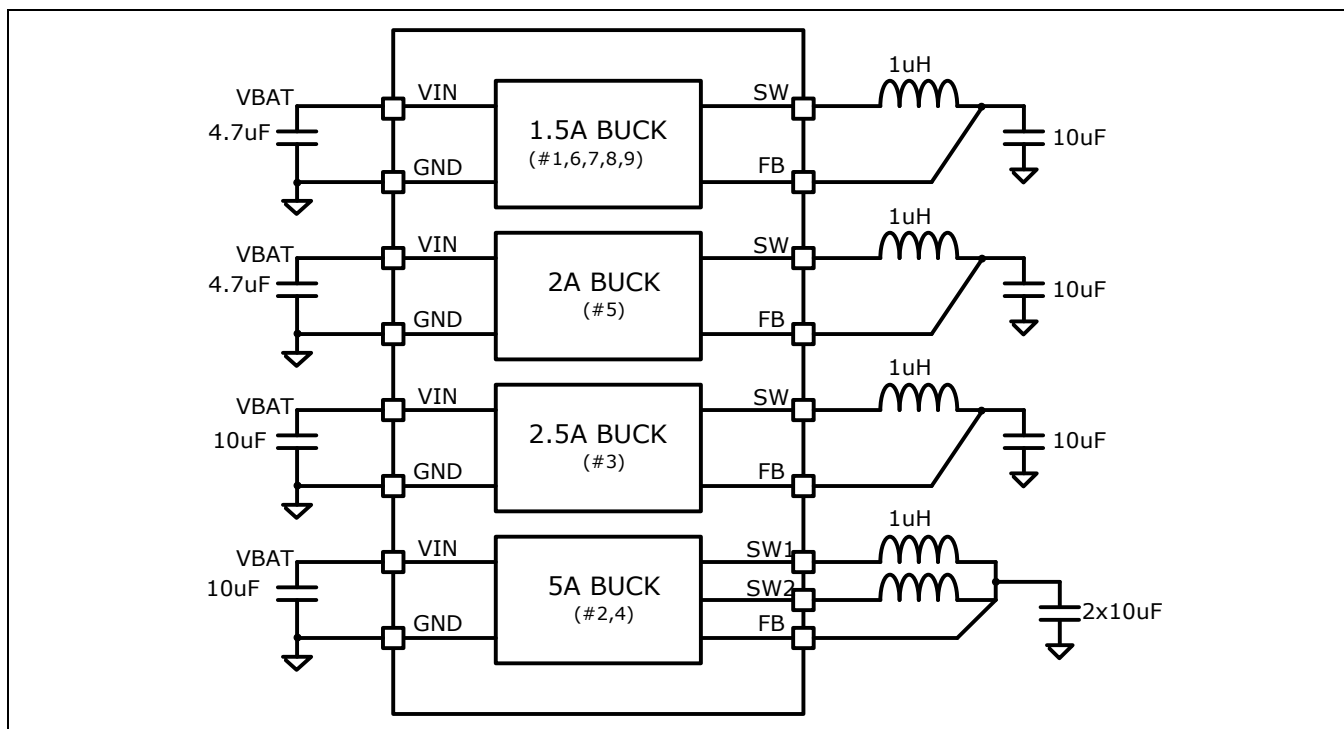


Figure 12 Buck Converter Block Diagram

Soft-start operation is integrated to protect the chip from the in-rush current. In power-on sequence, output voltage is increased with a 30 mV/ μ s ramp slope. Delay time for calibration must be needed before soft start operation; therefore the total start time which depends on output target voltage including calibration and soft start period for 1V output voltage after enabling Buck converter is approximately 60 μ s.

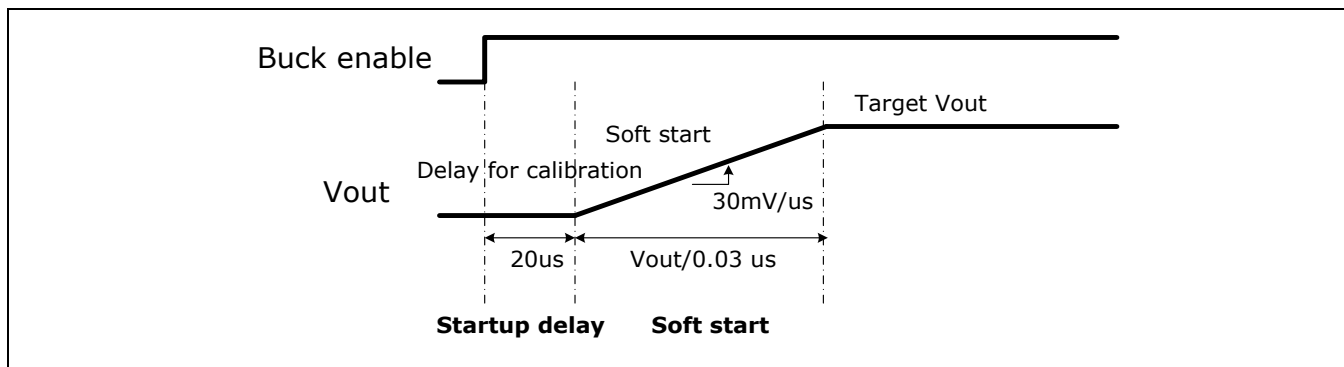


Figure 13 Power On Sequence in Buck Converter

Each Buck provides a wide range of output voltage which is controlled by Dynamic Voltage Scale (DVS) function which has 8 bits of output voltage control. Buck 1, Buck 5 and Buck 6 have a controllable output voltage range from 0.65 V to 2.24 V. Buck 2, Buck 3 and Buck 4 have a controllable output voltage range from 0.6 V to 1.6 V. Buck 7, Buck 8 and Buck 9 have a controllable output voltage range from 0.65 V to 3.3 V (3.0 V for Buck 7/8). Ramp slope can be controlled from 1 mV/ μ s to 100 mV/ μ s using 4 bits.

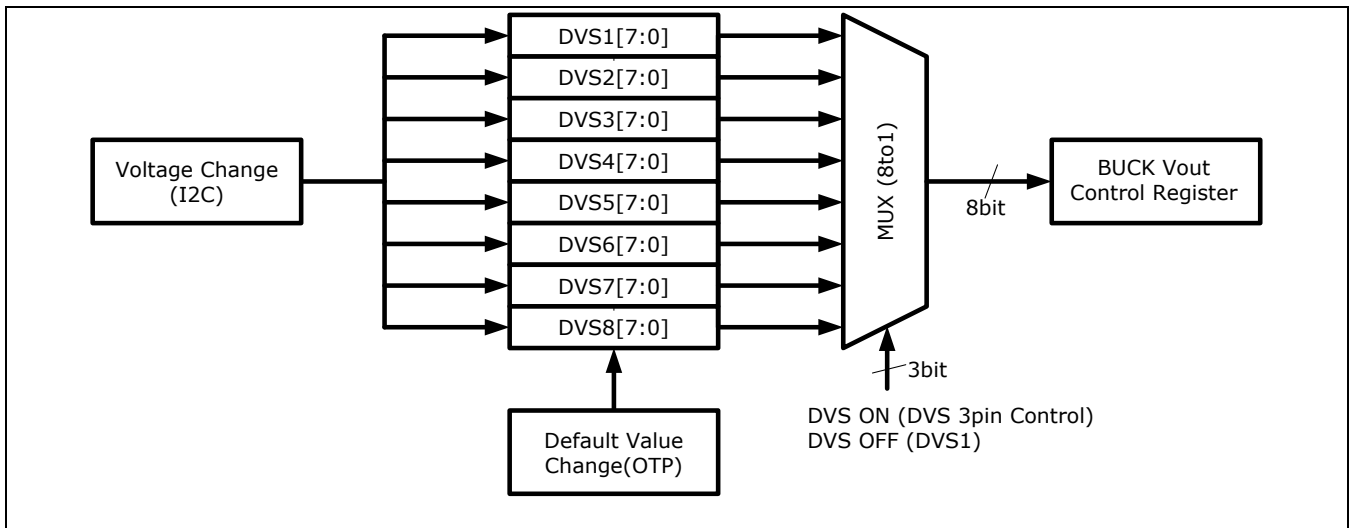


Figure 14 Buck2/3/4 DVS Control

Remote Sense function is integrated in order to compensate voltage drop by parasitic resistance across PCB traces in high current. Regulated voltage is required to maintain precision in the regulation. In case of using remote sense function, connect Remote sense pin as shown in below figure (a). If remote sense is not required, remote sense function can be disabled using I2C control in software method shown in figure (a) or RSP must be directly connected to the ground and RSN must be connected to the VBAT in hardware method shown in figure (b).

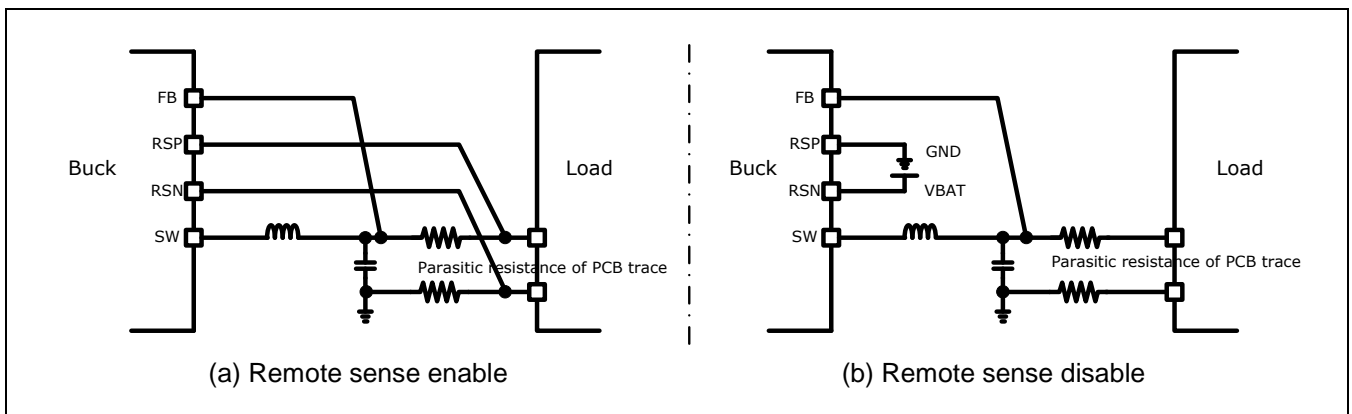


Figure 15 Remote Sense Pin Connection

The dual phase scheme approach offers improved response time, superior ripple cancellation, and thermal distribution. The switching of each channel is timed to be symmetrically out of phase. As a result, a combined ripple frequency of the dual phase buck converter is twice the frequency of single phase buck converter, whereas the peak to peak amplitude of the combined inductor currents for the dual phase buck converter is reduced.

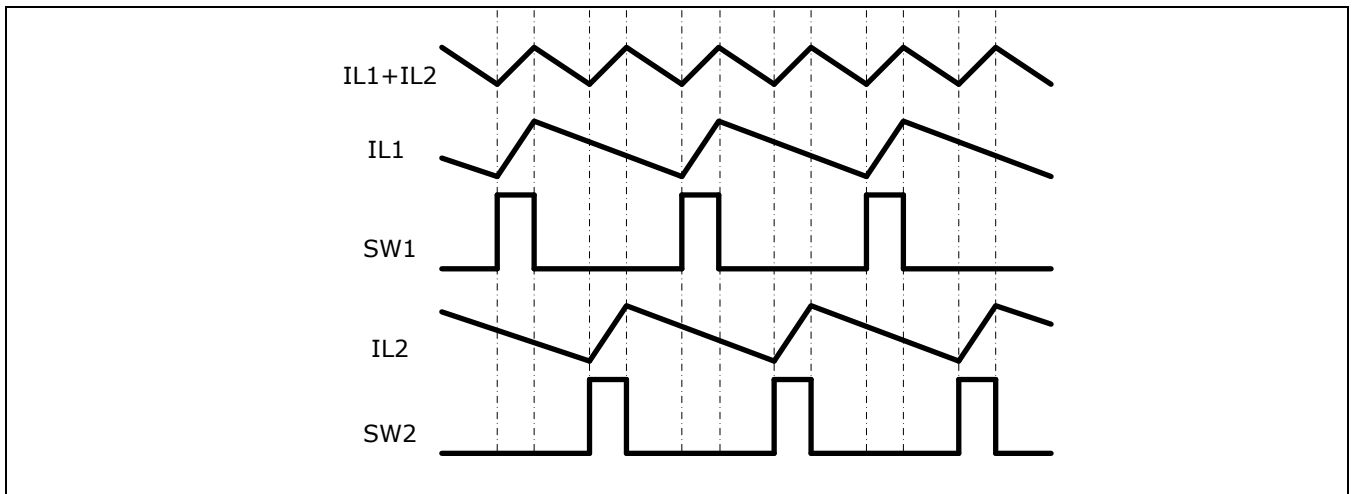


Figure 16 SW Node Voltage and Inductor Current Waveforms in Dual Phase Buck Converter

For Buck 5 converter and LDO2, the default output voltage setting can be set using B5S1 and B5S2 GPIOs which depend on set application.

The low power mode using an internally integrated LDO for Buck 5 converter during sleep mode operation is available up to 5 mA current capability. When Buck5 converter operation is changed between normal mode and low power mode, the delay is needed to reduce the glitch. In detail, the delay for the bias settling time of LDO is needed during the transition from normal mode to low power mode, while the soft start time of Buck 5 converter is required during the transition from low power mode to normal mode.

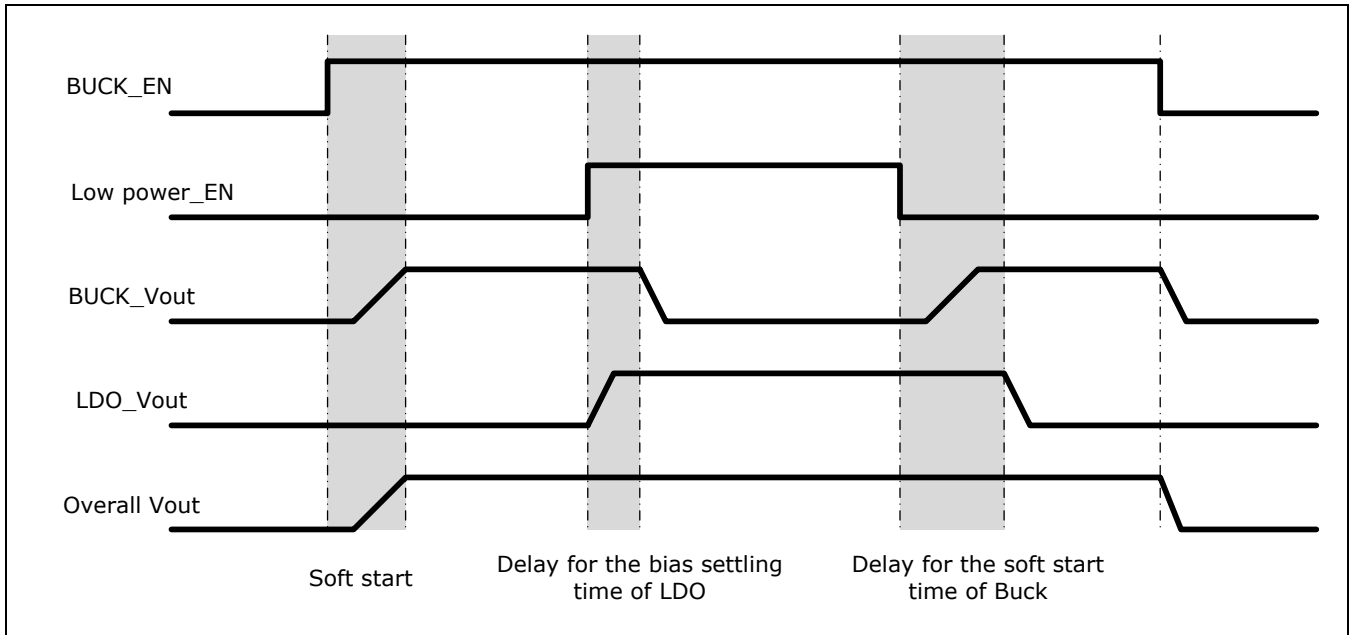


Figure 17 Mode Transition Waveforms in Buck 5

3.3.1.1 Inductor Selection

The inductor can be chosen with two main considerations which include its DC resistance (DCR) and saturation current. Since the inductor value has a significant impact on the ripple current and output voltage ripple, it should be carefully considered. A 1.0 μH inductor with a saturation current of at least 2 A to 2.5 A is strongly recommended for high load capacity buck converters (Buck2/3/4/5) with a full load. For medium load capacity buck converters (Buck1/6/7/8/9), a slightly smaller size is allowed. Also, inductor rated current can be reduced with lower DCR. For maximum efficiency, the inductor's DCR should be as low as possible.

NOTE: The inductor type and core materials are different among several manufacturers and affect the converter efficiency. See [Table 1](#) for suggested inductors and their manufacturers. You may choose other manufacturers' inductors with similar inductor value and DCR.

Table 1 List of Recommended Inductors

Model Number	Inductor Value (μH)	Vendor	Dimension L x W x H (mm)	Max. IDC (A)	Max. DCR (m Ω)
1.0 μH Multi-Layer Chip or Metal Alloy Type Power Inductor for Buck2/3/4/5 (High Load Capacity)					
DFE252010C	1.0	TOKO	2.5 x 2.0 x 1.0	3.0	60
CIG22H1R0MAE	1.0	SEM	2.5 x 2.0 x 0.9	2.3	65
TFM252010A-1R0M	1.0	TDK	2.5 x 2.0 x 1.0	2.5	65
LQM2HPN1R0NGHL07	1.0	Murata	2.5 x 2.0 x 0.9	2	100
DFE252012C	1.0	TOKO	2.5 x 2.0 x 1.2	3.8	59
1.0 μH Multi-Layer Chip Type or Metal Alloy Power Inductor for Buck1/6/7/8/9 (Medium Load Capacity)					
DFE201610C	1.0	TOKO	2.0 x 1.6 x 1.0	2.0	80
MDT2012-CR1R0N	1.0	TOKO	2.0 x 1.2 x 1.0	2.15	80
CIG21L1R0MNE	1.0	SEM	2.0 x 1.2 x 1.0	1.15	110
MLP2012L1R0M	1.0	TDK	2.0 x 1.2 x 1.0	1.2	100
LQM2MPN1R0MG0	1.0	Murata	2.0 x 1.6 x 1.0	1.4	55

3.3.1.2 Capacitor Selection

Ceramic capacitors are used for most linear regulators' and switching converters' input and output filters. Low equivalent series resistance (ESR) ceramic capacitors should be chosen as output filter capacitors and input filter capacitors. Since X5R or X7R ceramic capacitors maintain their capacitance over a wide voltage range and temperature range, X5R or X7R ceramic capacitors are strongly recommended.

3.3.1.3 Output Capacitors

The output ripple voltage depends upon the charging and discharging of output capacitor and depends upon the ESR too. A X5R or X7R type of 10 μF ceramic output capacitor with low ESR is recommended for linear regulators and switching converters. This keeps the output ripple voltage small and ensures good transient response for converter with loop stability over a wide operating temperature range and voltage.

3.3.1.4 Input Capacitors

A ceramic input capacitor is used to improve the input voltage filtering. For instance, a ceramic input capacitor of 1 μF to 4.7 μF with low ESR is sufficient for linear regulator and switching converter input voltage. It provides noise filtering of the input voltage spikes. The impedance of input capacitor should be kept low at the switching frequency. If a lower capacitor is used, ringing can appear at the supply pin (ringing can cause loop instability or even damage the part). You can choose other manufacturers' capacitors with similar value and low ESR, as shown in [Table 2](#).

Table 2 List of Recommended Capacitors

Model Number	Type	Vendor	Dimension Inch (mm)	Voltage Rating (V)
1.0 μF for CIN, COUT				
CL05A105KP5NNNC	Ceramic, X5R	SEM	0402 (1005)	10
GRM155R61A105KE15	Ceramic, X5R	Murata	0402 (1005)	10
JMK105BJ105MV	Ceramic, X5R	Taiyo Yuden	0402 (1005)	6.3
2.2 μF for CIN, COUT				
CL05A225KO5NQNC	Ceramic, X5R	SEM	0402 (1005)	16
CL05A225MP5NSNC	Ceramic, X5R	SEM	0402 (1005)	10
C1005X5R1A225K	Ceramic, X5R	TDK	0402 (1005)	10
4.7 μF for COUT				
C1005X5R0J475M	Ceramic, X5R	TDK	0402 (1005)	6.3
CL05A475KP5NRNC	Ceramic, X5R	SEM	0402 (1005)	10
GRM155R61A475M	Ceramic, X5R	Murata	0402 (1005)	10
10 μF for COUT				
GRM155R61A106M	Ceramic, X5R	Murata	0402 (1005)	6.3
JMK107BJ106MA	Ceramic, X5R	Taiyo Yuden	0603 (1608)	6.3
22 μF for COUT				
GRM188R60J226M	Ceramic, X5R	Murata	0603 (1608)	6.3
JMK212BJ226MG	Ceramic, X5R	Taiyo Yuden	0805 (2012)	6.3

3.3.2 LDOs

Twenty eight LDOs consisted of 22 PLDOs (PMOS-type LDO) and 6 NLDOs (NMOS-type LDO) are integrated into S5M8767A. PLDOs are mainly used for the high output voltages ranging from 0.8 V to 3.95 V with a 50mV step. Their maximum output current driving capacities are 150 mA, 300 mA, and 400 mA. PLDO structure is depicted as below figure.

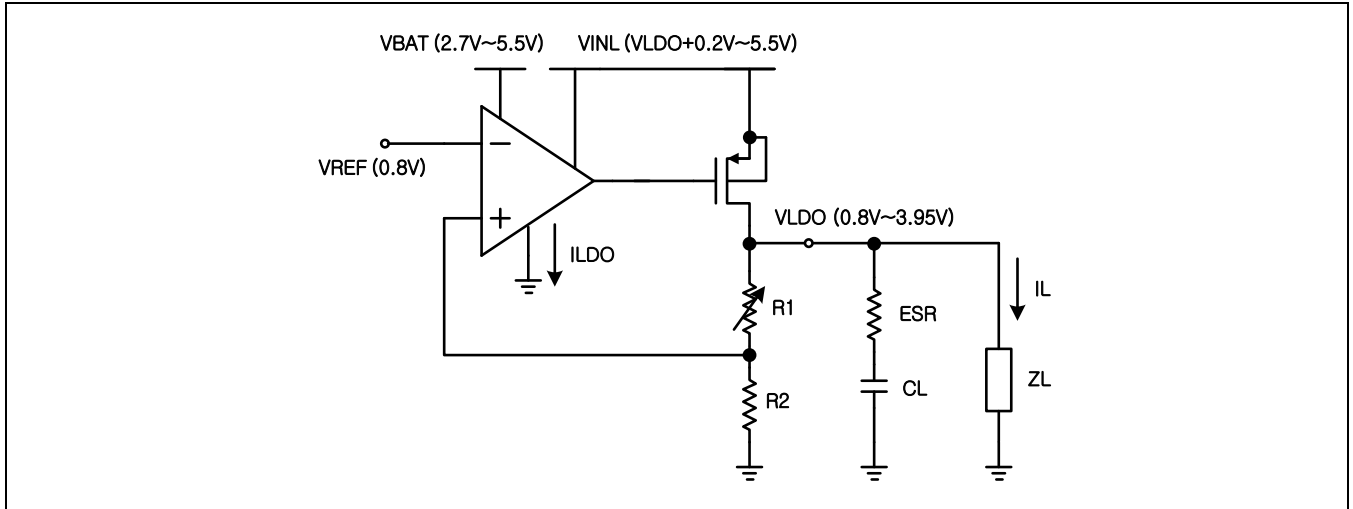


Figure 18 PLDO (Low-Dropout Regulator having a PMOS Power Transistor)

Power efficiency of LDO is given by

$$\eta = \frac{\text{power(output)}}{\text{power(input)}} \times 100\% = \frac{VLDO \cdot IL}{VINL \cdot (IL + ILDO)} \times 100\% \approx \frac{VLDO}{VINL} \times 100\%$$

where, VLDO is the LDO output voltage, IL is output load current, ILDO is the current consumed by LDO itself, and VINL is the power supply for the power transistor. Despite of many advantages, one critical drawback of LDO is low power efficiency especially in case of heavy load and low voltage output.

The approximate estimation example of power efficiency with and without 1.2 V sub-regulation buck converter (Buck converter + NLDO and PLDO)

LDO only : $(1/3.7) \times 100 \% = 27 \%$

Buck + LDO : $0.8 \text{ (Buck efficiency)} \times (1/1.2) \times 100 \% = 66.7 \%$

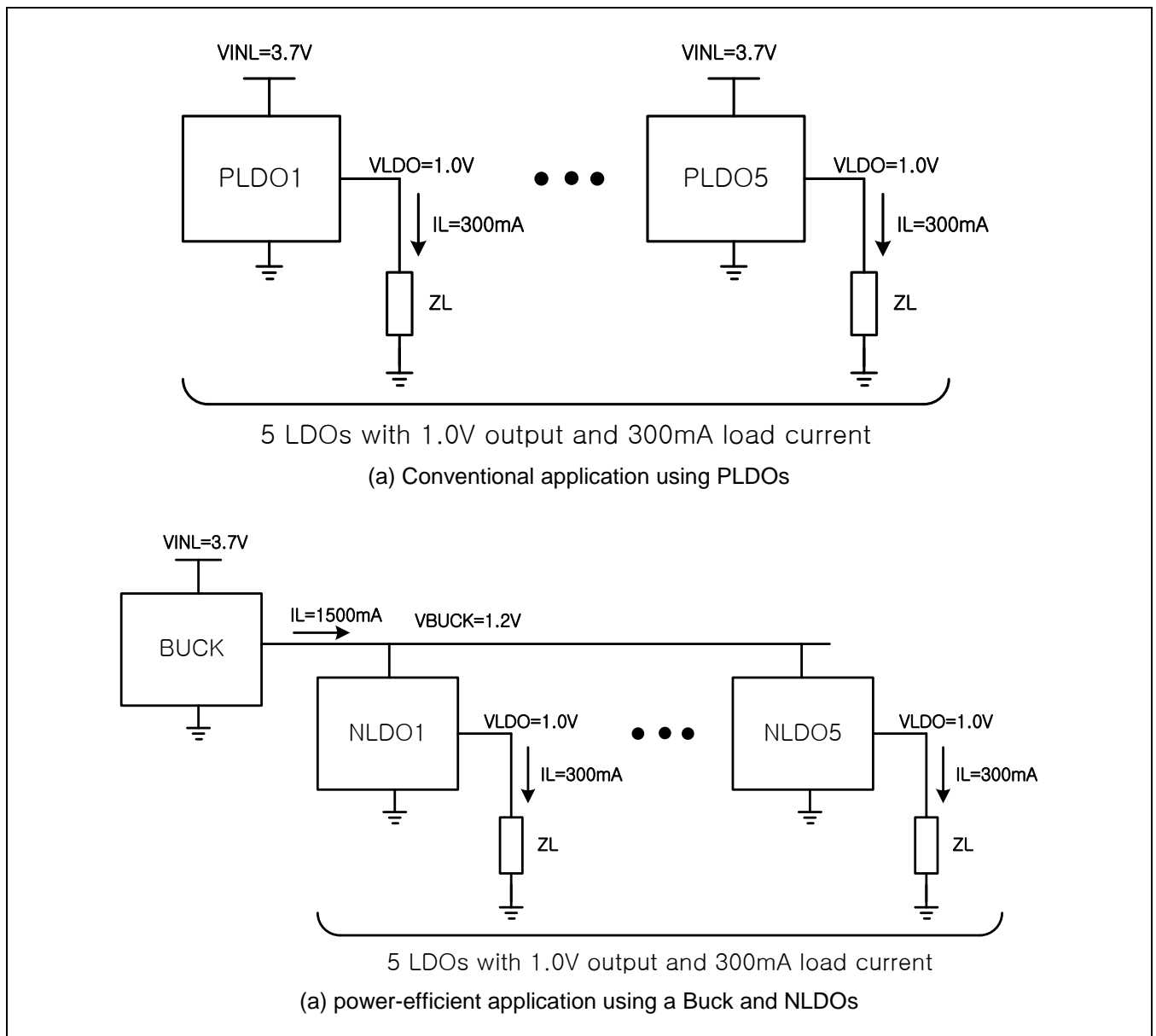


Figure 19 Application Example

To overcome the low power efficiency, N-type LDOs which are powered from sub-regulation buck converter are recommended for the low output voltages ranging from 0.8 V to 2.375 V with 25 mV step. Their maximum output current driving capacities are 150 mA, 300 mA, and 450 mA. NLDO structure is shown as below figure.

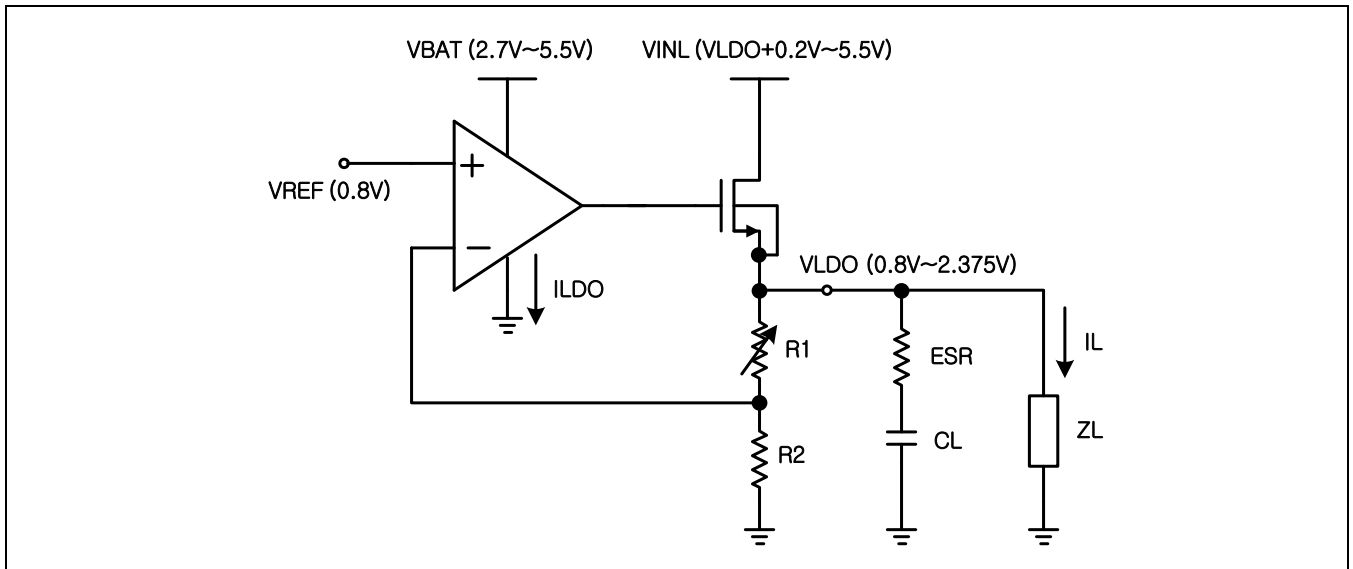


Figure 20 NLDO (Low-Dropout Regulator having a NMOS Power Transistor)

Both PLDO and NLDO support normal and low power modes alternatively. In normal-mode operation, PLDO or NLDO guarantees output voltage regulation between 150 mA and 450 mA depending on their capacity. In low-power-mode operation, it guarantees output voltage supplying maximum 5 mA. Each LDO requires an external capacitor of X5R and X7R type MLCC. The capacitor value from 1 uF to 2.2 uF depending on its capacity is needed to guarantee good stability.

In case of LDO4, LDO18, and LDO23, AP can control to turn on and off each of them directly using its GPIOs which are connected to LDO4EN, LDO19EN, and LDO23EN pins when using PWREN coupled with LDOxEN. Using LDO_EN [7:6] control bits, LDO output mode can be controlled as below.

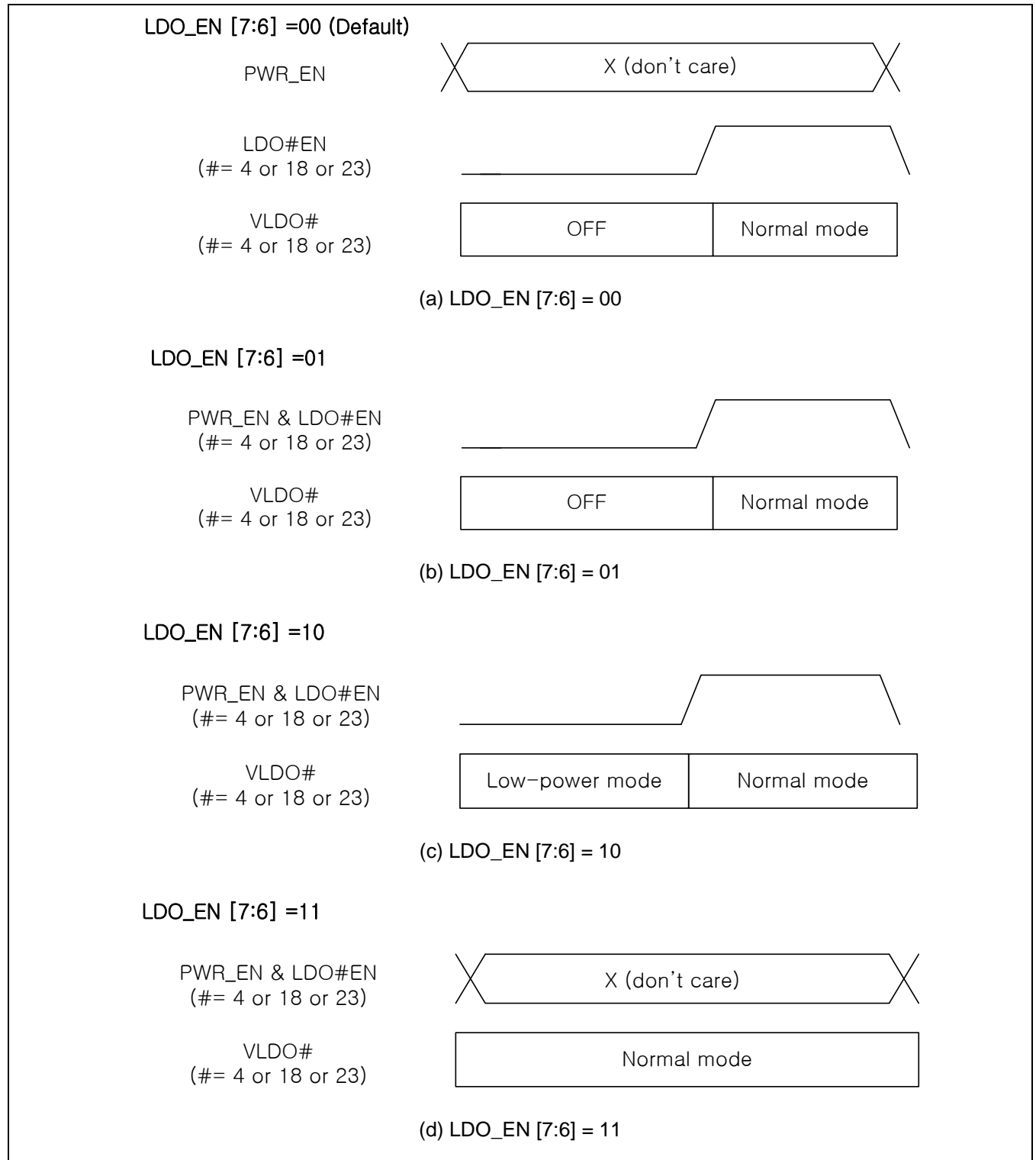


Figure 21 Mode Control Waveforms in LDO4,LDO18 and LDO 23

Table 3 Information of Power Supply on Each LDO

LDO	Default Voltage	Max. Current	Voltage Range/Step (I2C)	Purpose_AP, Peri (NOTE)
LDO1	1.0 V	150 mA	0.8 V to 2.375 V, 25 mV step	Alive
LDO2	1.2 V	450 mA		VDDQ_M1/M2
LDO3	1.8 V	300 mA	0.8 V to 3.95 V, 50 mV Step	E, SBUS, GPIO, MIPIHSI, RTC, CKO, SYS33
LDO4	1.8 V	150 mA		VDD_PRE
LDO5	1.8 V	150 mA		VCC_18_IO
LDO6	1.0 V	150 mA	0.8 V to 2.375 V, 25 mV step	VDD10_MPLL
LDO7	1.0 V	150 mA		VDD10_VPLL ,EPLL,APLL
LDO8	1.0 V	300 mA		VDD10_HDMI, HDMI_PLL, MIPI, MIPI_PLL, MIPI2L
LDO9	3.0 V	400 mA	0.8 V to 3.95 V, 50 mV Step	VDD33_EFNAND
LDO10	1.8 V	300 mA		VDD18_HDMI_OSC , MIPI, MIPI2L,ADC,TS
LDO11	1.8 V	150 mA		VDD18_ABB1
LDO12	3.0 V	150 mA		VDD33_UOTG
LDO13	1.8 V	150 mA		VDDQ_C2C
LDO14	1.8 V	150 mA		VDD18_ABB0, ABB2
LDO15	1.0 V	150 mA	0.8 V to 2.375 V, 25 mV step	VDD10_HSIC, UOTG
LDO16	1.8 V	150 mA	0.8 V to 3.95 V, 50 mV Step	VDD18_HSIC
LDO17	2.8 V	150 mA		VDDQ_MMC01/MMC2
LDO18	2.8 V	300 mA		VDDF_eMMC
LDO19	3.0 V	150 mA		Cam_AF
LDO20	3.0 V	150 mA		VCC-LCD
LDO21	3.0 V	150 mA		Haptic Motor Driver
LDO22	3.3 V	150 mA		IRDA (LEDA)
LDO23	2.8 V	300 mA		T-Flash
LDO24	3.0 V	300 mA		Touch
LDO25	1.2 V	300 mA		Cam Sensor
LDO26	1.8 V	150 mA		CAM ISP
LDO27	1.8 V	150 mA		VT Cam
LDO28	1.8 V	150 mA		CAM_ISP_MIPI

NOTE: Samsung Application Processor is recommended.

3.4 Backup Coin Battery

3.4.1 Backup Coin Battery

The backup coin battery charger is a voltage limited current source with a 1 k Ω output resistor. This charger is always on regardless of power on/off status (except if the main battery voltage is below UVLO). Backup Charger has an I2C controlled output voltage from 2.5 V to 3.5 V with a default output voltage of 3.0 V. This charger can also support a super capacitor.

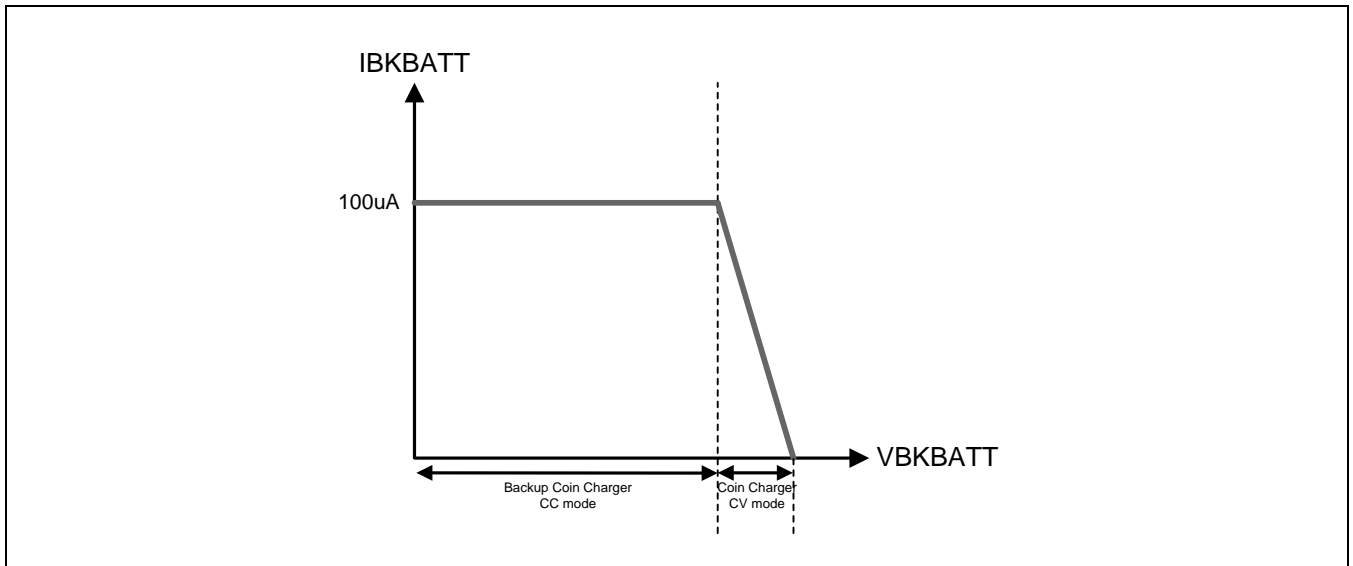


Figure 22 Backup Coin Battery Charging Graph

4

Digital Interface (I2C)

S5M8767A is controlled through the I2C interface. The operational mode in S5M8767A is set by the I2C. Read and Write modes are also supported. S5M8767A is activated only as a slave mode.

Access Mode	Host (Master)	S5M8767A (Slave)
Write	Transmitter	Receiver
Read	Receiver	Transmitter

4.1 Slave Address

Slave address is used to select the S5M8767A on the I2C bus. This address consists of 8-bit data. The LSB 1-bit determines the read or write mode. If the LSB 1-bit is low, the write mode is selected.

Section	Address selection	Access Mode
PM section	1100 1100 (0xCC)	PM Write
	1100 1101 (0xCD)	PM Read
RTC section	0000 1100 (0x0C)	RTC Write
	0000 1101 (0x0D)	RTC Read

4.2 Register Address

4.2.1 I2C Interface

4.2.2 Control Interface using SCL (Clock) and SDA (Data)

In multi bytes write mode, the destination address of transferred data is selected by the Register Address (RA). Each of the register addresses for data should not be transferred, since the register address for the multi bytes data will be automatically increased by 1 until the STOP state.

In multi bytes read mode, the source address of transferring data is selected by the RA. Each of the register addresses for data should not be transferred, since the register address for the multi bytes data will be automatically increased by 1 until the STOP state.

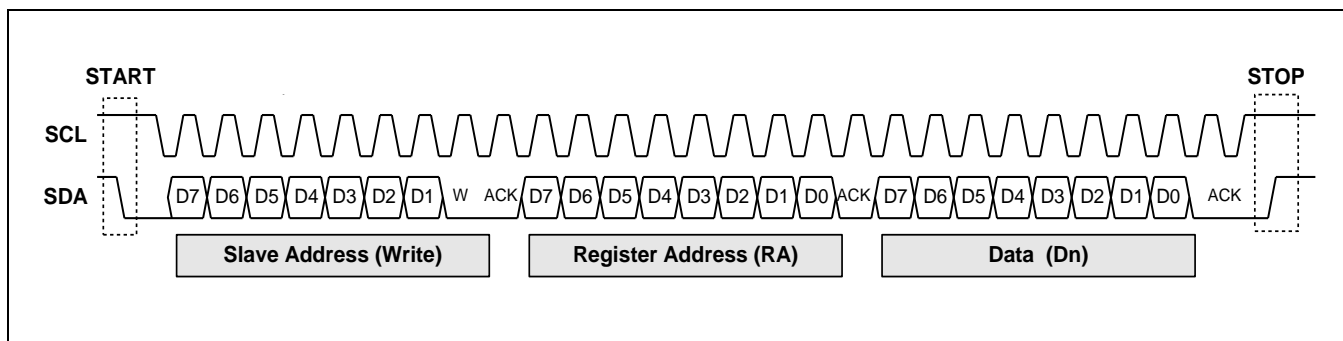


Figure 23 Single Byte Write Mode

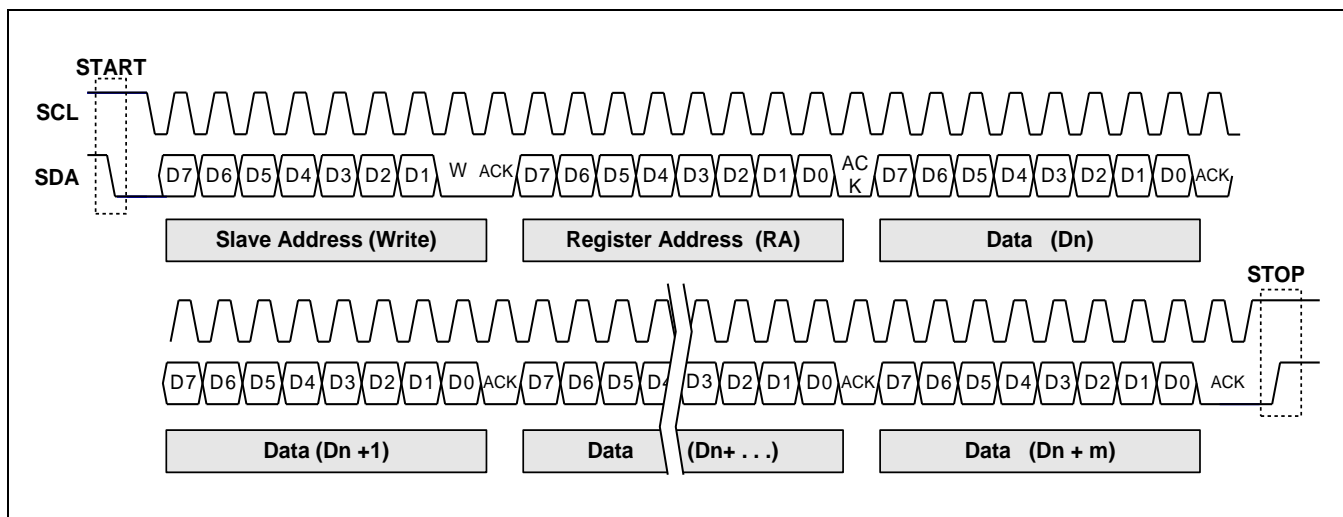


Figure 24 Multi Bytes Write Mode

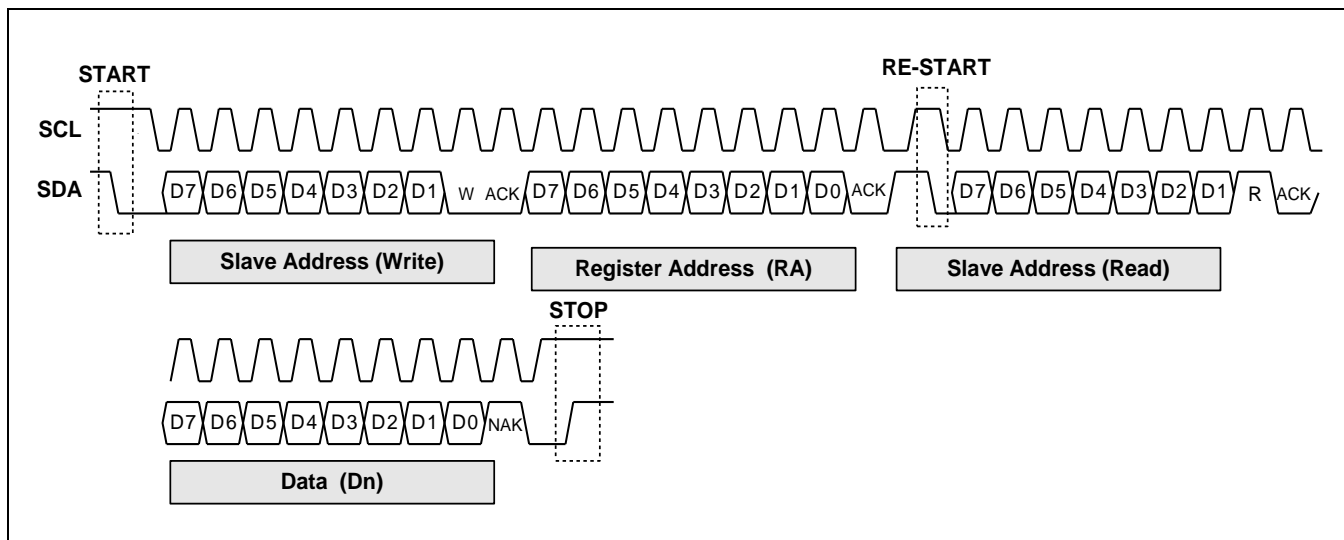


Figure 25 Single Byte Read Mode

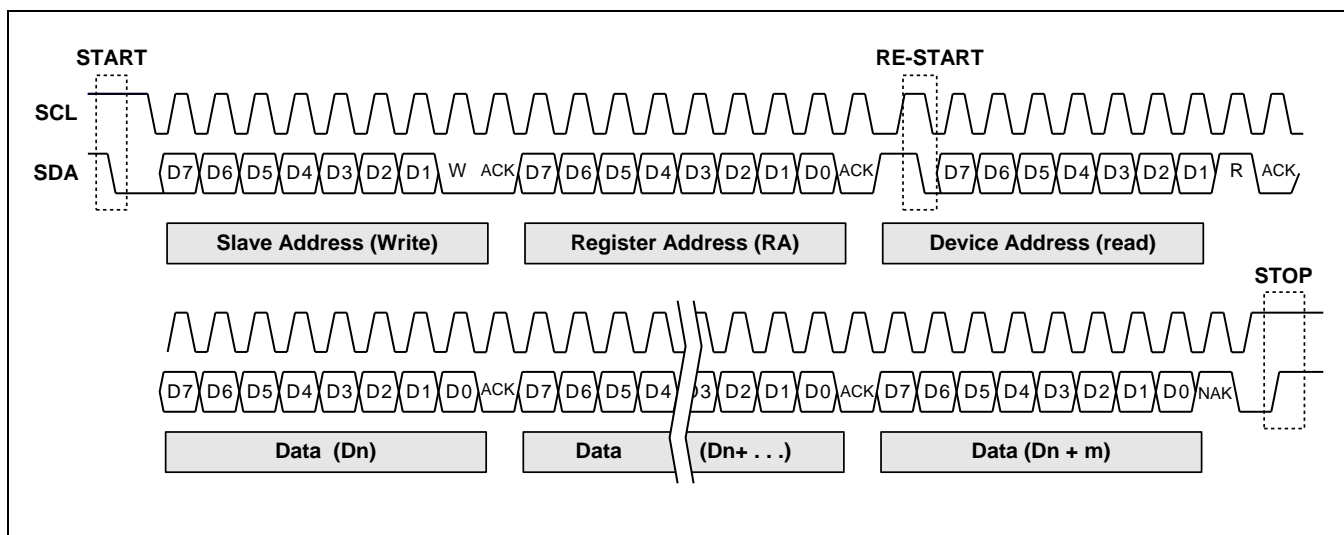


Figure 26 Multi Bytes Read Mode

4.2.3 I2C Interface Timing Diagram

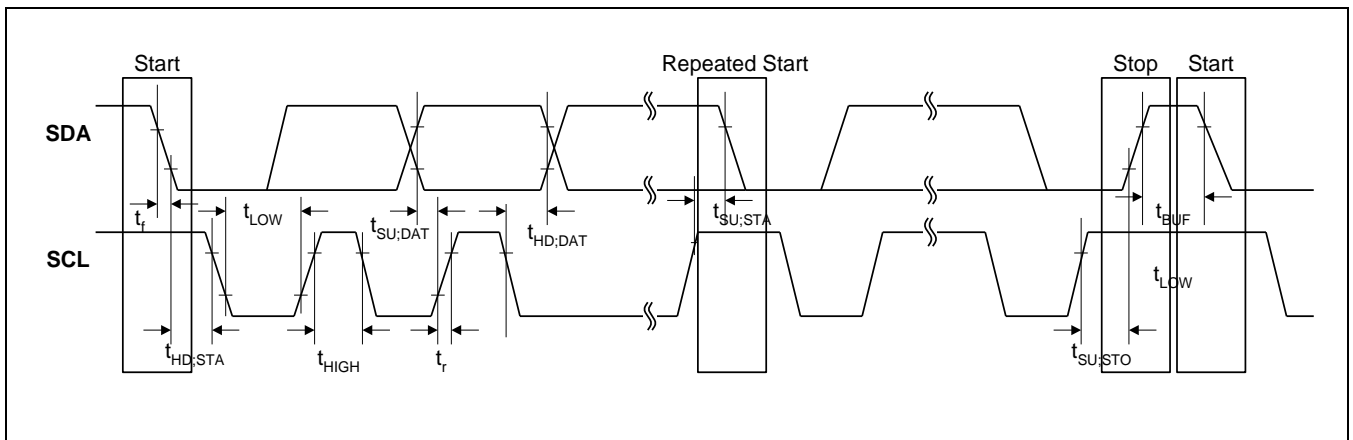


Figure 27 I2C Control Interface Timing Diagram

Table 4 I2C Electrical Specification

(VBATT = 3.7 V, T_A = 25 °C, unless otherwise specified)

Characteristics	Symbol	Standard Mode		Units
		Min.	Max.	
SCL clock frequency	f _{SCL}	0	3400	kHz
Hold time (repeated) START condition. After this period, the first clock pulse is generated.	t _{HD;STA}	0.16	–	μs
LOW period of the SCL clock	t _{LOW}	0.16	–	μs
HIGH period of the SCL clock	t _{HIGH}	0.06	–	μs
Set-up time for a repeated START condition	t _{SU;STA}	0.16	–	μs
Data hold time: for CBUS compatible masters ⁽¹⁾ for I2C-bus devices	t _{HD;DAT}	–	70	ns
Data set-up time	t _{SU;DAT}	10	–	ns
Rise time of both SDA and SCL signals	t _r	10	80	ns
Fall time of both SDA and SCL signals	t _f	10	80	ns
Set-up time for STOP condition	t _{SU;STO}	0.16	–	μs
Bus free time between STOP and START conditions	t _{BUF}	0.5	–	μs
Capacitive load for each bus line	C _b	–	100	pF
Low level input voltage	V _{IL}		0.4	V
High level input voltage	V _{IH}	1.4		V

NOTE:

1. All values refer to the V_{IHmin} and V_{IHmax} levels.
2. A device must internally provide a hold time of at least 300 ns for the SDA signal (refer to the V_{IHmin} of SCL signal) to bridge the undefined region of falling edge of SCL.
3. The maximum THD; DAT is only met if the device does not stretch the LOW period (t_{LOW}) of the SCL signal.
4. C_b = Total capacitance of one bus line in pF

5

Register Description

5.1 Power Management

5.1.1 Register Map Summary

Register	Address	Description	Reset Value
PMIC_ID	0x00	PMIC ID Register	0x00
ONOFF INT1	0x01	On/OFF Interrupt 1 Register	0x00
ONOFF INT2	0x02	On/OFF Interrupt 2 Register	0x00
RTC INT3	0x03	RTC Interrupt Register	0x00
ONOFF INT1M	0x04	On/OFF Interrupt 1 Mask Register	0x00
ONOFF INT2M	0x05	On/OFF Interrupt 2 Mask Register	0x78
RTC INT3M	0x06	RTC Interrupt Mask Register	0x00
STATUS1	0x07	Status1 Register	N/A
STATUS2	0x08	Status 2 Register	N/A
RSVD	0x09	Reserved	N/A
CTRL1	0x0A	Control 1 Register	0x01
CTRL2	0x0B	Control 2 Register	0x0E
RSVD	0x0C	Reserved	N/A
RSVD	0x0D	Reserved	N/A
BU_CHG	0x0E	Back-Up Charger Register	0x4F
DVS_RAMP	0x0F	DVS Ramp Register	0x90
RSVD	0x10	Reserved	N/A
RSVD	0x11	Reserved	N/A
RSVD	0x12	Reserved	N/A
LDO1	0x13	LDO1 Configuration Register	0x22
LDO2	0x14	LDO2 Configuration Register	0x22
LDO3	0x15	LDO3 Configuration Register	0x22
LDO4	0x16	LDO4 Configuration Register	0x22
LDO5	0x17	LDO5 Configuration Register	0x22
LDO6	0x18	LDO6 Configuration Register	0x22
LDO7	0x19	LDO7 Configuration Register	0x22
LDO8	0x1A	LDO8 Configuration Register	0x22
LDO9	0x1B	LDO9 Configuration Register	0x22

Register	Address	Description	Reset Value
LDO10	0x1C	LDO10 Configuration Register	0x22
LDO11	0x1D	LDO11 Configuration Register	0x22
LDO12	0x1E	LDO12 Configuration Register	0x22
LDO13	0x1F	LDO13 Configuration Register	0x22
LDO14	0x20	LDO14 Configuration Register	0x22
LDO15	0x21	LDO15 Configuration Register	0x22
LDO16	0x22	LDO16 Configuration Register	0x22
LDO17	0x23	LDO17 Configuration Register	0x22
LDO18	0x24	LDO18 Configuration Register	0x22
LDO19	0x25	LDO19 Configuration Register	0x22
LDO20	0x26	LDO20 Configuration Register	0x22
LDO21	0x27	LDO21 Configuration Register	0x22
LDO22	0x28	LDO22 Configuration Register	0x22
LDO23	0x29	LDO23 Configuration Register	0x22
LDO24	0x2A	LDO24 Configuration Register	0x22
LDO25	0x2B	LDO25 Configuration Register	0x22
LDO26	0x2C	LDO26 Configuration Register	0x22
LDO27	0x2D	LDO27 Configuration Register	0x22
LDO28	0x2E	LDO28 Configuration Register	0x22
RSVD	0x2F	Reserved	0x00
RSVD	0x30	Reserved	0x00
UVLO	0x31	Under Voltage Lock Out Register	0x04
BUCK1_CTRL1	0x32	BUCK1 Control1 Register	0xD8
BUCK1_CTRL2	0x33	BUCK1 Control2 Register	0x38
BUCK2_CTRL	0x34	BUCK2 Control Register	0xFA
BUCK2_DVS1	0x35	BUCK2 DVS1 Register	0x50
BUCK2_DVS2	0x36	BUCK2 DVS2 Register	0x50
BUCK2_DVS3	0x37	BUCK2 DVS3 Register	0x50
BUCK2_DVS4	0x38	BUCK2 DVS4 Register	0x50
BUCK2_DVS5	0x39	BUCK2 DVS5 Register	0x50
BUCK2_DVS6	0x3A	BUCK2 DVS6 Register	0x50
BUCK2_DVS7	0x3B	BUCK2 DVS7 Register	0x50
BUCK2_DVS8	0x3C	BUCK2 DVS8 Register	0x50
BUCK3_CTRL	0x3D	BUCK3 Control Register	0xFA
BUCK3_DVS1	0x3E	BUCK3 DVS1 Register	0x40
BUCK3_DVS2	0x3F	BUCK3 DVS2 Register	0x40
BUCK3_DVS3	0x40	BUCK3 DVS3 Register	0x40

Register	Address	Description	Reset Value
BUCK3_DVS4	0x41	BUCK3 DVS4 Register	0x40
BUCK3_DVS5	0x42	BUCK3 DVS5 Register	0x40
BUCK3_DVS6	0x43	BUCK3 DVS6 Register	0x40
BUCK3_DVS7	0x44	BUCK3 DVS7 Register	0x40
BUCK3_DVS8	0x45	BUCK3 DVS8 Register	0x40
BUCK4_CTRL	0x46	BUCK4 Control Register	0xFA
BUCK4_DVS1	0x47	BUCK4 DVS1 Register	0x40
BUCK4_DVS2	0x48	BUCK4 DVS2 Register	0x40
BUCK4_DVS3	0x49	BUCK4 DVS3 Register	0x40
BUCK4_DVS4	0x4A	BUCK4 DVS4 Register	0x40
BUCK4_DVS5	0x4B	BUCK4 DVS5 Register	0x40
BUCK4_DVS6	0x4C	BUCK4 DVS6 Register	0x40
BUCK4_DVS7	0x4D	BUCK4 DVS7 Register	0x40
BUCK4_DVS8	0x4E	BUCK4 DVS8 Register	0x40
BUCK5_CTRL1	0x4F	BUCK5 Control1 Register	0xD8
BUCK5_CTRL2	0x50	BUCK5 DVS1 Register	0x58
BUCK5_CTRL3	0x51	BUCK5 DVS2 Register	0x70
BUCK5_CTRL4	0x52	BUCK5 DVS3 Register	0x88
BUCK5_CTRL2	0x53	BUCK5 DVS4 Register	0xB8
BUCK6_CTRL1	0x54	BUCK6 Control2 Register	0x18
BUCK6_CTRL2	0x55	BUCK6 Control1 Register	0x58
BUCK7_CTRL1	0x56	BUCK7 Control2 Register	0xD8
BUCK7_CTRL2	0x57	BUCK7 Control1 Register	0x64
BUCK8_CTRL1	0x58	BUCK8 Control2 Register	0xD8
BUCK8_CTRL2	0x59	BUCK8 Control1 Register	0x34
BUCK9_CTRL1	0x5A	BUCK9 Control2 Register	0x18
BUCK9_CTRL2	0x5B	BUCK9 Control1 Register	0xA8
LDO1_CTRL	0x5C	LDO1 Control Register	0xC8
LDO2_CTRL	0x5D	LDO2 Control Register	0xD0
LDO2_CTRL	0x5E	LDO2 Control Register	0x16
LDO2_CTRL	0x5F	LDO2 Control Register	0x1C
LDO2_CTRL	0x60	LDO2 Control Register	0x28
LDO3_CTRL	0x61	LDO3 Control Register	0xD4
LDO4_CTRL	0x62	LDO4 Control Register	0xD4
LDO5_CTRL	0x63	LDO5 Control Register	0xD4
LDO6_CTRL	0x64	LDO6 Control Register	0xC8
LDO7_CTRL	0x65	LDO7 Control Register	0xC8

Register	Address	Description	Reset Value
LDO8_CTRL	0x66	LDO8 Control Register	0XC8
LDO9_CTRL	0x67	LDO9 Control Register	0x2C
LDO10_CTRL	0x68	LDO10 Control Register	0XD4
LDO11_CTRL	0x69	LDO11 Control Register	0XD4
LDO12_CTRL	0x6A	LDO12 Control Register	0XEC
LDO13_CTRL	0x6B	LDO13 Control Register	0XD4
LDO14_CTRL	0x6C	LDO14 Control Register	0XD4
LDO15_CTRL	0x6D	LDO15 Control Register	0XC8
LDO16_CTRL	0x6E	LDO16 Control Register	0xD4
LDO17_CTRL	0x6F	LDO17 Control Register	0xE8
LDO18_CTRL	0x70	LDO18 Control Register	0x28
LDO19_CTRL	0x71	LDO19 Control Register	0x2C
LDO20_CTRL	0x72	LDO20 Control Register	0x2C
LDO21_CTRL	0x73	LDO21 Control Register	0x2C
LDO22_CTRL	0x74	LDO22 Control Register	0x32
LDO23_CTRL	0x75	LDO23 Control Register	0x28
LDO24_CTRL	0x76	LDO24 Control Register	0x2C
LDO25_CTRL	0x77	LDO25 Control Register	0x08
LDO26_CTRL	0x78	LDO26 Control Register	0x14
LDO27_CTRL	0x79	LDO27 Control Register	0x14
LDO28_CTRL	0x7A	LDO28 Control Register	0x14
PWRONSRC	0xE0	Power on source Register	N/A

5.1.2 Bit Map Summary

Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x00	RSVD	RSVD	RSVD	RSVD	REV_ID			
0x01	RSVD	RSVD	JIGONBR	JIGONBF	PWR_ON1S	RSVD	PWR_ONF	PWR_ONR
0x02	RSVD	RSVD	RSVD	RSVD	RSVD	MRB	ACOKBF	ACOKBR
0x03	RSVD	RSVD	WTSR	RTC_1S	SMPL	RTC_A2	RTC_A1	RTC_60S
0x04	RSVD	RSVD	JIG_ONFM	JIG_ONRM	PWR_ON1SM	RSVD	PWR_ONFM	PWR_ONRM
0x05	RSVD	RSVD	RSVD	RSVD	RSVD	MRBM	ACOKBFM	ACOKBRM
0x06	RSVD	RSVD	WTSRM	RTC_1SM	SMPLM	RTC_A2M	RTC_A1M	RTC_60SM
0x07	WTSR_EVENT	SMPL_EVENT	RTC_A2S	RTC_A1S	LOW_BAT2S	LOW_BAT1S	JIG_ONFS	PWR_ONS
0x08	DVS_SET3S	DVS_SET2S	DVS_SET1S	PWR_ENS	RSVD	MR2BS	MR1BS	ACOKBS
0x09	RSVD							
0x0A	RSVD	RSVD	RSVD	PWR_HOLD	RSVD	32 KHz_EN	32 KHz_CP_EN	32 KHz_AP_EN
0x0B	RSVD	RSVD	RSVD	RSVD	MRSTB_EM	MRDT		
0x0C	RSVD							
0x0D	RSVD							
0x0E	OUT_R		LCHG_I	V_LIM		CHG_I		BU_EN
0x0F	BUCK_RAMP				ENRAMP_B2	ENRAMP_B3	ENRAMP_B4	RSVD
0x10	RSVD							
0x11	RSVD							
0x12	RSVD							
0x13	OVCB1	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH1	POK1 :Read only
0x14	OVCB2	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH2	POK2:Read only
0x15	OVCB3	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH3	POK3:Read only
0x16	OVCB4	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH4	POK4:Read only
0x17	OVCB5	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH5	POK5:Read only
0x18	OVCB6	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH6	POK6:Read only

Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x19	OVCB7	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH7	POK7:Read only
0x1A	OVCB8	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH8	POK8:Read only
0x1B	OVCB9	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH9	POK9:Read only
0x1C	OVCB10	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH10	POK10:Read only
0x1D	OVCB11	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH11	POK11:Read only
0x1E	OVCB12	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH12	POK12:Read only
0x1F	OVCB13	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH13	POK13:Read only
0x20	OVCB14	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH14	POK14:Read only
0x21	OVCB15	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH15	POK15:Read only
0x22	OVCB16	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH16	POK16:Read only
0x23	OVCB17	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH17	POK17:Read only
0x24	OVCB18	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH18	POK18:Read only
0x25	OVCB19	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH19	POK19:Read only
0x26	OVCB20	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH20	POK20:Read only
0x27	OVCB21	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH21	POK21:Read only
0x28	OVCB22	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH22	POK22:Read only
0x29	OVCB23	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH23	POK23:Read only
0x2A	OVCB24	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH24	POK24:Read only
0x2B	OVCB25	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH25	POK25:Read only
0x2C	OVCB26	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH26	POK26:Read only
0x2D	OVCB27	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH27	POK27:Read only
0x2E	OVCB28	RSVD	RSVD	RSVD	RSVD	RSVD	DSCH28	POK28:Read only

Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
								read only
0x2F	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD
0x30	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD	RSVD
0x31	UVLO_H		UVLO_L		RSVD	RSVD	REG_TIMING	
0x32	BUCK1_EN		RSVD	DSCH_B1	MODE_B1		RSVD	RSVD
0x33	VO_CTRL							
0x34	BUCK2_EN		REMOTE_2_EN	DSCH_B2	MODE_B2		DVS_B2	RSVD
0x35	DVS_B21							
0x36	DVS_B22							
0x37	DVS_B23							
0x38	DVS_B24							
0x39	DVS_B25							
0x3A	DVS_B26							
0x3B	DVS_B27							
0x3C	DVS_B28							
0x3D	BUCK3_EN		REMOTE_3_EN	DSCH_B3	MODE_B3		DVS_B3	RSVD
0x3E	DVS_B31							
0x3F	DVS_B32							
0x40	DVS_B33							
0x41	DVS_B34							
0x42	DVS_B35							
0x43	DVS_B36							
0x44	DVS_B37							
0x45	DVS_B38							
0x46	BUCK4_EN		REMOTE_4_EN	DSCH_B4	MODE_B4		DVS_B4	RSVD
0x47	DVS_B41							
0x48	DVS_B42							
0x49	DVS_B43							
0x4A	DVS_B44							
0x4B	DVS_B45							
0x4C	DVS_B46							
0x4D	DVS_B47							
0x4E	DVS_B48							
0x4F	Buck5_EN		RSVD	DSCH_B5	MODE_B5		RSVD	RSVD
0x50	DVS_B51							

Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x51	DVS_B52							
0x52	DVS_B53							
0x53	DVS_B54							
0x54	Buck6_EN		RSVD	DSCH_B6	MODE_B6		RSVD	RSVD
0x55	VO_CTRL							
0x56	Buck7_EN		RSVD	DSCH_B7	MODE_B7		RSVD	RSVD
0x57	VO_CTRL							
0x58	Buck8_EN		RSVD	DSCH_B8	MODE_B8		RSVD	RSVD
0x59	VO_CTRL							
0x5A	Buck9_EN		RSVD	DSCH_B9	MODE_B9		RSVD	RSVD
0x5B	VO_CTRL							
0x5C	LDO1_EN		OUT_L1					
0x5D	LDO2_EN		OUT_L2_1					
0x5E	RSVD		OUT_L2_2					
0x5F	RSVD		OUT_L2_3					
0x60	RSVD		OUT_L2_4					
0x61	LDO3_EN		OUT_L3					
0x62	LDO4_EN		OUT_L4					
0x63	LDO5_EN		OUT_L5					
0x64	LDO6_EN		OUT_L6					
0x65	LDO7_EN		OUT_L7					
0x66	LDO8_EN		OUT_L8					
0x67	LDO9_EN		OUT_L9					
0x68	LDO10_EN		OUT_L10					
0x69	LDO11_EN		OUT_L11					
0x6A	LDO12_EN		OUT_L12					
0x6B	LDO13_EN		OUT_L13					
0x6C	LDO14_EN		OUT_L14					
0x6D	LDO15_EN		OUT_L15					
0x6E	LDO16_EN		OUT_L16					
0x6F	LDO17_EN		OUT_L17					
0x70	LDO18_EN		OUT_L18					
0x71	LDO19_EN		OUT_L19					
0x72	LDO20_EN		OUT_L20					
0x73	LDO21_EN		OUT_L21					
0x74	LDO22_EN		OUT_L22					
0x75	LDO23_EN		OUT_L23					

Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x76	LDO24_EN		OUT_L24					
0x77	LDO25_EN		OUT_L25					
0x78	LDO26_EN		OUT_L26					
0x79	LDO27_EN		OUT_L27					
0x7A	LDO28_EN		OUT_L28					
0xE0	RSVD	SMPL	ALARM2	ALARM1	MRST	ACOKB	JIGON	PWRON

5.1.2.1 PMIC_ID

- Address = 0x00, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value
RSVD	[7:4]	R	Reserved	0b0000
REV_ID	[3:0]	R	IC Revision ID	0b0000

5.1.2.2 ONOFF INT1

- Address = 0x01, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value
RSVD	[7]	RC	Reserved	0b0
RSVD	[6]	RC	Reserved	0b0
JIGONBR	[5]	RC	1 = JIGONB rising edge detection (debounced)	0b0
JIGONBF	[4]	RC	1 = JIGONB falling edge detection (debounced)	0b0
PWR_ON1S	[3]	RC	1 = PWR_ON high for longer than 1 sec	0b0
RSVD	[2]	RC	Reserved	0b0
PWR_ONF	[1]	RC	1 = PWR_ON key falling edge detection (debounced)	0b0
PWR_ONR	[0]	RC	1 = PWR_ON key rising edge detection (debounced)	0b0

NOTE: All IRQ registers must be read at once (Not individually) because a user does not know which source will trigger an IRQ.

5.1.2.3 ONOFF INT2

- Address = 0x02, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value
RSVD	[7:6]	RC	Reserved	0b00
RSVD	[5]	RC	Reserved	0b0
RSVD	[4]	RC	Reserved	0b0
RSVD	[3]	RC	Reserved	0b0
MRB	[2]	RC	1 = MR1B and MR2B logic low for longer than manual reset debounce time	0b0
ACOKBF	[1]	RC	1 = ACOKB falling edge detection (debounced)	0b0
ACOKBR	[0]	RC	1 = ACOKB rising edge detection (debounced)	0b0

NOTE: All IRQ registers must be read at once (Not individually) because a user does not know which source will trigger an IRQ.

5.1.2.4 RTC INT3

- Address = 0x03, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value
RSVD	[7:6]	RC	Reserved	0b00
WTSR	[5]	RC	1 = WTSR event interrupt	0b0
RTC_1S	[4]	RC	1 = RTC periodic 1sec event	0b0
SMPL	[3]	RC	1 = SMPL interrupt to host controller	0b0
RTC_A2	[2]	RC	1 = RTC alarm 2	0b0
RTC_A1	[1]	RC	1 = RTC alarm 1	0b0
RTC_60S	[0]	RC	1 = RTC periodic 60sec event	0b0

NOTE: All IRQ registers must be read at once (Not individually) because a user does not know which source will trigger an IRQ.

5.1.2.5 ONOFF INT1M

- Address = 0x04, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value
RSVD	[7]	RW	Reserved	0b0
RSVD	[6]	RW	Reserved	0b0
JIGONBFM	[5]	RW	JIGONB falling event 0 = Not masked 1 = Masked	0b0
JIGONBRM	[4]	RW	JIGONB rising event 0 = Not masked 1 = Masked	0b0
PWR_On1SM	[3]	RW	PWR_ON 1sec vent 0 = Not masked 1 = Masked	0b0
RSVD	[2]	RW	Reserved	0b0
PWR_ONFM	[1]	RW	PWR_ON falling event 0 = Not masked 1 = Masked	0b0
PWR_ONRM	[0]	RW	PWR_ON rising vent 0 = Not masked 1 = Masked	0b0

5.1.2.6 ONOFF INT2M

- Address = 0x05, Reset Value = 0x78

Name	Bit	Type	Description	Reset Value
RSVD	[7:6]	RW	Reserved	0b01
RSVD	[5]	RW	Reserved	0b1
RSVD	[4]	RW	Reserved	0b1
RSVD	[3]	RW	Reserved	0b1
MRBM	[2]	RW	MR1B and MR2B event 0 = Not masked 1 = Masked	0b0
ACOKBFM	[1]	RW	ACOKB falling event 0 = Not masked 1 = Masked	0b0
ACOKBRM	[0]	RW	ACOKB rising event 0 = Not masked 1 = Masked	0b0

5.1.2.7 RTC INT3M

- Address = 0x06, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value
RSVD	[7:6]	RW	Reserved	0b00
WTSRM	[5]	RW	WTSR event 0 = Not masked 1 = Masked	0b0
RTC_1SM	[4]	RW	RTC periodic 1sec event 0 = Not masked 1 = Masked	0b0
SMPLM	[3]	RW	SMPL interrupt to host controller event 0 = Not masked 1 = Masked	0b0
RTC_A2M	[2]	RW	RTC alarm2 event 0 = Not masked 1 = Masked	0b0
RTC_A1M	[1]	RW	RTC alarm1 event 0 = Not masked 1 = Masked	0b0
RTC_60SM	[0]	RW	RTC periodic 60sec event 0 = Not masked 1 = Masked	0b0

5.1.2.8 STATUS1

- Address = 0x07, Reset Value = N/A

Name	Bit	Type	Description	Reset Value
WTSR_EVENT	[7]	R	0 = WTSR event does not occur 1 = WTSR event does occur	N/A
SMPL_EVENT	[6]	R	0 = SMPL event does not occur 1 = SMPL event does occur	N/A
RTC_A2S	[5]	R	0 = RTC alarm2 is not reached 1 = RTC alarm2 is reached	N/A
RTC_A1S	[4]	R	0 = RTC alarm1 is not reached 1 = RTC alarm1 is reached	N/A
Low_BAT2S	[3]	R	0 = Main battery voltage is below low battery voltage monitor 2 1 = Main battery voltage is above low battery voltage monitor 2	N/A
Low_BAT1S	[2]	R	0 = Main battery voltage is below low battery voltage monitor1 1 = Main battery voltage is above low battery voltage monitor1`	N/A
JIGONBFS	[1]	R	0 = JIGONB falling is low (No input) 1 = JIGONB falling is high (Input present)	N/A
PWR_ONS	[0]	R	0 = PWR_ON is low (No input) 1 = PWR_ON is high (Input present)	N/A

NOTE: If the value is low (0), the register interrupt is enabled.

5.1.2.9 STATUS2

- Address = 0x08, Reset Value = N/A

Name	Bit	Type	Description	Reset Value
DVS_SET3S	[7]	R	0 = DVS_SET3 is low 1 = DVS_SET3 is high	N/A
DVS_SET2S	[6]	R	0 = DVS_SET2 is low 1 = DVS_SET2 is high	N/A
DVS_SET1S	[5]	R	0 = DVS_SET1 is low 1 = DVS_SET1 is high	N/A
PWR_ENS	[4]	R	0 = PWREN is low 1 = PWREN is high	N/A
RSVD	[3]	R	Reserved	N/A
MR2BS	[2]	R	0 = MR2B is low 1 = MR2B is high	N/A
MR1BS	[1]	R	0 = MR1B is low 1 = MR1B is high	N/A
ACOKbS	[0]	R	0 = ACOKb is low 1 = ACOKb is high	N/A

NOTE: If the value is low (0), the register interrupt is enabled.

5.1.2.10 RSVD

- Address = 0x09, Reset Value = N/A

Name	Bit	Type	Description	Reset Value
RSVD	[7:0]	R	Reserved	N/A

NOTE: . If the value is low (0), the register interrupt is enabled.

5.1.2.11 CTRL1

- Address = 0x0A, Reset Value = 0x01

Name	Bit	Type	Description	Reset Value
RSVD	[7:5]	RW	Reserved	0b000
PWRHOLD	[4]	RW	Internal PWRHOLD logic and external PWRHOLD signal are ORed 0 = Internal PWRHOLD logic is low 1 = Internal PWRHOLD logic is high	0b0
RSVD	[3]	RW	Reserved	0b0
32KHzBT_EN	[1]	RW	0 = Turn 32 kHz BT on 1 = Turn 32 kHz BT off	0b0
32KHzCP_EN	[1]	RW	0 = Turn 32 kHz CP on 1 = Turn 32 kHz CP off	0b0
32KHzAP_EN	[0]	RW	0 = Turn 32 kHz AP on 1 = Turn 32 kHz AP off	0b1

5.1.2.12 CTRL2

- Address = 0x0B, Reset Value = 0x0E

Name	Bit	Type	Description	Reset Value
RSVD	[7:4]	RW	Reserved	0b0000
MRSTB_EN	[3]	RW	0 = Manual Resetb disable 1 = Manual Resetb enable	0b1
MRDT	[2:0]	RW	Manual Reset Debounce Timer when MR1B = MR2B = low 000 = 9 sec 001 = 10 sec 010 = 3 sec 011 = 4 sec 100 = 5 sec 101 = 6 sec 110 = 7 sec (Default) 111 = 8 sec	0b110

5.1.2.13 RSVD

- Address = 0x0C, Reset Value = 0xE7

Name	Bit	Type	Description	Reset Value
RSVD	[7:0]	R	Reserved	N/A

5.1.2.14 RSVD

- Address = 0x0D, Reset Value = 0x87

Name	Bit	Type	Description	Reset Value
RSVD	[7:0]	R	Reserved	N/A

5.1.2.15 BU_CHG

- Address = 0x0E, Reset Value = 0x4F

Name	Bit	Type	Description	Reset Value
OUT_R	[7:6]	RW	Output Resistor 00 = Bypass 01 = 1 kΩ(Default) 10 = 3 kΩ 11 = 6 kΩ	0b01
LCHG_I	[5]	RW	0 = Low charging current enable 1 = Low charging current disable	0b0
V_LIM	[4:3]	RW	Limit voltage setting 00 = 2.5 V 01 = 3.0 V (Default) 10 = 3.3 V 11 = 3.5 V	0b01
CHG_I	[2:1]	RW	Charging current setting @LCHG_I = 0 00 = 80 μA 01 = 80 μA 10 = 80 μA 11 = 100 μA (Default) @LCHG_I = 1 00 = 200 μA 01 = 600 μA 10 = 800 μA 11 = 400 μA	0b11
BU_EN	[0]	RW	0 = Backup battery charger off 1 = Backup battery charger on	0b1

5.1.2.16 DVS_RAMP

- Address = 0x0F, Reset Value = 0x90

Name	Bit	Type	Description	Reset Value
BUCK_RAMP	[7:4]	RW	0100 = 5.00 mV/μs 1001 = 10.00 mV/μs (Default) 1101 = 25.00 mV/μs 1110 = 50.00 mV/μs 1111 = 100.00 mV/μs	0b1001
ENRAMP_B2	[3]	RW	Ramp Control ON/OFF for BUCK 2 0 = Turn Off Ramp Control (Max Ramp Rate) of BUCK 2 1 = Turn On Ramp Control of BUCK 2	0b0
ENRAMP_B3	[2]	RW	Ramp Control ON/OFF for BUCK3 0 = Turn Off Ramp Control (Max Ramp Rate) of BUCK 3 1 = Turn On Ramp Control of BUCK 3	0b0
ENRAMP_B4	[1]	RW	Ramp Control ON/OFF for BUCK 3 0 = Turn Off Ramp Control (Max Ramp Rate) of BUCK 3 1 = Turn On Ramp Control of BUCK 3	0b0
RSVD	[0]	RW	Reserved	0b0

5.1.2.17 RSVD

- Address = 0x10/0x11/0x12, Reset Value = 0x03

Name	Bit	Type	Description	Reset Value
DVS_TEST	[7:0]	RW	Reserved	0b00000011

5.1.2.18 LDO1 to LDO28

- Address = 0x13 to 0x2E, Reset Value = 0x22

Name	Bit	Type	Description	Reset Value
OVCB1 OVCB2 OVCB3 OVCB4 OVCB5 OVCB6 OVCB7 OVCB8 OVCB9 OVCB10 OVCB11 OVCB12 OVCB13 OVCB14 OVCB15 OVCB16 OVCB17 OVCB18 OVCB19 OVCB20 OVCB21 OVCB22 OVCB23 OVCB24 OVCB25 OVCB26 OVCB27 OVCB28	[7]	RW	Over-voltage Clamp Enable 0 = Enable 1 = Disable	0b0
RSVD	[6:2]	RW	Reserved	0b01000

Name	Bit	Type	Description	Reset Value
DSCH1 DSCH2 DSCH3 DSCH4 DSCH5 DSCH6 DSCH7 DSCH8 DSCH9 DSCH10 DSCH11 DSCH12 DSCH13 DSCH14 DSCH15 DSCH16 DSCH17 DSCH18 DSCH19 DSCH20 DSCH21 DSCH22 DSCH23 DSCH24 DSCH25 DSCH26 DSCH27 DSCH28	[1]	RW	Active Discharge Enable 0 = Disable 1 = Enable	0b1
POK1: Read only POK2: Read only POK3: Read only POK4: Read only POK5: Read only POK6: Read only POK7: Read only POK8: Read only POK9: Read only POK10: Read only POK11: Read only POK12: Read only POK13: Read only POK14: Read only POK15: Read only	[0]	RW	LDO output voltage OK flag bit 0 = LDO output is less than 90 % of target output voltage (POK threshold), and the device is operating in normal mode. 1 = LDO output is higher than the POK threshold, or LDO is operating in low-power mode, or the device is disabled.	0b0

Name	Bit	Type	Description	Reset Value
POK16: Read only				
POK17: Read only				
POK18: Read only				
POK19: Read only				
POK20: Read only				
POK21: Read only				
POK22: Read only				
POK23: Read only				
POK24: Read only				
POK25: Read only				
POK26: Read only				
POK27: Read only				
POK28: Read only				

5.1.2.19 RSVD

- Address = 0x2F/0x30, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value
RSVD	[7:0]	RW	Reserved	0b00000000

5.1.2.20 UVLO

- Address = 0x31, Reset Value = 0x04

Name	Bit	Type	Description	Reset Value
UVLO_H	[7:6]	RW	UVLO Rising Level Trimming	0b00
UVLO_L	[5:4]	RW	UVLO Falling Level Trimming	0b00
RSVD	[3]	RW	Reserved	0b0
RSVD	[2]	RW	Reserved	0b1
REG_TIMING	[1:0]	RW	Regulator Timing Trimming	0b00

5.1.2.21 BUCK1_CTRL1

- Address = 0x32, Reset Value = 0xD8

Name	Bit	Type	Description	Reset Value
BUCK1_EN	[7:6]	RW	BUCK1 enable control 00 = Always off 01 = On/off by PWREN (High: On, Low: Off) 1x = Always on (Default)	0b11
RSVD	[5]	RW	Reserved	0b0
DSCH_B1	[4]	RW	Active Discharge of SW1 0 = No Active Discharge 1 = Active Discharge (Default)	0b1
MODE_B1	[3:2]	RW	Mode Control 10 = Auto mode (Default) 11 = Forced PWM	0b10
RSVD	[1]	RW	Reserved	0b0
RSVD	[0]	RW	Reserved	0b0

5.1.2.22 BUCK1_CTRL2

- Address = 0x33, Reset Value = 0x38

Name	Bit	Type	Description	Reset Value
VO_CTRL	[7:0]	RW	BUCK 1 Output Voltage Control 8-bit Programmable from 0.65 V to 2.225 V in 6.25 mV steps	0b00111000

5.1.2.23 BUCK2_CTRL

- Address = 0x34, Reset Value = 0xFA

Name	Bit	Type	Description	Reset Value
BUCK2_EN	[7:6]	RW	BUCK2 enable control 00 = Always off 01 = On/off by PWREN (High: On, Low: Off) 10 = Reserved 11 = Always on (Default)	0b11
REMOTE2_EN	[5]	RW	0 = Turn Remote2_sense Off 1 = Turn Remote2_sense On (Default)	0b1
DSCH_B2	[4]	RW	Active Discharge of SW2 0 = No Active Discharge 1 = Active Discharge (Default)	0b1
MODE_B2	[3:2]	RW	Mode Control 10 = Auto mode (Default) 11 = Forced PWM	0b10
DVS_B2	[1]	RW	DVS Control 0 = DVS Off 1 = DVS On (Output Voltage is chosen by SET1, SET2 and SET3)	0b1
RSVD	[0]	RW	Reserved	0b0

5.1.2.24 BUCK2_DVS1 to BUCK2_DVS8

- Address = 0x35 to 0x3C, Reset Value = 0x50

Name	Bit	Type	Description	Reset Value
DVS_B21 DVS_B22 DVS_B23 DVS_B24 DVS_B25 DVS_B26 DVS_B27 DVS_B28	[7:0]	RW	BUCK2 DVS Output Voltage Option 8-bit Programmable from 0.6 V to 1.6 V in 6.25 mV steps	0b01010000

5.1.2.25 BUCK3_CTRL

- Address = 0x3D, Reset Value = 0xFA

Name	Bit	Type	Description	Reset Value
BUCK3_EN	[7:6]	RW	BUCK 3 enable control 00 = Always off 01 = On/off by PWREN (High:On, Low:Off) 10 = Reserved 11 = Always on (Default)	0b11
REMOTE3_EN	[5]	RW	0 = Turn Remote3_sense Off 1 = Turn Remote3_sense On (Default)	0b1
DSCH_B3	[4]	RW	Active Discharge of SW3 0 = No Active Discharge 1 = Active Discharge (Default)	0b1
MODE_B3	[3:2]	RW	Mode Control 10 = Auto Mode (Default) 11 = Forced PWM	0b10
DVS_B3	[1]	RW	Dvs Control 0 = DVS Off 1 = DVS On (Output voltage is chosen by SET1, SET2 and SET3)	0b1
RSVD	[0]	RW	Reserved	0b0

5.1.2.26 BUCK3_DVS1 to BUCK3_DVS8

- Address = 0x3E to 0x45, Reset Value = 0x40

Name	Bit	Type	Description	Reset Value
DVS_B31 DVS_B32 DVS_B33 DVS_B34 DVS_B35 DVS_B36 DVS_B37 DVS_B38	[7:0]	RW	BUCK 3 DVS Output Voltage Option 8-bit Programmable from 0.6 V to 1.6 V in 6.25 mV steps	0b01000000

5.1.2.27 BUCK4_CTRL

- Address = 0x46, Reset Value = 0xFA

Name	Bit	Type	Description	Reset Value
BUCK4_EN	[7:6]	RW	BUCK4 enable control 00 = Always off 01 = On/off by PWREN (High:On, Low:Off) 10 = Reserved 11 = Always on (Default)	0b11
REMOTE4_EN	[5]	RW	0 = Turn Remote4_sense Off 1 = Turn Remote4_sense On (Default)	0b1
DSCH_B4	[4]	RW	Active Discharge of SW4 0 = No Active Discharge 1 = Active Discharge (Default)	0b1
MODE_B4	[3:2]	RW	Mode Control 10 = Auto mode (Default) 11 = Forced PWM	0b10
DVS_B4	[1]	RW	DVS Control 0 = DVS Off 1 = DVS On (Output Voltage is chosen by SET1, SET2 and SET3)	0b1
RSVD	[0]	RW	Reserved	0b0

5.1.2.28 BUCK4_DVS1 to BUCK4_DVS8

- Address = 0x47 to 0x4E, Reset Value = 0x40

Name	Bit	Type	Description	Reset Value
DVS_B41 DVS_B42 DVS_B43 DVS_B44 DVS_B45 DVS_B46 DVS_B47 DVS_B48	[7:0]	RW	BUCK 4 DVS Output Voltage Option 8-bit Programmable from 0.6 V to 1.6 V in 6.25 mV steps	0b01000000

5.1.2.29 BUCK5_CTRL1

- Address = 0x4F, Reset Value = 0xD8

Name	Bit	Type	Description	Reset Value
BUCK5_EN	[7:6]	RW	BUCK 5 enable control 00 = Always off 01 = On/off by PWREN (High: On, Low: Off) 10 = Enter low power mode by PWREN(High: Normal, Low:Low-Power) 11 = Always on (Default)	0b11
RSVD	[5]	RW	Reserved	0b0
DSCH_B5	[4]	RW	Active Discharge of SW5 0 = No Active Discharge 1 = Active Discharge (Default)	0b1
MODE_B5	[3:2]	RW	Mode Control 10 = Auto mode (Default) 11 = Forced PWM	0b10
RSVD	[1]	RW	Reserved	0b0
RSVD	[0]	RW	Reserved	0b0

5.1.2.30 BUCK5_DVS1

- Address = 0x50, Reset Value = 0x58

Name	Bit	Type	Description	Reset Value
DVS_B51	[7:0]	RW	BUCK 5 DVS Output Voltage Option 8-bit Programmable from 0.65 V to 2.225 V in 6.25 mV steps	0b01011000

5.1.2.31 BUCK5_DVS2

- Address = 0x51, Reset Value = 0x70

Name	Bit	Type	Description	Reset Value
DVS_B52	[7:0]	RW	BUCK5 DVS Output Voltage Option 8-bit Programmable from 0.65 V to 2.225 V in 6.25 mV steps	0b01110000

5.1.2.32 BUCK5_DVS3

- Address = 0x52, Reset Value = 0x88

Name	Bit	Type	Description	Reset Value
DVS_B53	[7:0]	RW	BUCK5 DVS Output Voltage Option 8-bit Programmable from 0.65 V to 2.225 V in 6.25 mV steps	0b10001000

5.1.2.33 BUCK5_DVS4

- Address = 0x53, Reset Value = 0xB8

Name	Bit	Type	Description	Reset Value
DVS_B54	[7:0]	RW	BUCK5 DVS Output Voltage Option 8-bit Programmable from 0.65 V to 2.225 V in 6.25 mV steps	0b10111000

5.1.2.34 BUCK6_CTRL1

- Address = 0x54, Reset Value = 0x18

Name	Bit	Type	Description	Reset Value
BUCK6_EN	[7:6]	RW	BUCK6 enable control 00 = Always off (Default) 01 = On/off by BUCK6EN (High:On, Low:Off) 1x = Always on	0b00
RSVD	[5]	RW	Reserved	0b0
DSCH_B6	[4]	RW	Active Discharge of SW6 0 = No Active Discharge 1 = Active Discharge (Default)	0b1
MODE_B6	[3:2]	RW	Mode Control 10 = Auto mode (Default) 11 = Forced PWM	0b10
RSVD	[1]	RW	Reserved	0b0
RSVD	[0]	RW	Reserved	0b0

5.1.2.35 BUCK6_CTRL2

- Address = 0x55, Reset Value = 0x58

Name	Bit	Type	Description	Reset Value
VO_CTRL	[7:0]	RW	BUCK6 Output Voltage Option 8-bit Programmable from 0.65 V to 2.225 V in 6.25 mV steps	0b01011000

5.1.2.36 BUCK7_CTRL1

- Address = 0x56, Reset Value = 0xD8

Name	Bit	Type	Description	Reset Value
BUCK7_EN	[7:6]	RW	BUCK 7 enable control 00 = Always off 01 = On/off by PWREN (High:On, Low:Off) 1x = Always on (Default)	0b11
RSVD	[5]	RW	Reserved	0b0
DSCH_B7	[4]	RW	Active Discharge of SW7 0 = No Active Discharge 1 = Active Discharge (Default)	0b1
MODE_B7	[3:2]	RW	Mode Control 10= Auto mode (Default) 11= Forced PWM	0b10
RSVD	[1]	RW	Reserved	0b0
RSVD	[0]	RW	Reserved	0b0

5.1.2.37 BUCK7_CTRL2

- Address = 0x57, Reset Value = 0x64

Name	Bit	Type	Description	Reset Value
VO_CTRL	[7:0]	RW	BUCK 7 Output Voltage Control 8-bit Programmable from 0.75 V to 3.0 V in 12.5 mV steps	0b01100100

5.1.2.38 BUCK8_CTRL1

- Address = 0x58, Reset Value = 0xD8

Name	Bit	Type	Description	Reset Value
BUCK8_EN	[7:6]	RW	BUCK8 enable control 00 = Always off 01 = On/off by PWREN (High: On, Low: Off) 1x = Always on (Default)	0b11
RSVD	[5]	RW	Reserved	0b0
DSCH_B8	[4]	RW	Active Discharge of SW8 0 = No Active Discharge 1 = Active Discharge (Default)	0b1
MODE_B8	[3:2]	RW	Mode Control 10 = Auto mode (Default) 11 = Forced PWM	0b10
RSVD	[1]	RW	Reserved	0b0
RSVD	[0]	RW	Reserved	0b0

5.1.2.39 BUCK8_CTRL2

- Address = 0x59, Reset Value = 0x34

Name	Bit	Type	Description	Reset Value
VO_CTRL	[7:0]	RW	BUCK 8 Output Voltage Control 8-bit Programmable from 0.75 V to 3.0V in 12.5 mV steps	0b00110100

5.1.2.40 BUCK9_CTRL1

- Address = 0x5A, Reset Value = 0x18

Name	Bit	Type	Description	Reset Value
BUCK9_EN	[7:6]	RW	BUCK 9 enable control 00 = Always off (Default) 01 = On/off by BUCK9EN (High:On, Low:Off) 1x = Always on	0b00
RSVD	[5]	RW	Reserved	0b0
DSCH_B9	[4]	RW	Active Discharge of SW9 0 = No Active Discharge 1 = Active Discharge (Default)	0b1
MODE_B9	[3:2]	RW	Mode Control 10 = Auto mode (Default) 11 = Forced PWM	0b10
RSVD	[1]	RW	Reserved	0b0
RSVD	[0]	RW	Reserved	0b0

5.1.2.41 BUCK9_CTRL2

- Address = 0x5B, Reset Value = 0xA8

Name	Bit	Type	Description	Reset Value
VO_CTRL	[7:0]	RW	BUCK9 Output Voltage Control 8-bit Programmable from 0.75 V to 3.0V in 12.5 mV steps	0b10101000

Table 5 Voltage Table for BUCK 2/3/4

0x00 = 0.60000	0x20 = 0.80000	0x40 = 1.00000	0x60 = 1.20000	0x80 = 1.40000	0xA0 = 1.60000
0x01 = 0.60625	0x21 = 0.80625	0x41 = 1.00625	0x61 = 1.20625	0x81 = 1.40625	
0x02 = 0.61250	0x22 = 0.81250	0x42 = 1.01250	0x62 = 1.21250	0x82 = 1.41250	
0x03 = 0.61875	0x23 = 0.81875	0x43 = 1.01875	0x63 = 1.21875	0x83 = 1.41875	
0x04 = 0.62500	0x24 = 0.82500	0x44 = 1.02500	0x64 = 1.22500	0x84 = 1.42500	
0x05 = 0.63125	0x25 = 0.83125	0x45 = 1.03125	0x65 = 1.23125	0x85 = 1.43125	
0x06 = 0.63750	0x26 = 0.83750	0x46 = 1.03750	0x66 = 1.23750	0x86 = 1.43750	
0x07 = 0.64375	0x27 = 0.84375	0x47 = 1.04375	0x67 = 1.24375	0x87 = 1.44375	
0x08 = 0.65000	0x28 = 0.85000	0x48 = 1.05000	0x68 = 1.25000	0x88 = 1.45000	
0x09 = 0.65625	0x29 = 0.85625	0x49 = 1.05625	0x69 = 1.25625	0x89 = 1.45625	
0x0A = 0.66250	0x2A = 0.86250	0x4A = 1.06250	0x6A = 1.26250	0x8A = 1.46250	
0x0B = 0.66875	0x2B = 0.86875	0x4B = 1.06875	0x6B = 1.26875	0x8B = 1.46875	
0x0C = 0.67500	0x2C = 0.87500	0x4C = 1.07500	0x6C = 1.27500	0x8C = 1.47500	
0x0D = 0.68125	0x2D = 0.88125	0x4D = 1.08125	0x6D = 1.28125	0x8D = 1.48125	
0x0E = 0.68750	0x2E = 0.88750	0x4E = 1.08750	0x6E = 1.28750	0x8E = 1.48750	
0x0F = 0.69375	0x2F = 0.89375	0x4F = 1.09375	0x6F = 1.29375	0x8F = 1.49375	
0x10 = 0.70000	0x30 = 0.90000	0x50 = 1.10000	0x70 = 1.30000	0x90 = 1.50000	
0x11 = 0.70625	0x31 = 0.90625	0x51 = 1.10625	0x71 = 1.30625	0x91 = 1.50625	
0x12 = 0.71250	0x32 = 0.91250	0x52 = 1.11250	0x72 = 1.31250	0x92 = 1.51250	
0x13 = 0.71875	0x33 = 0.91875	0x53 = 1.11875	0x73 = 1.31875	0x93 = 1.51875	
0x14 = 0.72500	0x34 = 0.92500	0x54 = 1.12500	0x74 = 1.32500	0x94 = 1.52500	
0x15 = 0.73125	0x35 = 0.93125	0x55 = 1.13125	0x75 = 1.33125	0x95 = 1.53125	
0x16 = 0.73750	0x36 = 0.93750	0x56 = 1.13750	0x76 = 1.33750	0x96 = 1.53750	
0x17 = 0.74375	0x37 = 0.94375	0x57 = 1.14375	0x77 = 1.34375	0x97 = 1.54375	
0x18 = 0.75000	0x38 = 0.95000	0x58 = 1.15000	0x78 = 1.35000	0x98 = 1.55000	
0x19 = 0.75625	0x39 = 0.95625	0x59 = 1.15625	0x79 = 1.35625	0x99 = 1.55625	
0x1A = 0.76250	0x3A = 0.96250	0x5A = 1.16250	0x7A = 1.36250	0x9A = 1.56250	
0x1B = 0.76875	0x3B = 0.96875	0x5B = 1.16875	0x7B = 1.36875	0x9B = 1.56875	
0x1C = 0.77500	0x3C = 0.97500	0x5C = 1.17500	0x7C = 1.37500	0x9C = 1.57500	
0x1D = 0.78125	0x3D = 0.98125	0x5D = 1.18125	0x7D = 1.38125	0x9D = 1.58125	
0x1E = 0.78750	0x3E = 0.98750	0x5E = 1.18750	0x7E = 1.38750	0x9E = 1.58750	
0x1F = 0.79375	0x3F = 0.99375	0x5F = 1.19375	0x7F = 1.39375	0x9F = 1.59375	

Table 6 Voltage Table for BUCK1/5/6

0x00 = 0.65000	0x20 = 0.85000	0x40 = 1.05000	0x60 = 1.25000	0x80 = 1.45000	0xA0 = 1.65000	0xC0 = 1.85000	0xE0 = 2.05000
0x01 = 0.65625	0x21 = 0.85625	0x41 = 1.05625	0x61 = 1.25625	0x81 = 1.45625	0xA1 = 1.65625	0xC1 = 1.85625	0xE1 = 2.05625
0x02 = 0.66250	0x22 = 0.86250	0x42 = 1.06250	0x62 = 1.26250	0x82 = 1.46250	0xA2 = 1.66250	0xC2 = 1.86250	0xE2 = 2.06250
0x03 = 0.66875	0x23 = 0.86875	0x43 = 1.06875	0x63 = 1.26875	0x83 = 1.46875	0xA3 = 1.66875	0xC3 = 1.86875	0xE3 = 2.06875
0x04 = 0.67500	0x24 = 0.87500	0x44 = 1.07500	0x64 = 1.27500	0x84 = 1.47500	0xA4 = 1.67500	0xC4 = 1.87500	0xE4 = 2.07500
0x05 = 0.68125	0x25 = 0.88125	0x45 = 1.08125	0x65 = 1.28125	0x85 = 1.48125	0xA5 = 1.68125	0xC5 = 1.88125	0xE5 = 2.08125
0x06 = 0.68750	0x26 = 0.88750	0x46 = 1.08750	0x66 = 1.28750	0x86 = 1.48750	0xA6 = 1.68750	0xC6 = 1.88750	0xE6 = 2.08750
0x07 = 0.69375	0x27 = 0.89375	0x47 = 1.09375	0x67 = 1.29375	0x87 = 1.49375	0xA7 = 1.69375	0xC7 = 1.89375	0xE7 = 2.09375
0x08 = 0.70000	0x28 = 0.90000	0x48 = 1.10000	0x68 = 1.30000	0x88 = 1.50000	0xA8 = 1.70000	0xC8 = 1.90000	0xE8 = 2.10000
0x09 = 0.70625	0x29 = 0.90625	0x49 = 1.10625	0x69 = 1.30625	0x89 = 1.50625	0xA9 = 1.70625	0xC9 = 1.90625	0xE9 = 2.10625
0x0A = 0.71250	0x2A = 0.91250	0x4A = 1.11250	0x6A = 1.31250	0x8A = 1.51250	0xAA = 1.71250	0xCA = 1.91250	0xEA = 2.11250
0x0B = 0.71875	0x2B = 0.91875	0x4B = 1.11875	0x6B = 1.31875	0x8B = 1.51875	0xAB = 1.71875	0xCB = 1.91875	0xEB = 2.11875
0x0C = 0.72500	0x2C = 0.92500	0x4C = 1.12500	0x6C = 1.32500	0x8C = 1.52500	0xAC = 1.72500	0xCC = 1.92500	0xEC = 2.12500
0x0D = 0.73125	0x2D = 0.93125	0x4D = 1.13125	0x6D = 1.33125	0x8D = 1.53125	0xAD = 1.73125	0xCD = 1.93125	0xED = 2.13125
0x0E = 0.73750	0x2E = 0.93750	0x4E = 1.13750	0x6E = 1.33750	0x8E = 1.53750	0xAE = 1.73750	0xCE = 1.93750	0xEE = 2.13750
0x0F = 0.74375	0x2F = 0.94375	0x4F = 1.14375	0x6F = 1.34375	0x8F = 1.54375	0xAF = 1.74375	0xCF = 1.94375	0xEF = 2.14375
0x10 = 0.75000	0x30 = 0.95000	0x50 = 1.15000	0x70 = 1.35000	0x90 = 1.55000	0xB0 = 1.75000	0xD0 = 1.95000	0xF0 = 2.15000
0x11 = 0.75625	0x31 = 0.95625	0x51 = 1.15625	0x71 = 1.35625	0x91 = 1.55625	0xB1 = 1.75625	0xD1 = 1.95625	0xF1 = 2.15625
0x12 = 0.76250	0x32 = 0.96250	0x52 = 1.16250	0x72 = 1.36250	0x92 = 1.56250	0xB2 = 1.76250	0xD2 = 1.96250	0xF2 = 2.16250
0x13 = 0.76875	0x33 = 0.96875	0x53 = 1.16875	0x73 = 1.36875	0x93 = 1.56875	0xB3 = 1.76875	0xD3 = 1.96875	0xF3 = 2.16875
0x14 = 0.77500	0x34 = 0.97500	0x54 = 1.17500	0x74 = 1.37500	0x94 = 1.57500	0xB4 = 1.77500	0xD4 = 1.97500	0xF4 = 2.17500
0x15 = 0.78125	0x35 = 0.98125	0x55 = 1.18125	0x75 = 1.38125	0x95 = 1.58125	0xB5 = 1.78125	0xD5 = 1.98125	0xF5 = 2.18125
0x16 = 0.78750	0x36 = 0.98750	0x56 = 1.18750	0x76 = 1.38750	0x96 = 1.58750	0xB6 = 1.78750	0xD6 = 1.98750	0xF6 = 2.18750
0x17 = 0.79375	0x37 = 0.99375	0x57 = 1.19375	0x77 = 1.39375	0x97 = 1.59375	0xB7 = 1.79375	0xD7 = 1.99375	0xF7 = 2.19375
0x18 = 0.80000	0x38 = 1.0	0x58 = 1.2	0x78 = 1.40000	0x98 = 1.60000	0xB8 = 1.80000	0xD8 = 2.00000	0xF8 = 2.20000
0x19 = 0.80625	0x39 = 1.00625	0x59 = 1.20625	0x79 = 1.40625	0x99 = 1.60625	0xB9 = 1.80625	0xD9 = 2.00625	0xF9 = 2.20625
0x1A = 0.81250	0x3A = 1.01250	0x5A = 1.21250	0x7A = 1.41250	0x9A = 1.61250	0xBA = 1.81250	0xDA = 2.01250	0xFA = 2.21250
0x1B = 0.81875	0x3B = 1.01875	0x5B = 1.21875	0x7B = 1.41875	0x9B = 1.61875	0xBB = 1.81875	0xDB = 2.01875	0xFB = 2.21875
0x1C = 0.82500	0x3C = 1.02500	0x5C = 1.22500	0x7C = 1.42500	0x9C = 1.62500	0xBC = 1.82500	0xDC = 2.02500	0xFC = 2.22500
0x1D = 0.83125	0x3D = 1.03125	0x5D = 1.23125	0x7D = 1.43125	0x9D = 1.63125	0xBD = 1.83125	0xDD = 2.03125	
0x1E = 0.83750	0x3E = 1.04750	0x5E = 1.23750	0x7E = 1.43750	0x9E = 1.63750	0xBE = 1.83750	0xDE = 2.03750	
0x1F = 0.84375	0x3F = 1.04375	0x5F = 1.24375	0x7F = 1.44375	0x9F = 1.64375	0xBF = 1.84375	0xDF = 2.04375	

Table 7 Voltage Table for BUCK7/8/9

0x00 = 0.7500	0x20 = 1.1500	0x40 = 1.5500	0x60 = 1.9500	0x80 = 2.3500	0xA0 = 2.7500
0x01 = 0.7625	0x21 = 1.1625	0x41 = 1.5625	0x61 = 1.9625	0x81 = 2.3625	0xA1 = 2.7625
0x02 = 0.7750	0x22 = 1.1750	0x42 = 1.5750	0x62 = 1.9750	0x82 = 2.3750	0xA2 = 2.7750
0x03 = 0.7875	0x23 = 1.1875	0x43 = 1.5875	0x63 = 1.9875	0x83 = 2.3875	0xA3 = 2.7875
0x04 = 0.8000	0x24 = 1.2000	0x44 = 1.6000	0x64 = 2.0000	0x84 = 2.4000	0xA4 = 2.8000
0x05 = 0.8125	0x25 = 1.2125	0x45 = 1.6125	0x65 = 2.0125	0x85 = 2.4125	0xA5 = 2.8125
0x06 = 0.8250	0x26 = 1.2250	0x46 = 1.6250	0x66 = 2.0250	0x86 = 2.4250	0xA6 = 2.8250
0x07 = 0.8375	0x27 = 1.2375	0x47 = 1.6375	0x67 = 2.0375	0x87 = 2.4375	0xA7 = 2.8375
0x08 = 0.8500	0x28 = 1.2500	0x48 = 1.6500	0x68 = 2.0500	0x88 = 2.4500	0xA8 = 2.85
0x09 = 0.8625	0x29 = 1.2625	0x49 = 1.6625	0x69 = 2.0625	0x89 = 2.4625	0xA9 = 2.8625
0x0A = 0.8750	0x2A = 1.2750	0x4A = 1.6750	0x6A = 2.0750	0x8A = 2.4750	0xAA = 2.8750
0x0B = 0.8875	0x2B = 1.2875	0x4B = 1.6875	0x6B = 2.0875	0x8B = 2.4875	0xAB = 2.8875
0x0C = 0.9000	0x2C = 1.3000	0x4C = 1.7000	0x6C = 2.1000	0x8C = 2.5000	0xAC = 2.9000
0x0D = 0.9125	0x2D = 1.3125	0x4D = 1.7125	0x6D = 2.1125	0x8D = 2.5125	0xAD = 2.9125
0x0E = 0.9250	0x2E = 1.3250	0x4E = 1.7250	0x6E = 2.1250	0x8E = 2.5250	0xAE = 2.9250
0x0F = 0.9375	0x2F = 1.3375	0x4F = 1.7375	0x6F = 2.1375	0x8F = 2.5375	0xAF = 2.9375
0x10 = 0.9500	0x30 = 1.3500	0x50 = 1.7500	0x70 = 2.1500	0x90 = 2.5500	0xB0 = 2.9500
0x11 = 0.9625	0x31 = 1.3625	0x51 = 1.7625	0x71 = 2.1625	0x91 = 2.5625	0xB1 = 2.9625
0x12 = 0.9750	0x32 = 1.3750	0x52 = 1.7750	0x72 = 2.1750	0x92 = 2.5750	0xB2 = 2.9750
0x13 = 0.9875	0x33 = 1.3875	0x53 = 1.7875	0x73 = 2.1875	0x93 = 2.5875	0xB3 = 2.9875
0x14 = 1.0000	0x34 = 1.4000	0x54 = 1.8000	0x74 = 2.2000	0x94 = 2.6000	0xB4 = 3.0000
0x15 = 1.0125	0x35 = 1.4125	0x55 = 1.8125	0x75 = 2.2125	0x95 = 2.6125	
0x16 = 1.0250	0x36 = 1.4250	0x56 = 1.8250	0x76 = 2.2250	0x96 = 2.6250	
0x17 = 1.0375	0x37 = 1.4375	0x57 = 1.8375	0x77 = 2.2375	0x97 = 2.6375	
0x18 = 1.0500	0x38 = 1.4500	0x58 = 1.8500	0x78 = 2.2500	0x98 = 2.6500	
0x19 = 1.0625	0x39 = 1.4625	0x59 = 1.8625	0x79 = 2.2625	0x99 = 2.6625	
0x1A = 1.0750	0x3A = 1.4750	0x5A = 1.8750	0x7A = 2.2750	0x9A = 2.6750	
0x1B = 1.0875	0x3B = 1.4875	0x5B = 1.8875	0x7B = 2.2875	0x9B = 2.6875	
0x1C = 1.1000	0x3C = 1.5000	0x5C = 1.9000	0x7C = 2.3000	0x9C = 2.7000	
0x1D = 1.1125	0x3D = 1.5125	0x5D = 1.9125	0x7D = 2.3125	0x9D = 2.7125	
0x1E = 1.1250	0x3E = 1.5250	0x5E = 1.9250	0x7E = 2.3250	0x9E = 2.7250	
0x1F = 1.1375	0x3F = 1.5375	0x5F = 1.9375	0x7F = 2.3375	0x9F = 2.7375	

5.1.2.42 N-type LDO_CTRL

- LDO1: Address = 0x5C, Reset Value = 0xC8
- LDO2: Address = 0x5D, Reset Value = 0xD0
- LDO6: Address = 0x64, Reset Value = 0xC8
- LDO7: Address = 0x65, Reset Value = 0xC8
- LDO8: Address = 0x66, Reset Value = 0xC8
- LDO15: Address = 0x6D, Reset Value = 0xC8

Name	Bit	Type	Description	Reset Value																																																																
LDO_EN	[7:6]	RW	LDO enable control 00 = Output off (regardless of PWREN) 01 = Output on/off controlled by PWREN PWREN = 1: Output is on in normal mode. PWREN = 0: Output is off 10 = Output is on, and its mode changed by PWREN PWREN = 1: Normal mode PWREN = 0: Low-power mode 11 = Output is on in Normal mode (regardless of PWREN)	0b11																																																																
OUT_L1	[5:0]	RW	<table><tr><td>0X00</td><td>0.8 V</td><td>0X20</td><td>1.6 V</td></tr><tr><td>0X01</td><td>0.825 V</td><td>0X21</td><td>1.625 V</td></tr><tr><td>0X02</td><td>0.85 V</td><td>0X22</td><td>1.65 V</td></tr><tr><td>0X03</td><td>0.875 V</td><td>0X23</td><td>1.675 V</td></tr><tr><td>0X04</td><td>0.9 V</td><td>0X24</td><td>1.7 V</td></tr><tr><td>0X05</td><td>0.925 V</td><td>0X25</td><td>1.725 V</td></tr><tr><td>0X06</td><td>0.95 V</td><td>0X26</td><td>1.75 V</td></tr><tr><td>0X07</td><td>0.975 V</td><td>0X27</td><td>1.775 V</td></tr><tr><td>0X08</td><td>1 V</td><td>0X28</td><td>1.8 V</td></tr><tr><td>0X09</td><td>1.025 V</td><td>0X29</td><td>1.825 V</td></tr><tr><td>0X0A</td><td>1.05 V</td><td>0X2A</td><td>1.85 V</td></tr><tr><td>0X0B</td><td>1.075 V</td><td>0X2B</td><td>1.875 V</td></tr><tr><td>0X0C</td><td>1.1 V</td><td>0X2C</td><td>1.9 V</td></tr><tr><td>0X0D</td><td>1.125 V</td><td>0X2D</td><td>1.925 V</td></tr><tr><td>0X0E</td><td>1.15 V</td><td>0X2E</td><td>1.95 V</td></tr><tr><td>0X0F</td><td>1.175 V</td><td>0X2F</td><td>1.975 V</td></tr></table>	0X00	0.8 V	0X20	1.6 V	0X01	0.825 V	0X21	1.625 V	0X02	0.85 V	0X22	1.65 V	0X03	0.875 V	0X23	1.675 V	0X04	0.9 V	0X24	1.7 V	0X05	0.925 V	0X25	1.725 V	0X06	0.95 V	0X26	1.75 V	0X07	0.975 V	0X27	1.775 V	0X08	1 V	0X28	1.8 V	0X09	1.025 V	0X29	1.825 V	0X0A	1.05 V	0X2A	1.85 V	0X0B	1.075 V	0X2B	1.875 V	0X0C	1.1 V	0X2C	1.9 V	0X0D	1.125 V	0X2D	1.925 V	0X0E	1.15 V	0X2E	1.95 V	0X0F	1.175 V	0X2F	1.975 V	0b001000
0X00			0.8 V	0X20	1.6 V																																																															
0X01			0.825 V	0X21	1.625 V																																																															
0X02			0.85 V	0X22	1.65 V																																																															
0X03			0.875 V	0X23	1.675 V																																																															
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0X05			0.925 V	0X25	1.725 V																																																															
0X06			0.95 V	0X26	1.75 V																																																															
0X07			0.975 V	0X27	1.775 V																																																															
0X08			1 V	0X28	1.8 V																																																															
0X09			1.025 V	0X29	1.825 V																																																															
0X0A			1.05 V	0X2A	1.85 V																																																															
0X0B			1.075 V	0X2B	1.875 V																																																															
0X0C			1.1 V	0X2C	1.9 V																																																															
0X0D			1.125 V	0X2D	1.925 V																																																															
0X0E			1.15 V	0X2E	1.95 V																																																															
0X0F	1.175 V	0X2F	1.975 V																																																																	
OUT_L2	0b010000																																																																			
OUT_L6	0b001000																																																																			

Name	Bit	Type	Description				Reset Value
OUT_L7			0X10	1.2 V	0X30	2 V	0b001000
			0X11	1.225 V	0X31	2.025 V	
			0X12	1.25 V	0X32	2.05 V	
			0X13	1.275 V	0X33	2.075 V	
			0X14	1.3 V	0X34	2.1 V	
OUT_L8			0X15	1.325 V	0X35	2.125 V	0b001000
			0X16	1.35 V	0X36	2.15 V	
			0X17	1.375 V	0X37	2.175 V	
			0X18	1.4 V	0X38	2.2 V	
			0X19	1.425 V	0X39	2.225 V	
OUT_L15			0X1A	1.45 V	0X3A	2.25 V	0b001000
			0X1B	1.475 V	0X3B	2.275 V	
			0X1C	1.5 V	0X3C	2.3 V	
			0X1D	1.525 V	0X3D	2.325 V	
			0X1E	1.55 V	0X3E	2.35 V	
	0X1F	1.575 V	0X3F	2.375 V			

5.1.2.43 P-type LDO_CTRL

- LDO3: Address = 0x61, Reset Value = 0xD4
- LDO4: Address = 0x62, Reset Value = 0xD4
- LDO5: Address = 0x63, Reset Value = 0xD4
- LDO9: Address = 0x67, Reset Value = 0x2C
- LDO10: Address = 0x68, Reset Value = 0xD4
- LDO11: Address = 0x69, Reset Value = 0xD4
- LDO12: Address = 0x6A, Reset Value = 0xEC
- LDO13: Address = 0x6B, Reset Value = 0xD4
- LDO14: Address = 0x6C, Reset Value = 0xD4
- LDO16: Address = 0x6E, Reset Value = 0xD4
- LDO17: Address = 0x6F, Reset Value = 0xE8
- LDO18: Address = 0x70, Reset Value = 0x28
- LDO19: Address = 0x71, Reset Value = 0x2C
- LDO20: Address = 0x72, Reset Value = 0x2C
- LDO21: Address = 0x73, Reset Value = 0x2C
- LDO22: Address = 0x74, Reset Value = 0x32
- LDO23: Address = 0x75, Reset Value = 0x28
- LDO24: Address = 0x76, Reset Value = 0x2C
- LDO25: Address = 0x77, Reset Value = 0x08
- LDO26: Address = 0x78, Reset Value = 0x14
- LDO27: Address = 0x79, Reset Value = 0x14
- LDO28: Address = 0x7A, Reset Value = 0x14

Name	Bit	Type	Description	Reset Value
LDO_EN	[7:6]	RW	<p>LDO enable control: LDO5, LDO9, LDO10, LDO11, LDO12, LDO13, LDO14, LDO16, LDO17, LDO19, LDO20, LDO21, LDO22, LDO24, LDO25, LDO26, LDO27, LDO28,</p> <p>► 00 = Output off (regardless of PWREN)</p> <p>► 01 = Output on/off controlled by PWREN</p> <p> PWREN = 1: Output is on in normal mode.</p> <p> PWREN = 0: Output is off</p> <p>► 10 = Output is on, and its mode changed by PWREN</p> <p> PWREN = 1: Normal mode</p> <p> PWREN = 0: Low-power mode</p> <p>► 11 = Output is on in Normal mode (regardless of PWREN)</p>	<p>0b00: LDO9, LDO19, LDO20, LDO21, LDO22, LDO24, LDO25, LDO26, LDO27, LDO28</p> <p>0b11: LDO5, LDO10,</p>

Name	Bit	Type	Description	Reset Value
				LDO11, LDO12, LDO13, LDO14, LDO16, LDO17
			<p>LDO enable control: LDO4, 18, LDO23</p> <p>► 00 = Output on/off controlled by LDO#EN (regardless of PWREN) (# = 4 or 18 or 23)</p> <p style="padding-left: 40px;">LDO#EN= 0: Output off</p> <p style="padding-left: 40px;">LDO#EN= 1: Normal mode</p> <p>► 01 = Output on/off controlled by PWREN and LDO#EN.</p> <p style="padding-left: 40px;">PWREN and LDO#EN= 00: Output off</p> <p style="padding-left: 80px;">01: Output on in Normal mode</p> <p style="padding-left: 80px;">10: Output on in Normal mode</p> <p style="padding-left: 80px;">11: Output on in Normal mode</p> <p>(When LDO#EN is tied to PWREN, PWREN can turn off and on LDO output alternatively with its low and high state respectively.)</p> <p>► 10 = Output is on, and its mode changed by PWREN and LDO#EN.</p> <p style="padding-left: 40px;">PWREN and LDO#EN= 00: Output on in Low-power mode</p> <p style="padding-left: 80px;">01: Output on in Normal mode</p> <p style="padding-left: 80px;">10: Output on in Normal mode</p> <p style="padding-left: 80px;">11: Output on in Normal mode</p> <p>(When LDO#EN is tied to PWREN, PWREN can control LDO output in low-power mode and normal mode alternatively with its low and high state respectively.)</p> <p>► 11 = Output is on in Normal mode (regardless of PWREN and LDO#EN)</p>	<p>0b11: LDO4</p> <p>0b00: LDO18, LDO23</p>
			<p>LDO enable control (Special Case): LDO3</p> <p>► 00 = Output off is not available (always on)</p> <p>► 01 = Output on/off controlled by PWREN</p> <p style="padding-left: 40px;">PWREN = 1: Output is on in normal mode.</p> <p style="padding-left: 40px;">PWREN = 0: Output is off</p> <p>► 10 = Output is on, and its mode changed by PWREN</p> <p style="padding-left: 40px;">PWREN = 1: Normal mode</p> <p style="padding-left: 40px;">PWREN = 0: Low-power mode</p> <p>► 11 = Output is on in Normal mode (regardless of PWREN)</p>	0b11

Name	Bit	Type	Description				Reset Value
OUT_L3	[5:0]	RW					0b010100
OUT_L4			0X00	0.80 V	0X20	2.40 V	0b010100
OUT_L5			0X01	0.85 V	0X21	2.45 V	0b010100
OUT_L9			0X02	0.90 V	0X22	2.50 V	0b010100
OUT_L10			0X03	0.95 V	0X23	2.55 V	0b101100
OUT_L11			0X04	1.00 V	0X24	2.60 V	0b010100
OUT_L12			0X05	1.05 V	0X25	2.65 V	0b010100
OUT_L13			0X06	1.10 V	0X26	2.70 V	0b010100
OUT_L14			0X07	1.15 V	0X27	2.75 V	0b101100
OUT_L16			0X08	1.20 V	0X28	2.80 V	0b010100
OUT_L17			0X09	1.25 V	0X29	2.85 V	0b010100
OUT_L18			0X0A	1.30 V	0X2A	2.90 V	0b010100
OUT_L19			0X0B	1.35 V	0X2B	2.95 V	0b010100
OUT_L20			0X0C	1.40 V	0X2C	3.00 V	0b010100
OUT_L21			0X0D	1.45 V	0X2D	3.05 V	0b010100
OUT_L22			0X0E	1.50 V	0X2E	3.10 V	0b101000
OUT_L23			0X0F	1.55 V	0X2F	3.15 V	0b101000
OUT_L24			0X10	1.60 V	0X30	3.20 V	0b101000
OUT_L25			0X11	1.65 V	0X31	3.25 V	0b101100
OUT_L26			0X12	1.70 V	0X32	3.30 V	0b101100
OUT_L27			0X13	1.75 V	0X33	3.35 V	0b101100
OUT_L28			0X14	1.80 V	0X34	3.40 V	0b101100
			0X15	1.85 V	0X35	3.45 V	0b110010
			0X16	1.90 V	0X36	3.50 V	0b101000
			0X17	1.95 V	0X37	3.55 V	0b101000
			0X18	2.00 V	0X38	3.60 V	0b101100
			0X19	2.05 V	0X39	3.65 V	0b001000
			0X1A	2.10 V	0X3A	3.70 V	0b010100
			0X1B	2.15 V	0X3B	3.75 V	0b010100
			0X1C	2.20 V	0X3C	3.80 V	0b010100
			0X1D	2.25 V	0X3D	3.85 V	0b010100
			0X1E	2.30 V	0X3E	3.90 V	0b010100
			0X1F	2.35 V	0X3F	3.95 V	0b010100

5.1.2.44 PWRONSRC

- Address = 0xE0, Reset Value = N/A

Name	Bit	Type	Description	Reset Value
RSVD	[7]	R	Reserved	0b0
SMPL	[6]	R	1: Indicates power on by 'SMPL event'	N/A
ALARM2	[5]	R	1: Indicates power on by 'ALARM2 event'	N/A
ALARM1	[4]	R	1: Indicates power on by 'ALARM1 event'	N/A
MRST	[3]	R	1: Indicates power on by 'MRST event'	N/A
ACOKB	[2]	R	1: Indicates power on by 'ACOKB' event'	N/A
JIGON	[1]	R	1: Indicates power on by 'JIGON event'	N/A
PWRON	[0]	R	1: Indicates power on by 'PWRON key event'	N/A

5.2 RTC

5.2.1 Register Map Summary

Register	Address	Description	Reset Value
SEC_TK	0x00	Current Seconds Set Register	0x00
MIN_TK	0x01	Current Minutes Set Register	0x00
HR_TK	0x02	Current Hours Set Register	0x00
WD_TK	0x03	Current Weeks Set Register	0x01
DATE_TK	0x04	Current Date Set Register	0x01
MON_TK	0x05	Current Month Set Register	0x01
YEAR_TK	0x06	Current Year Set Register	0x00
CENT_TK (BCD)	0x07	Current Century Set Register	0x00
SEC_Alarm0	0x08	Alarm0 Seconds Set Register	0x00
MIN_Alarm0	0x09	Alarm0 Minutes Set Register	0x00
HR_Alarm0	0x0A	Alarm0 Hours Set Register	0x00
WD_Alarm0	0x0B	Alarm0 Weeks Set Register	0x00
DATE_Alarm0	0x0C	Alarm0 Date Set Register	0x01
MON_Alarm0	0x0D	Alarm0 Month Set Register	0x00
YR_Alarm0	0x0E	Alarm0 Year Set Register	0x00
CENT_Alarm0 (BCD)	0x0F	Alarm0 Century Set Register	0x00
SEC_Alarm1	0x10	Alarm1 Seconds Set Register	0x00
MIN_Alarm1	0x11	Alarm1 Minutes Set Register	0x00
HR_Alarm1	0x12	Alarm1 Hours Set Register	0x00
WD_Alarm1	0x13	Alarm1 Weeks Set Register	0x00
DATE_Alarm1	0x14	Alarm1 Date Set Register	0x01
MON_Alarm1	0x15	Alarm1 Month Set Register	0x00
YR_Alarm1	0x16	Alarm1 Year Set Register	0x00
CENT_Alarm1 (BCD)	0x17	Alarm1 Century Set Register	0x00
RTC_CTRLM	0x18	RTC Control Mask Register	0x03
RTC_CTRL	0x19	RTC Control Register	0x00
TEST_STATUS	0x1A	Status Register	NA
SMPL_WTSR	0x1B	SMPL WTSR Register	0x00
TEST_CON	0x1C	Update Register	0x00

5.2.2 Bit Map Summary

Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x00	RSVD	SEC						
0x01	RSVD	MIN						
0x02	RSVD	AM/PM	HOUR					
0x03	RSVD	SAT	FRI	THU	WED	TUE	MON	SUN
0x04	RSVD	RSVD	DATE					
0x05	RSVD	RSVD	RSVD	MONTH				
0x06	YEAR							
0x07	1000YEAR : BCD format only				100YEAR : BCD format only			
0x08	ALM0_EN	ALM0_SEC						
0x09	ALM0_EN	ALM0_MIN						
0x0A	ALM0_EN	AM/PM	ALM0_HOUR					
0x0B	ALM0_EN	SAT	FRI	THU	WED	TUE	MON	SUN
0x0C	ALM0_EN	RSVD	ALM0_DATE					
0x0D	ALM0_EN	RSVD	RSVD	ALM0_MONTH				
0x0E	ALM0_EN	ALM0_YEAR						
0x0F	ALM0_1000YEAR				ALM0_100YEAR			
0x10	ALM1_EN	ALM1_SEC						
0x11	ALM1_EN	ALM1_MIN						
0x12	ALM1_EN	AM/PM	ALM1_HOUR					
0x13	ALM1_EN	SAT	FRI	THU	WED	TUE	MON	SUN
0x14	ALM1_EN	RSVD	ALM1_DATE					
0x15	ALM1_EN	RSVD	RSVD	ALM1_MONTH				
0x16	ALM1_EN	ALM1_YEAR						
0x17	ALM1_1000YEAR				ALM1_100YEAR			
0x18	1 SECM	ALM CENTM	RSVD	RSVD	RSVD	RSVD	MODE24_12nM	BCDM
0x19	1 SEC	ALM CENT	RSVD	RSVD	RSVD	RSVD	MODE24_12n	BCD
0x1A	RSVD	LEAP_OK	RSVD	RSVD	RSVD	ALARM1	ALARM0	UDF
0x1B	SMPL	WTSR	WTSR_H_TIMER		SMPL_TIMER		WTSR_TIMER	
0x1C	UDR_T		SEL_OSC	TEST_OSC	TIMEN	SEC_FREEZE	RSVD	UDR

5.2.2.1 SEC_TK

- Address = 0x00, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value															
RSVD	[7]	RW	Reserved	0b0															
SEC	[6:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>0 sec</td><td>000_0000</td><td>0h</td><td>000_0000</td><td>0h</td></tr> <tr> <td>59 sec</td><td>011_1011</td><td>3Bh</td><td>101_1001</td><td>59h</td></tr> </tbody> </table> <ul style="list-style-type: none"> If setting value is bigger than 3Bh in BIN mode, it is set to 3Bh. BCD/BIN mode selection is referred to 0x18 and 0x19. 	–	BIN Format		BCD Format		0 sec	000_0000	0h	000_0000	0h	59 sec	011_1011	3Bh	101_1001	59h	0b0000000
–	BIN Format		BCD Format																
0 sec	000_0000	0h	000_0000	0h															
59 sec	011_1011	3Bh	101_1001	59h															

5.2.2.2 MIN_TK

- Address = 0x01, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value															
RSVD	[7]	RW	Reserved	0b0															
MIN	[6:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>0 min</td><td>000_0000</td><td>0h</td><td>000_0000</td><td>0h</td></tr> <tr> <td>59 min</td><td>011_1011</td><td>3Bh</td><td>101_1001</td><td>59h</td></tr> </tbody> </table> <ul style="list-style-type: none"> If setting vales is bigger than 3Bh in BIN mode, it is set to 3Bh. BCD/BIN mode selection is referred to 0x18 and 0x19. 	–	BIN Format		BCD Format		0 min	000_0000	0h	000_0000	0h	59 min	011_1011	3Bh	101_1001	59h	0b0000000
–	BIN Format		BCD Format																
0 min	000_0000	0h	000_0000	0h															
59 min	011_1011	3Bh	101_1001	59h															

5.2.2.3 HR_TK

- Address = 0x02, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value	
RSVD	[7]	RW	Reserved	0b0	
AM/PM	[6]	RW	Select AM/PM	0b0	
HOUR	[5:0}	RW			0b000000

5.2.2.4 WD_TK

- Address = 0x03, Reset Value = 0x01

Name	Bit	Type	Description	Reset Value
RSVD	[7]	RW	Reserved	0b0
SAT	[6]	RW	Multi-setting is not supported.	0b0
FRI	[5]	RW		0b0
THU	[4]	RW		0b0
WED	[3]	RW		0b0
TUE	[2]	RW		0b0
MON	[1]	RW		0b0
SUN	[0]	RW		0b1

5.2.2.5 DATE_TK

- Address = 0x04, Reset Value = 0x01

Name	Bit	Type	Description	Reset Value															
RSVD	[7]	RW	Reserved	0b0															
RSVD	[6]	RW	Reserved	0b0															
DATE	[5:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>1</td><td>00_0000</td><td>0h</td><td>00_0000</td><td>0h</td></tr> <tr> <td>31</td><td>01_1110</td><td>1Eh</td><td>11_0001</td><td>31h</td></tr> </tbody> </table> <ul style="list-style-type: none"> If setting vales is bigger than 1Eh in BIN mode, it is set to 1Eh. BCD/BIN mode selection is referred to 0x18 and 0x19. 	–	BIN Format		BCD Format		1	00_0000	0h	00_0000	0h	31	01_1110	1Eh	11_0001	31h	0b000001
–	BIN Format		BCD Format																
1	00_0000	0h	00_0000	0h															
31	01_1110	1Eh	11_0001	31h															

5.2.2.6 MON_TK

- Address = 0x05, Reset Value = 0x01

Name	Bit	Type	Description	Reset Value															
RSVD	[7]	RW	Reserved	0b0															
RSVD	[6]	RW	Reserved	0b0															
RSVD	[5]	RW	Reserved	0b0															
MONTH	[5:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>1</td><td>0_0000</td><td>00h</td><td>0_0001</td><td>01h</td></tr> <tr> <td>12</td><td>0_1100</td><td>0Ch</td><td>1_0010</td><td>12h</td></tr> </tbody> </table> <ul style="list-style-type: none"> If setting vales is bigger than 0Ch in BIN mode, it is set to 0Ch. BCD/BIN mode selection is referred to 0x18 and 0x19. 	–	BIN Format		BCD Format		1	0_0000	00h	0_0001	01h	12	0_1100	0Ch	1_0010	12h	0b00001
–	BIN Format		BCD Format																
1	0_0000	00h	0_0001	01h															
12	0_1100	0Ch	1_0010	12h															

5.2.2.7 YEAR_TK

- Address = 0x06, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value															
YEAR	[7:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>1</td><td>0000_0000</td><td>00h</td><td>00 0_0000</td><td>00h</td></tr> <tr> <td>99 (BIN) /79 (BCD)</td><td>0110_ 011</td><td>63h</td><td>X111_1001</td><td>79h</td></tr> </tbody> </table> <ul style="list-style-type: none"> Maximum setting value is 63h in BIN mode and 79h in BCD mode. 	–	BIN Format		BCD Format		1	0000_0000	00h	00 0_0000	00h	99 (BIN) /79 (BCD)	0110_ 011	63h	X111_1001	79h	0b00000000
–	BIN Format		BCD Format																
1	0000_0000	00h	00 0_0000	00h															
99 (BIN) /79 (BCD)	0110_ 011	63h	X111_1001	79h															

5.2.2.8 CENT_TK (BC)

- Address = 0x07, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value															
1000YEAR	[7:4]	RW	–	0b0000															
100YEAR	[3:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>1</td><td>X</td><td>X</td><td>0000_0000</td><td>0h</td></tr> <tr> <td>9900</td><td>X</td><td>X</td><td>1001_1001</td><td>99h</td></tr> </tbody> </table> <ul style="list-style-type: none"> CENT is only valid in BCD mode. 	–	BIN Format		BCD Format		1	X	X	0000_0000	0h	9900	X	X	1001_1001	99h	0b0000
–	BIN Format		BCD Format																
1	X	X	0000_0000	0h															
9900	X	X	1001_1001	99h															

5.2.2.9 SEC_Alarm0

- Address = 0x08, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value															
ALM0_EN	[7]	RW	SEC ALARM enable	0b0															
ALM0_SEC	[6:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>0 sec</td><td>000_0000</td><td>0h</td><td>000_0000</td><td>0h</td></tr> <tr> <td>59 sec</td><td>011_1011</td><td>3Bh</td><td>101_1001</td><td>59h</td></tr> </tbody> </table>	–	BIN Format		BCD Format		0 sec	000_0000	0h	000_0000	0h	59 sec	011_1011	3Bh	101_1001	59h	0b0000000
–	BIN Format		BCD Format																
0 sec	000_0000	0h	000_0000	0h															
59 sec	011_1011	3Bh	101_1001	59h															

5.2.2.10 MIN_Ararm0

- Address = 0x09, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value															
ALM0_EN	[7]	RW	MIN ALARM enable	0b0															
ALM0_MIN	[6:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>0 min</td><td>000_0000</td><td>0h</td><td>000_0000</td><td>0h</td></tr> <tr> <td>59 min</td><td>011_1011</td><td>3Bh</td><td>101_1001</td><td>59h</td></tr> </tbody> </table>	–	BIN Format		BCD Format		0 min	000_0000	0h	000_0000	0h	59 min	011_1011	3Bh	101_1001	59h	0b0000000
–	BIN Format		BCD Format																
0 min	000_0000	0h	000_0000	0h															
59 min	011_1011	3Bh	101_1001	59h															

5.2.2.11 HR_Alarm0

- Address = 0x0A, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value																							
ALM0_EN	[7]	RW	HOURLY ALARM enable	0b0																							
AM/PM	[6]	RW	Select AM/PM	0b0																							
ALM0_HOUR	[5:0]	RW	<table border="1"> <thead> <tr> <th>Mode</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td rowspan="2">12 Hour</td><td>00_0000</td><td>00h</td><td>00_0000</td><td>00h</td></tr> <tr> <td>00_1100</td><td>0Ch</td><td>01_0010</td><td>12h</td></tr> <tr> <td rowspan="2">24 Hour</td><td>00_0000</td><td>00h</td><td>00_0000</td><td>00h</td></tr> <tr> <td>01_0111</td><td>17h</td><td>10_0011</td><td>23h</td></tr> </tbody> </table>	Mode	BIN Format		BCD Format		12 Hour	00_0000	00h	00_0000	00h	00_1100	0Ch	01_0010	12h	24 Hour	00_0000	00h	00_0000	00h	01_0111	17h	10_0011	23h	0b0000000
Mode	BIN Format		BCD Format																								
12 Hour	00_0000	00h	00_0000	00h																							
	00_1100	0Ch	01_0010	12h																							
24 Hour	00_0000	00h	00_0000	00h																							
	01_0111	17h	10_0011	23h																							

5.2.2.12 WD_Alarm0

- Address = 0x0B, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value
ALM0_EN	[7]	RW	WEEK ALARM enable	0b0
SAT	[6]	RW	100_0000 represents Saturday	0b0
FRI	[5]	RW	010_0000 represents Friday	0b0
THU	[4]	RW	001_0000 represents Thursday	0b0
WED	[3]	RW	000_1000 represents Wednesday	0b0
TUE	[2]	RW	000_0100 represents Tuesday	0b0
MON	[1]	RW	000_0010 represents Monday	0b0
SUN	[0]	RW	000_0001 represents Sunday	0b0

5.2.2.13 DATE_Alarm0

- Address = 0x0C, Reset Value = 0x01

Name	Bit	Type	Description	Reset Value															
ALM0_EN	[7]	RW	DATE ALARM enable	0b0															
RSVD	[6]	RW	Reserved	0b0															
ALM0_DATE	[5:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>1</td><td>00_0000</td><td>0h</td><td>00_0000</td><td>0h</td></tr> <tr> <td>31</td><td>01_1110</td><td>1Eh</td><td>11_0001</td><td>31h</td></tr> </tbody> </table>	–	BIN Format		BCD Format		1	00_0000	0h	00_0000	0h	31	01_1110	1Eh	11_0001	31h	0b000001
–	BIN Format		BCD Format																
1	00_0000	0h	00_0000	0h															
31	01_1110	1Eh	11_0001	31h															

5.2.2.14 MON_Alarm0

- Address = 0x0D, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value															
ALM0_EN	[7]	RW	MONTH ALARM enable	0b0															
RSVD	[6]	RW	Reserved	0b0															
RSVD	[5]	RW	Reserved	0b0															
ALM0_MONTH	[4:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>1</td><td>0_0001</td><td>00h</td><td>00_0001</td><td>01h</td></tr> <tr> <td>12</td><td>0_1100</td><td>0Ch</td><td>01_0010</td><td>12h</td></tr> </tbody> </table>	–	BIN Format		BCD Format		1	0_0001	00h	00_0001	01h	12	0_1100	0Ch	01_0010	12h	0b00000
–	BIN Format		BCD Format																
1	0_0001	00h	00_0001	01h															
12	0_1100	0Ch	01_0010	12h															

5.2.2.15 YR_Alarm0

- Address = 0x0E, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value															
ALM0_EN	[7]	RW	YEAR ALARM enable	0b0															
ALM0_YEAR	[6:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>1</td><td>0000_0000</td><td>0h</td><td>0000_0000</td><td>0h</td></tr> <tr> <td>99 (BIN) /79 (BCD)</td><td>0110_0011</td><td>63h</td><td>X111_1001</td><td>79h</td></tr> </tbody> </table>	–	BIN Format		BCD Format		1	0000_0000	0h	0000_0000	0h	99 (BIN) /79 (BCD)	0110_0011	63h	X111_1001	79h	0b0000000
–	BIN Format		BCD Format																
1	0000_0000	0h	0000_0000	0h															
99 (BIN) /79 (BCD)	0110_0011	63h	X111_1001	79h															

5.2.2.16 CENT_Alarm0

- Address = 0x0F, Reset Value = 0x00

Name	Bit	Type	Description					Reset Value															
ALM0_1000YEAR	[7:4]	RW	<table><tr><td>—</td><td colspan="2">BIN Format</td><td colspan="2">BCD Format</td></tr><tr><td>1</td><td>X</td><td>X</td><td>0000_0000</td><td>0h</td></tr><tr><td>9900</td><td>X</td><td>X</td><td>1001_1001</td><td>99h</td></tr></table>					—	BIN Format		BCD Format		1	X	X	0000_0000	0h	9900	X	X	1001_1001	99h	0b0000
—	BIN Format		BCD Format																				
1	X	X	0000_0000	0h																			
9900	X	X	1001_1001	99h																			
ALM0_100YEAR	[3:0]	RW	<ul style="list-style-type: none">• If 0x0E[7] is set high, CENT ALARM enabled.• CENT is only valid in BCD mode.• CENT Comparison is activated when 0x19[6] is set to high.					0b0000															

5.2.2.17 SEC_Alarm1

- Address = 0x10, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value															
ALM1_EN	[7]	RW	SEC ALARM enable	0b0															
ALM1_SEC	[6:0]	RW	<table><tr><th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr><tr><td>0 sec</td><td>000_0000</td><td>0h</td><td>000_0000</td><td>0h</td></tr><tr><td>59 sec</td><td>011_1011</td><td>3Bh</td><td>101_1001</td><td>59h</td></tr></table>	–	BIN Format		BCD Format		0 sec	000_0000	0h	000_0000	0h	59 sec	011_1011	3Bh	101_1001	59h	0b0000000
–	BIN Format		BCD Format																
0 sec	000_0000	0h	000_0000	0h															
59 sec	011_1011	3Bh	101_1001	59h															

5.2.2.18 MIN_Alarm1

- Address = 0x11, Reset Value = 0x00

Name	Bit	Type	Description					Reset Value
ALM1_EN	[7]	RW	MIN ALARM enable					0b0
ALM1_MIN	[6:0]	RW						0b0000000
			–	BIN Format		BCD Format		
			0 min	000_0000	0h	000_0000	0h	
			59 min	011_1011	3Bh	101_1001	59h	

5.2.2.19 HR_Alarm1

- Address = 0x12, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value																							
ALM1_EN	[7]	RW	HOUR ALARM enable	0b0																							
AM/PM	[6]	RW	Select AM/PM.	0b0																							
ALM1_HOUR	[5:0]	RW	<table border="1"> <thead> <tr> <th>Mode</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td rowspan="2">12 Hour</td><td>00_0000</td><td>00h</td><td>00_0000</td><td>00h</td></tr> <tr> <td>00_1100</td><td>0Ch</td><td>01_0010</td><td>11h</td></tr> <tr> <td rowspan="2">24 Hour</td><td>00_0000</td><td>00h</td><td>00_0000</td><td>00h</td></tr> <tr> <td>01_0111</td><td>17h</td><td>10_0011</td><td>23h</td></tr> </tbody> </table>	Mode	BIN Format		BCD Format		12 Hour	00_0000	00h	00_0000	00h	00_1100	0Ch	01_0010	11h	24 Hour	00_0000	00h	00_0000	00h	01_0111	17h	10_0011	23h	0b000000
Mode	BIN Format		BCD Format																								
12 Hour	00_0000	00h	00_0000	00h																							
	00_1100	0Ch	01_0010	11h																							
24 Hour	00_0000	00h	00_0000	00h																							
	01_0111	17h	10_0011	23h																							

5.2.2.20 WD_Alarm1

- Address = 0x13, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value
ALM1_EN	[7]	RW	WEEK ALARM enable	0b0
SAT	[6]	RW	100_0000 represents Saturday	0b0
FRI	[5]	RW	010_0000 represents Friday	0b0
THU	[4]	RW	001_0000 represents Thursday	0b0
WED	[3]	RW	000_1000 represents Wednesday	0b0
TUE	[2]	RW	000_0100 represents Tuesday	0b0
MON	[1]	RW	000_0010 represents Monday	0b0
SUN	[0]	RW	000_0001 represents Sunday	0b0

5.2.2.21 DATE_Alarm1

- Address = 0x14, Reset Value = 0x01

Name	Bit	Type	Description	Reset Value															
ALM1_EN	[7]	RW	DATE ALARM enable	0b0															
RSVD	[6]	RW	Reserved	0b0															
ALM1_DATE	[5:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>1</td><td>00_0000</td><td>0h</td><td>00_0000</td><td>0h</td></tr> <tr> <td>31</td><td>01_1110</td><td>1Eh</td><td>11_0001</td><td>31h</td></tr> </tbody> </table>	–	BIN Format		BCD Format		1	00_0000	0h	00_0000	0h	31	01_1110	1Eh	11_0001	31h	0b000001
–	BIN Format		BCD Format																
1	00_0000	0h	00_0000	0h															
31	01_1110	1Eh	11_0001	31h															

5.2.2.22 MON_Alarm1

- Address = 0x15, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value															
ALM1_EN	[7]	RW	MONTH ALARM enable	0b0															
RSVD	[6]	RW	Reserved	0b0															
RSVD	[5]	RW	Reserved	0b0															
ALM1_MONTH	[4:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>1</td><td>0_0000</td><td>0h</td><td>00_0000</td><td>0h</td></tr> <tr> <td>12</td><td>0_1100</td><td>0Ch</td><td>01_0010</td><td>12h</td></tr> </tbody> </table>	–	BIN Format		BCD Format		1	0_0000	0h	00_0000	0h	12	0_1100	0Ch	01_0010	12h	0b00000
–	BIN Format		BCD Format																
1	0_0000	0h	00_0000	0h															
12	0_1100	0Ch	01_0010	12h															

5.2.2.23 YR_Alarm1

- Address = 0x16, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value															
ALM1_EN	[7]	RW	YEAR ALARM enable	0b0															
ALM1_YEAR	[6:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>1</td><td>0000_0000</td><td>0h</td><td>0000_0000</td><td>0h</td></tr> <tr> <td>99 (BIN) /79 (BCD)</td><td>0110_0011</td><td>63h</td><td>X111_1001</td><td>79h</td></tr> </tbody> </table>	–	BIN Format		BCD Format		1	0000_0000	0h	0000_0000	0h	99 (BIN) /79 (BCD)	0110_0011	63h	X111_1001	79h	0b0000000
–	BIN Format		BCD Format																
1	0000_0000	0h	0000_0000	0h															
99 (BIN) /79 (BCD)	0110_0011	63h	X111_1001	79h															

5.2.2.24 CENT_Alarm1

- Address = 0x17, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value															
ALM1_1000YEAR	[7:4]	RW		0b0000															
ALM1_100YEAR	[3:0]	RW	<table border="1"> <thead> <tr> <th>–</th><th colspan="2">BIN Format</th><th colspan="2">BCD Format</th></tr> </thead> <tbody> <tr> <td>1</td><td>X</td><td>X</td><td>0000_0000</td><td>0h</td></tr> <tr> <td>9900</td><td>X</td><td>X</td><td>1001_1001</td><td>99h</td></tr> </tbody> </table> <ul style="list-style-type: none"> If 0x16[7] is set high, CENT ALARM enabled. CENT is only valid in BCD mode. CENT Comparison is activated when 19h.6 is set to high. 	–	BIN Format		BCD Format		1	X	X	0000_0000	0h	9900	X	X	1001_1001	99h	0b0000
–	BIN Format		BCD Format																
1	X	X	0000_0000	0h															
9900	X	X	1001_1001	99h															

5.2.2.25 RTL_CTRLM

- Address = 0x18, Reset Value = 0x03

Name	Bit	Type	Description	Reset Value
1SECM	[7]	RW	Monitor selection. 0 = When read, ALARM0 status 1 = When read, 1SEC period	0b0
ALMCENTM	[6]	RW	ALMCENT 0 = Not masked 1 = Masked	0b0
RSVD	[5]	RW	Reserved	0b0
RSVD	[4]	RW	Reserved	0b0
RSVD	[3]	RW	Reserved	0b0
RSVD	[2]	RW	Reserved	0b0
MODE24_12nM	[1]	RW	Mode24_12n 0 = Not masked 1 = Masked	0b1
BCDM	[0]	RW	BCD 0 = Not masked 1 = Masked	0b1

5.2.2.26 RTL_CTRL

- Address = 0x19, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value
1SEC	[7]	RW	Monitor selection. 0 = When read, ALARM1 status 1 = When read, 1SEC period	0b0
ALMCENT	[6]	RW	0 = Only compare YEAR 1 = Compare both CENT and YEAR	0b0
RSVD	[5]	RW	Reserved	0b0
RSVD	[4]	RW	Reserved	0b0
RSVD	[3]	RW	Reserved	0b0
RSVD	[2]	RW	Reserved	0b0
MODE24_12n	[1]	RW	0 = 12 hour mode 1 = 24 hour mode	0b0
BCD	[0]	RW	0 = Binary mode 1 = BCD mode	0b0

5.2.2.27 TEST_STATUS

- Address = 0x1A, Reset Value = NA

Name	Bit	Type	Description	Reset Value
RSVD	[7]	R	Reserved	N/A
LEAP_OK	[6]	R	Indicates leap month. 0 = Non-February flag 1 = February flag	N/A
RSVD	[5]	R	Reserved	N/A
RSVD	[4]	R	Reserved	N/A
RSVD	[3]	R	Reserved	N/A
ALARM1	[2]	R	0 = ALARM1 interrupt flag is 0 1 = ALARM1 interrupt flag is 1	N/A
ALARM0	[1]	R	0 = ALARM0 interrupt flag is 0 1 = ALARM0 interrupt flag is 1	N/A
UDF	[0]	R	UDR status register 0 = Address DATA was not updated 1 = Address DATA	N/A

5.2.2.28 SMPL_WTSR

- Address = 0x1B, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value
SMPL	[7]	RW	0 = Disable SMPL interrupt 1 = Enable SMPL interrupt	0b0
WTSR	[6]	RW	0 = Disable WTSR interrupt 1 = Enable WTSR interrupt	0b0
WTSR_H_TIMER	[5:4]	RW	WTSR_RESETB threshold control registers. 00 = 0.25 s (Default) 01 = 0.50 s 10 = 0.75 s 11 = 1.00 s	0b00
SMPL_TIMER	[3:2]	RW	SMPL threshold control registers. 00 = 0.5 s (Default) 01 = 1.0 s 10 = 1.5 s 11 = 2.0 s	0b00
WSTR_TIMER	[1:0]	RW	WSTR threshold control registers. 00, 01, 10 = 62.5 ms 11 = 78.12 ms	0b11

5.2.2.29 TEST_CON

- Address = 0x1C, Reset Value = 0x00

Name	Bit	Type	Description	Reset Value
UDR_T	[7:6]	RW	Determines UDR (Update Register) time. 00 = 7.32 ms (Default) 01 = 1.83 ms 10 = 3.66 ms 11 = 0.45 ms	0b00
SEL_OSC	[5]	RW	0 = SEC counter clock inversion off 1 = SEC counter clock inversion on	0b0
TEST_OSC	[4]	RW	0 = 1 Hz for SEC counter 1 = 16 Hz for SEC counter	0b0
TIMEN	[3]	RW	Enable write current time register	0b0
SEC_FREEZE	[2]	RW	This bit freezes the RTC. 0 = Normal Timer 1 = Clock Disable for SEC Counter	0b0
RESERVED	[1]	RW	Reserved	0b0
UDR	[0]	RW	Enable flag of update. UDR is auto cleared to after the registers data have been transferred. 0 = Address & Data Hold 1 = Address & Data Update Enable	0b0

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Application Circuit

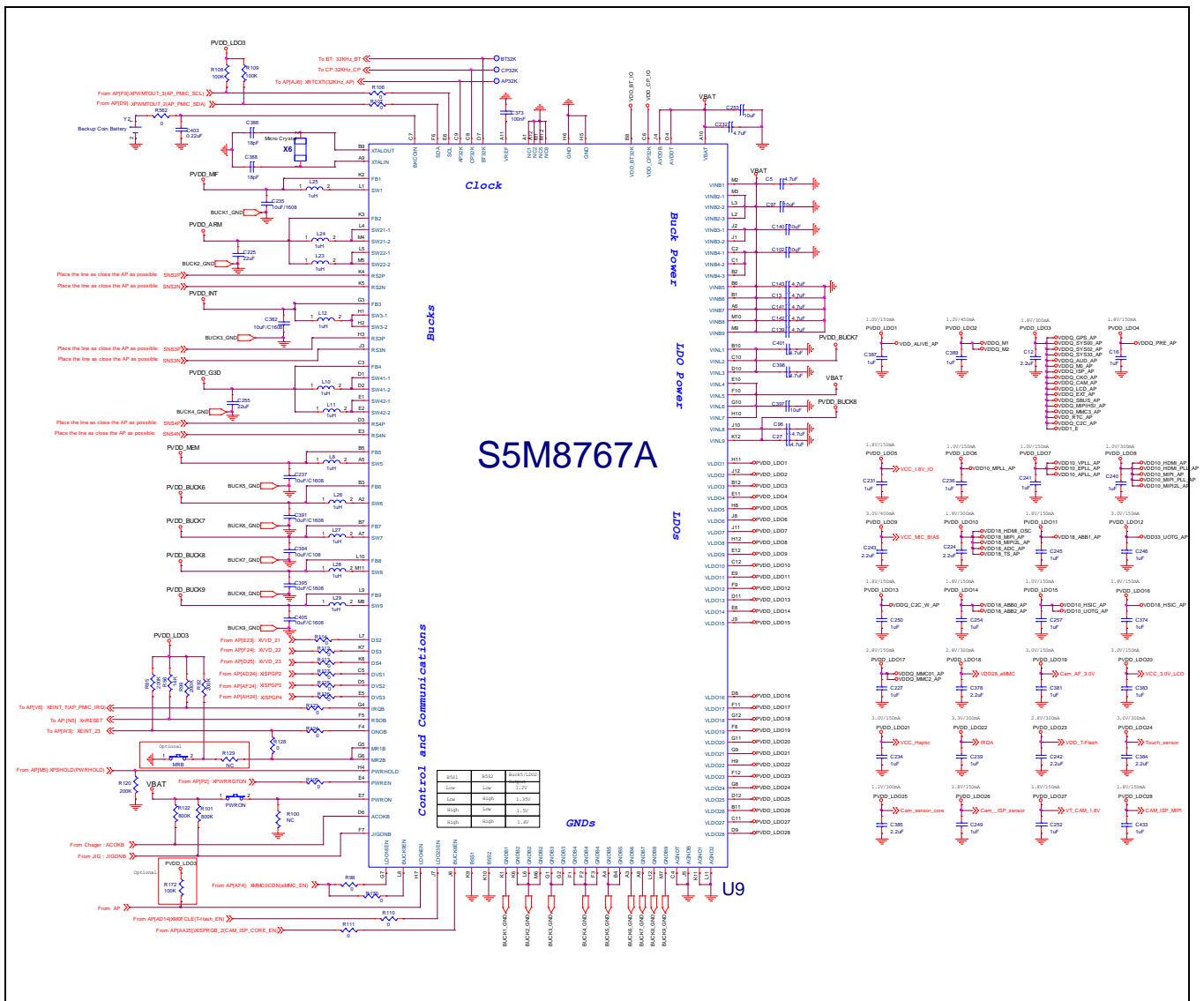


Figure 28 Typical Application Circuit

6.1 Package Dimension

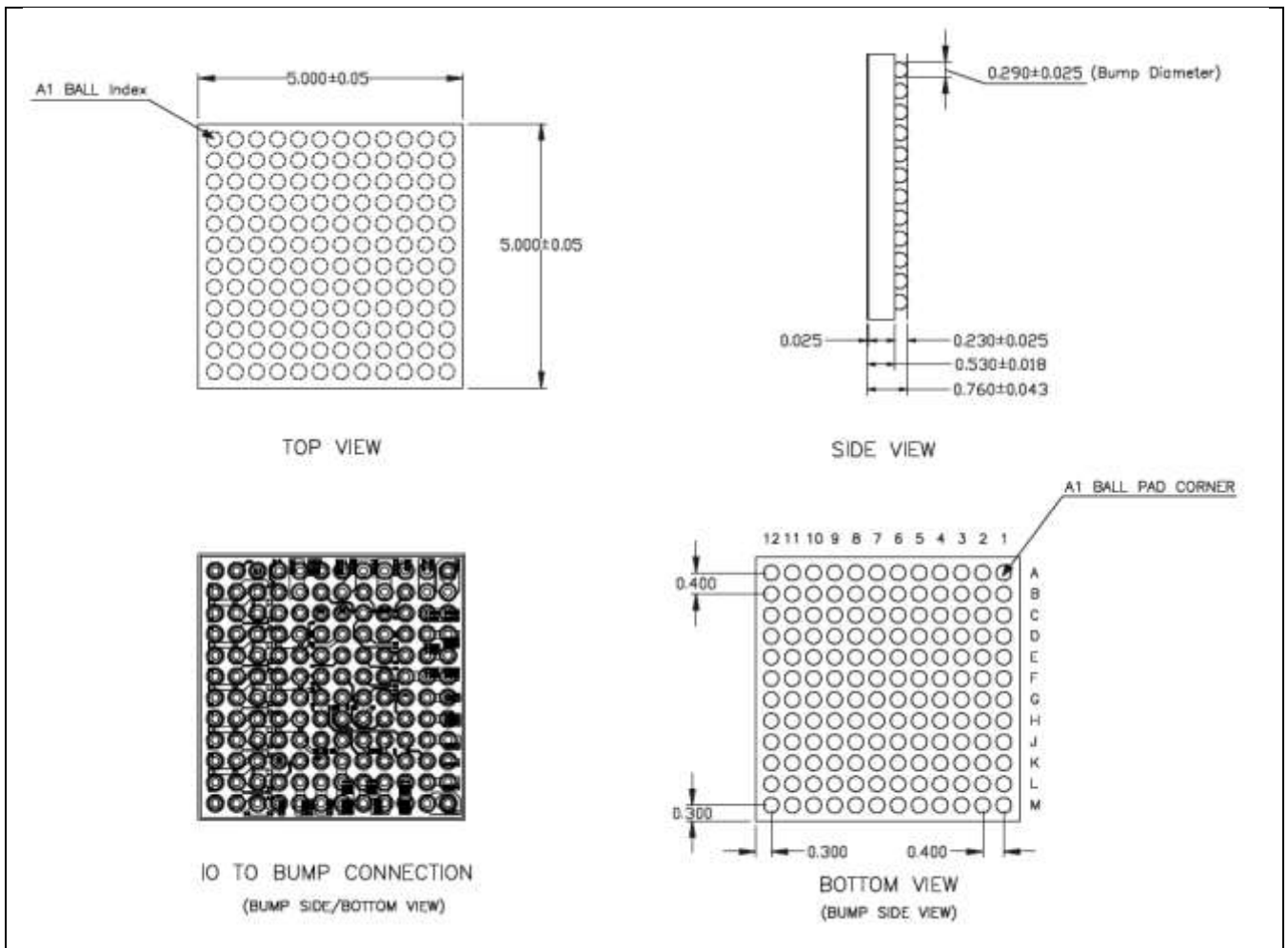


Figure 29 Package Dimension